

**RV COLLEGE OF ENGINEERING<sup>®</sup>** 

(Autonomous Institution Affiliated to VTU, Belagavi)

R.V. Vidyaniketan Post, Mysore Road Bengaluru – 560 059



## Bachelor of Engineering (B.E.) Scheme and Syllabus of VII & VIII Semesters

# **2016 SCHEME**

# ELECTRONICS & COMMUNICATION ENGINEERING

### VISION

Leadership in Quality Technical Education, Interdisciplinary Research & Innovation, with a Focus on Sustainable and Inclusive Technology

### MISSION

- 1. To deliver outcome based Quality education, emphasizing on experiential learning with the state of the art infrastructure.
- 2. To create a conducive environment for interdisciplinary research and innovation.
- 3. To develop professionals through holistic education focusing on individual growth, discipline, integrity, ethics and social sensitivity.
- 4. To nurture industry-institution collaboration leading to competency enhancement and entrepreneurship.
- 5. To focus on technologies that are sustainable and inclusive, benefiting all sections of the society.

# **QUALITY POLICY**

Achieving Excellence in Technical Education, Research and Consulting through an Outcome Based Curriculum focusing on Continuous Improvement and Innovation by Benchmarking against the global Best Practices.

# **CORE VALUES**

Professionalism, Commitment, Integrity, Team Work, Innovation

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## Bachelor of Engineering (B.E.) Scheme and Syllabus of VII & VIII Semesters

# **2016 SCHEME**

# DEPARTMENT OF ELECTRONICS & COMMUNICATION ENGINEERING

#### **DEPARTMENT VISION**

Imparting quality technical education through interdisciplinary research, innovation and teamwork for developing inclusive & sustainable technology in the area of Electronics and Communication Engineering.

#### **DEPARTMENT MISSION**

- To impart quality technical education to produce industry-ready engineers with a research outlook.
- To train the Electronics & Communication Engineering graduates to meet future global challenges by inculcating a quest for modern technologies in the emerging areas.
- To create centres of excellence in the field of Electronics & Communication Engineering with industrial and university collaborations.
- To develop entrepreneurial skills among the graduates to create new employment opportunities.

#### PROGRAM EDUCATIONAL OBJECTIVES (PEOs)

- **PEO1.** To apply concepts of mathematics, science and computing to Electronics and Communication Engineering
- **PEO2.** To design and develop interdisciplinary and innovative systems.
- **PEO3.** To inculcate effective communication skills, team work, ethics, leadership in preparation for a successful career in industry and R & D organizations.

| PSO  | Description                                                                            |
|------|----------------------------------------------------------------------------------------|
|      |                                                                                        |
| PSO1 | Should be able to clearly understand the concepts and applications in the field of     |
|      | Communication/networking, signal processing, embedded systems and semiconductor        |
|      | technology.                                                                            |
| PSO2 | Should be able to associate the learning from the courses related to Microelectronics, |
|      | Signal processing, Microcomputers, Embedded and Communication Systems to arrive        |
|      | at solutions to real world problems.                                                   |
| PSO3 | Should have the capability to comprehend the technological advancements in the usage   |
|      | of modern design tools to analyze and design subsystems/processes for a variety of     |
|      | applications.                                                                          |
| PSO4 | Should possess the skills to communicate in both oral and written forms, the work      |
|      | already done and the future plans with necessary road maps, demonstrating the practice |
|      | of professional ethics and the concerns for societal and environmental wellbeing.      |
|      | Lead Society: Institute of Electrical and Electronics Engineers (IEEE)                 |

#### PROGRAM SPECIFIC OUTCOMES (PSOS)

| SL. NO. | ABBREVIATION | MEANING                                   |  |  |  |  |
|---------|--------------|-------------------------------------------|--|--|--|--|
| 1.      | VTU          | Visvesvaraya Technological University     |  |  |  |  |
| 2.      | BS           | Basic Sciences                            |  |  |  |  |
| 3.      | CIE          | Continuous Internal Evaluation            |  |  |  |  |
| 4.      | SEE          | Semester End Examination                  |  |  |  |  |
| 5.      | CE           | Professional Core Elective                |  |  |  |  |
| 6.      | GE           | Global Elective                           |  |  |  |  |
| 7.      | HSS          | Humanities and Social Sciences            |  |  |  |  |
| 8.      | CV           | Civil Engineering                         |  |  |  |  |
| 9.      | ME           | Mechanical Engineering                    |  |  |  |  |
| 10.     | EE           | Electrical & Electronics Engineering      |  |  |  |  |
| 11.     | EC           | Electronics & Communication Engineering   |  |  |  |  |
| 12.     | IM           | Industrial Engineering & Management       |  |  |  |  |
| 13.     | EI           | Electronics & Instrumentation Engineering |  |  |  |  |
| 14.     | CH           | Chemical Engineering                      |  |  |  |  |
| 15.     | CS           | Computer Science & Engineering            |  |  |  |  |
| 16.     | TE           | Telecommunication Engineering             |  |  |  |  |
| 17.     | IS           | Information Science & Engineering         |  |  |  |  |
| 18.     | BT           | Biotechnology                             |  |  |  |  |
| 19.     | AS           | Aerospace Engineering                     |  |  |  |  |
| 20.     | PY           | Physics                                   |  |  |  |  |
| 21.     | CY           | Chemistry                                 |  |  |  |  |
| 22.     | MA           | Mathematics                               |  |  |  |  |

### ABBREVIATIONS

#### INDEX

|         | VII Semester       |                                            |          |  |  |  |
|---------|--------------------|--------------------------------------------|----------|--|--|--|
| Sl. No. | <b>Course Code</b> | Name of the Course                         | Page No. |  |  |  |
| 1.      | 16EC71             | Microwave & Radiating Systems              | 1        |  |  |  |
| 2.      | 16EC72             | Broadband Wireless –LTE 4G                 | 4        |  |  |  |
| 3.      | 16EC73P            | Minor Project                              | 6        |  |  |  |
|         | GR                 | OUP F: PROFESSIONAL CORE ELECTIVES         |          |  |  |  |
| 1.      | 16EC7F1            | Satellite Communications & GPS             | 7        |  |  |  |
| 2.      | 16EC7F2            | ARM Programming & Optimization             | 9        |  |  |  |
| 3.      | 16EC7F3            | Speech Processing                          | 11       |  |  |  |
| 4.      | 16EC7F4            | Radio Frequency Integrated Circuits Design | 13       |  |  |  |
| 5.      | 16EC7F5            | High Performance Computing                 | 15       |  |  |  |
| 6.      | 16EC7F6            | Integrated Photonics                       | 17       |  |  |  |
| 7.      | 16EC7F7            | Nanoelectronics                            | 19       |  |  |  |
|         | GR                 | OUP G: PROFESSIONAL CORE ELECTIVES         |          |  |  |  |
| 1.      | 16EC7G1            | Radar & Navigation                         | 21       |  |  |  |
| 2.      | 16EC7G2            | Automotive Electronics                     | 23       |  |  |  |
| 3.      | 16EC7G3            | Multimedia Communication                   | 25       |  |  |  |
| 4.      | 16EC7G4            | VLSI Testing for ICs                       | 27       |  |  |  |
| 5.      | 16EC7G5            | High Speed digital design                  | 29       |  |  |  |
| 6.      | 16EC7G6            | MEMS and Smart Systems                     | 31       |  |  |  |

|         | GROUP H: OPEN ELECTIVES |             |                                              |      |  |  |  |  |
|---------|-------------------------|-------------|----------------------------------------------|------|--|--|--|--|
| Sl. No. | Host                    | Course Code | Course Title                                 | Page |  |  |  |  |
|         | Dept                    |             |                                              | No.  |  |  |  |  |
| 1.      | BT                      | 16G7H01     | Nanotechnology                               | 33   |  |  |  |  |
| 2.      | СН                      | 16G7H02     | Industrial Safety and Risk Management        | 35   |  |  |  |  |
| 3.      | CV                      | 16G7H03     | Intelligent Transport System                 | 37   |  |  |  |  |
| 4.      | CS                      | 16G7H04     | Intelligent Systems                          | 39   |  |  |  |  |
| 5.      | EC                      | 16G7H05     | Image Processing and Machine Learning        | 41   |  |  |  |  |
| 6.      | EE                      | 16G7H06     | Design of Renewable Energy Systems           | 43   |  |  |  |  |
| 7.      | IM                      | 16G7H07     | Systems Engineering                          | 45   |  |  |  |  |
| 8.      | EI                      | 16G7H08     | MEMS and Applications                        | 47   |  |  |  |  |
| 9.      | IS                      | 16G7H09     | Introduction to Internet of Things           | 49   |  |  |  |  |
| 10.     | ME                      | 16G7H10     | Industry 4.0 – Smart Manufacturing for The   | 51   |  |  |  |  |
|         |                         |             | Future                                       |      |  |  |  |  |
| 11.     | TE                      | 16G7H11     | Space Technology and Applications            | 53   |  |  |  |  |
| 12.     | MA                      | 16G7H12     | Advanced linear Algebra                      | 55   |  |  |  |  |
| 13.     | PY                      | 16G7H13     | Thin Film Nanotechnology                     | 57   |  |  |  |  |
| 14.     | CY                      | 16G7H14     | Engineering Material for Advanced Technology | 59   |  |  |  |  |
| 15.     | HSS                     | 16G7H15     | Applied Psychology for Engineers             | 62   |  |  |  |  |
| 16.     | HSS                     | 16G7H16     | Foundational Course on Entrepreneurship      | 64   |  |  |  |  |
| 17.     | AS                      | 16G7H17     | Unmanned Aerial Vehicles                     | 66   |  |  |  |  |

|   |        | VIII Semester                |    |
|---|--------|------------------------------|----|
| 1 | 16EC81 | Major Project                | 68 |
| 2 | 16EC82 | Technical Seminar            | 71 |
| 3 | 16HS83 | Innovation and Social Skills | 72 |

### RV COLLEGE OF ENGINEERING® (Autonomous Institution Affiliated to VTU, Belagavi) ELECTRONICS AND COMMUNICATION ENGINEERING

|     | SEVENTH SEMESTER CREDIT SCHEME |                                     |                    |        |       |           |    |         |
|-----|--------------------------------|-------------------------------------|--------------------|--------|-------|-----------|----|---------|
| Sl. | Course                         |                                     |                    |        | Tatal |           |    |         |
| Ν   | Code                           | Course Title                        | BOS                | Lectur | Tutor | Practical | SS | Credits |
| 0   |                                |                                     |                    | е      | ial   |           | ~~ |         |
| 1   | 16EC71                         | Microwave &<br>Radiating<br>Systems | ECE                | 4      | 0     | 1         | 0  | 5       |
| 2   | 16EC72                         | Broadband<br>Wireless –LTE<br>4G    | ECE                | 4      | 0     | 0         | 0  | 4       |
| 3   | 16EC73P                        | Minor<br>Project**                  | ECE                | 0      | 0     | 3         | 0  | 3       |
| 4   | 16EC7FX                        | Elective F<br>(PE)                  | ECE                | 4      | 0     | 0         | 0  | 4       |
| 5   | 16EC7GX                        | Elective G(PE)                      | ECE                | 4      | 0     | 0         | 0  | 4       |
| 6   | 16G7HXX                        | Elective H<br>(GE)*                 | Respectiv<br>e BOS | 3      | 0     | 0         | 0  | 3       |
|     | Tota                           | No. of Credits                      |                    | 19     | 0     | 4         | 0  | 23      |
|     | No.                            | Of Hrs/Week                         |                    | 19     | 0     | 4         | 0  |         |

\*Students should take other department Global Elective courses;

\*\* Minor Project-6 hours per week;

|                      | EIGTH SEMESTER CREDIT SCHEME |                                    |     |         |          |           |    |         |
|----------------------|------------------------------|------------------------------------|-----|---------|----------|-----------|----|---------|
| Sl.                  | Sl. Course                   |                                    | BO  |         | -        | Total     |    |         |
| No                   | Code                         | Course Title                       | S   | Lecture | Tutorial | Practical | SS | Credits |
| 1.                   | 16EC81                       | Major Project                      | ECE | 0       | 0        | 16        | 0  | 16      |
| 2.                   | 16EC82                       | Technical Seminar                  | ECE | 0       | 0        | 2         | 0  | 2       |
| 3.                   | 16HS83                       | 83 Innovation and<br>Social Skills |     | 0       | 0        | 2         | 0  | 2       |
| Total No. of Credits |                              |                                    |     | 0       | 0        | 20        | 0  | 20      |
| No. Of Hrs.          |                              |                                    |     | 0       | 0        | 40        | 0  |         |

|                                  | VII Semester                    |                                            |  |  |  |  |
|----------------------------------|---------------------------------|--------------------------------------------|--|--|--|--|
|                                  | GROUP F: PROFESSIONAL ELECTIVES |                                            |  |  |  |  |
| Sl. No.                          | <b>Course Code</b>              | Course Title                               |  |  |  |  |
| 1.                               | 16EC7F1                         | Satellite Communications & GPS             |  |  |  |  |
| 2.                               | 16EC7F2                         | ARM Programming & Optimization             |  |  |  |  |
| 3.                               | 16EC7F3                         | Speech Processing                          |  |  |  |  |
| 4.                               | 16EC7F4                         | Radio Frequency Integrated Circuits Design |  |  |  |  |
| 5.                               | 16EC7F5                         | High Performance Computing                 |  |  |  |  |
| 6.                               | 16EC7F6                         | Integrated Photonics                       |  |  |  |  |
| 7.                               | 16EC7F7                         | Nanoelectronics                            |  |  |  |  |
| VII Semester                     |                                 |                                            |  |  |  |  |
|                                  | GROUP G: PROFESSIONAL ELECTIVES |                                            |  |  |  |  |
| Sl. No. Course Code Course Title |                                 |                                            |  |  |  |  |
| 1.                               | 16EC7G1                         | Radar & Navigation                         |  |  |  |  |
| 2.                               | 16EC7G2                         | Automotive Electronics                     |  |  |  |  |
| 3.                               | 16EC7G3                         | Multimedia Communication                   |  |  |  |  |
| 4.                               | 16EC7G4                         | VLSI Testing for ICs                       |  |  |  |  |
| 5.                               | 16EC7G5                         | High Speed digital design                  |  |  |  |  |
| 6.                               | 16EC7G6                         | MEMS and Smart Systems                     |  |  |  |  |

| OPEN ELECTIVES |      |             |                                                   |         |  |  |  |
|----------------|------|-------------|---------------------------------------------------|---------|--|--|--|
| Sl.            | Host | Course Code | Course Title                                      | Credits |  |  |  |
| No.            | Dept |             |                                                   |         |  |  |  |
| 1.             | BT   | 16G7H01     | Nanotechnology                                    | 3       |  |  |  |
| 2.             | CH   | 16G7H02     | Industrial Safety and Risk Management             | 3       |  |  |  |
| 3.             | CV   | 16G7H03     | Intelligent Transport System                      | 3       |  |  |  |
| 4.             | CS   | 16G7H04     | Intelligent Systems                               | 3       |  |  |  |
| 5.             | EC   | 16G7H05     | Image Processing and Machine Learning             | 3       |  |  |  |
| 6.             | EE   | 16G7H06     | Design of Renewable Energy Systems                | 3       |  |  |  |
| 7.             | IM   | 16G7H07     | Systems Engineering                               | 3       |  |  |  |
| 8.             | EI   | 16G7H08     | MEMS and Applications                             | 3       |  |  |  |
| 9.             | IS   | 16G7H09     | Introduction to Internet of Things                | 3       |  |  |  |
| 10.            | ME   | 16G7H10     | Industry 4.0 – Smart Manufacturing for The Future | 3       |  |  |  |
| 11.            | TE   | 16G7H11     | Space Technology and Applications                 | 3       |  |  |  |
| 12.            | MA   | 16G7H12     | Advanced linear Algebra                           | 3       |  |  |  |
| 13.            | PY   | 16G7H13     | Thin Film Nanotechnology                          | 3       |  |  |  |
| 14.            | CY   | 16G7H14     | Engineering Materials for Advanced Technology     | 3       |  |  |  |
| 15.            | HSS  | 16G7H15     | Applied Psychology for Engineers                  | 3       |  |  |  |
| 16.            | HSS  | 16G7H16     | Foundational Course on Entrepreneurship           | 3       |  |  |  |
| 17.            | AS   | 16G7H17     | Unmanned Aerial Vehicles                          | 3       |  |  |  |

|               | Semester: VII                                                                                    |   |     |              |                     |   |            |
|---------------|--------------------------------------------------------------------------------------------------|---|-----|--------------|---------------------|---|------------|
|               | MICROWAVE AND RADIATING SYSTEMS                                                                  |   |     |              |                     |   |            |
|               |                                                                                                  |   | (Th | eory and Pra | actice)             |   |            |
| Cou           | Course Code         :         16EC71         CIE         :         100+ 50 Marks                 |   |     |              |                     |   |            |
| Crec          | Credits: L:T:P:S         :         4:0:1:0         SEE         :         100+50 Marks            |   |     |              |                     |   |            |
| Total Hours : |                                                                                                  | : | 46L |              | <b>SEE Duration</b> | : | 3.00 Hours |
|               |                                                                                                  |   |     |              |                     |   |            |
| Cou           | Course Learning Objectives: The students will be able to                                         |   |     |              |                     |   |            |
| 1             | 1 Apply the knowledge of fields and waves to develop concepts of transmission line theory.       |   |     |              |                     |   |            |
| 2             | 2 Describe the basic operation of microwave devices.                                             |   |     |              |                     |   |            |
| 3             | 3 Describe the radiation from isolated, linear wire antennas and from linear elements near or on |   |     |              |                     |   |            |
|               | a conducting surface.                                                                            |   |     |              |                     |   |            |
| 4             | 4 Calculate the fundamental parameters for antennas and the radiation field from an antenna      |   |     |              |                     |   |            |
|               | using potential functions.                                                                       |   |     |              |                     |   |            |
|               |                                                                                                  |   |     |              |                     |   |            |
|               |                                                                                                  |   | T   | • • 4 T      |                     |   | 00.11      |

| Transmission Lines : Introduction, transmission lines equations and solutions, termination of line by infinite line, by characteristic impedance, short circuit line, open circuit line and any load resistive impedance , input impedance reflection and transmission coefficients, standing waves and SWR(at both load end and generator end).         Unit – II       09 Hrs         Impedance Transforms and Matching: Quarter wave transforms, Smith chart construction and properties, Single stub matching.         Microwave Waveguides: Introduction, TE, TM waves Rectangular waveguides (quantitative analysis TE, TM modes), circular waveguides (quantitative analysis), dominant modes, group velocity phase velocity, and wave impedance, Microwave cavities (quantitative analysis), resonant frequency.         S-parameters: Introduction, properties of S matrix (qualitative analysis)         Unit – III       09 Hrs         Microwave Passive Devices: Waveguide Tee's, Directional couplers, circulators, power divider, Isolators (Faraday isolator), phase shifters (Rotatory type), Attenuators (Rotatory type), (s-parameters of all devices)       09 Hrs         Microwave Sources: Multicavity Klystron amplifier, Reflex klystron oscillator       RF Amplifiers and Front End Modules for Communications – Gain and Output Power, Return Loss and Reverse Isolation, Noise Figure, Harmonics, Theory of Inter-modulation Distortion and measurement, Efficiency.         Unit –IV       09 Hrs |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| by infinite line, by characteristic impedance, short circuit line, open circuit line and any load resistive impedance ,input impedance reflection and transmission coefficients, standing waves and SWR(at both load end and generator end).           Unit – II         09 Hrs           Impedance Transforms and Matching: Quarter wave transforms, Smith chart construction and properties, Single stub matching.         Og Hrs           Microwave Waveguides: Introduction, TE, TM waves Rectangular waveguides (quantitative analysis TE, TM modes), circular waveguides (quantitative analysis), dominant modes, group velocity phase velocity, and wave impedance, Microwave cavities (quantitative analysis), resonant frequency.           S-parameters: Introduction, properties of S matrix (qualitative analysis)         O9 Hrs           Microwave Passive Devices: Waveguide Tee's, Directional couplers, circulators, power divider, Isolators (Faraday isolator), phase shifters (Rotatory type), Attenuators (Rotatory type), (s-parameters of all devices)         O9 Hrs           Microwave Sources: Multicavity Klystron amplifier, Reflex klystron oscillator         RF Amplifiers and Front End Modules for Communications – Gain and Output Power, Return Loss and Reverse Isolation, Noise Figure, Harmonics, Theory of Inter-modulation Distortion and measurement, Efficiency.                                                                                                                   |
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| Microwave Waveguides:       Introduction, TE, TM waves Rectangular waveguides (quantitative analysis TE, TM modes), circular waveguides (quantitative analysis), dominant modes, group velocity phase velocity, and wave impedance, Microwave cavities (quantitative analysis), resonant frequency.         S-parameters:       Introduction, properties of S matrix (qualitative analysis)         Unit –III       09 Hrs         Microwave Passive Devices:       Waveguide Tee's, Directional couplers, circulators, power divider, Isolators (Faraday isolator), phase shifters (Rotatory type), Attenuators (Rotatory type), (s-parameters of all devices)         Microwave Sources:       Multicavity Klystron amplifier, Reflex klystron oscillator         RF Amplifiers and Front End Modules for Communications – Gain and Output Power, Return Loss and Reverse Isolation, Noise Figure, Harmonics, Theory of Inter-modulation Distortion and measurement, Efficiency.       09 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| analysis TE, TM modes), circular waveguides (quantitative analysis), dominant modes, group<br>velocity phase velocity, and wave impedance, Microwave cavities (quantitative analysis), resonant<br>frequency.<br>S-parameters: Introduction, properties of S matrix (qualitative analysis)<br>Unit –III 09 Hrs<br>Microwave Passive Devices: Waveguide Tee's, Directional couplers, circulators, power divider,<br>Isolators (Faraday isolator), phase shifters (Rotatory type), Attenuators (Rotatory type), (s-<br>parameters of all devices)<br>Microwave Sources: Multicavity Klystron amplifier, Reflex klystron oscillator<br>RF Amplifiers and Front End Modules for Communications – Gain and Output Power, Return<br>Loss and Reverse Isolation, Noise Figure, Harmonics, Theory of Inter-modulation Distortion and<br>measurement, Efficiency.<br>Unit–IV 09 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| velocity phase velocity, and wave impedance, Microwave cavities (quantitative analysis), resonant<br>frequency.<br>S-parameters: Introduction, properties of S matrix (qualitative analysis)<br>Unit –III 09 Hrs<br>Microwave Passive Devices: Waveguide Tee's, Directional couplers, circulators, power divider,<br>Isolators (Faraday isolator), phase shifters (Rotatory type), Attenuators (Rotatory type), (s-<br>parameters of all devices)<br>Microwave Sources: Multicavity Klystron amplifier, Reflex klystron oscillator<br>RF Amplifiers and Front End Modules for Communications – Gain and Output Power, Return<br>Loss and Reverse Isolation, Noise Figure, Harmonics, Theory of Inter-modulation Distortion and<br>measurement, Efficiency.<br>Unit–IV 09 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| frequency.         S-parameters: Introduction, properties of S matrix (qualitative analysis)         Unit –III       09 Hrs         Microwave Passive Devices: Waveguide Tee's, Directional couplers, circulators, power divider, Isolators (Faraday isolator), phase shifters (Rotatory type), Attenuators (Rotatory type), (s-parameters of all devices)         Microwave Sources: Multicavity Klystron amplifier, Reflex klystron oscillator         RF Amplifiers and Front End Modules for Communications – Gain and Output Power, Return Loss and Reverse Isolation, Noise Figure, Harmonics, Theory of Inter-modulation Distortion and measurement, Efficiency.         Unit –IV       09 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| S-parameters: Introduction, properties of S matrix (qualitative analysis)       09 Hrs         Unit –III       09 Hrs         Microwave Passive Devices: Waveguide Tee's, Directional couplers, circulators, power divider, Isolators (Faraday isolator), phase shifters (Rotatory type), Attenuators (Rotatory type), (s-parameters of all devices)         Microwave Sources: Multicavity Klystron amplifier, Reflex klystron oscillator         RF Amplifiers and Front End Modules for Communications – Gain and Output Power, Return Loss and Reverse Isolation, Noise Figure, Harmonics, Theory of Inter-modulation Distortion and measurement, Efficiency.         Unit –IV       09 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| Unit –III09 HrsMicrowave Passive Devices: Waveguide Tee's, Directional couplers, circulators, power divider,<br>Isolators (Faraday isolator), phase shifters (Rotatory type), Attenuators (Rotatory type), (s-<br>parameters of all devices)Microwave Sources: Multicavity Klystron amplifier, Reflex klystron oscillatorRF Amplifiers and Front End Modules for Communications – Gain and Output Power, Return<br>Loss and Reverse Isolation, Noise Figure, Harmonics, Theory of Inter-modulation Distortion and<br>measurement, Efficiency.Unit –IV09 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| Microwave Passive Devices: Waveguide Tee's, Directional couplers, circulators, power divider, Isolators (Faraday isolator), phase shifters (Rotatory type), Attenuators (Rotatory type), (s-parameters of all devices)         Microwave Sources: Multicavity Klystron amplifier, Reflex klystron oscillator         RF Amplifiers and Front End Modules for Communications – Gain and Output Power, Return Loss and Reverse Isolation, Noise Figure, Harmonics, Theory of Inter-modulation Distortion and measurement, Efficiency.         Unit –IV       09 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| Isolators (Faraday isolator), phase shifters (Rotatory type), Attenuators (Rotatory type), (s-<br>parameters of all devices)<br><b>Microwave Sources:</b> Multicavity Klystron amplifier, Reflex klystron oscillator<br><b>RF Amplifiers and Front End Modules for Communications</b> – Gain and Output Power, Return<br>Loss and Reverse Isolation, Noise Figure, Harmonics, Theory of Inter-modulation Distortion and<br>measurement, Efficiency.<br><b>Unit –IV</b> 09 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| parameters of all devices)<br>Microwave Sources: Multicavity Klystron amplifier, Reflex klystron oscillator<br>RF Amplifiers and Front End Modules for Communications – Gain and Output Power, Return<br>Loss and Reverse Isolation, Noise Figure, Harmonics, Theory of Inter-modulation Distortion and<br>measurement, Efficiency.<br>Unit –IV 09 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| Microwave Sources: Multicavity Klystron amplifier, Reflex klystron oscillator         RF Amplifiers and Front End Modules for Communications – Gain and Output Power, Return         Loss and Reverse Isolation, Noise Figure, Harmonics, Theory of Inter-modulation Distortion and measurement, Efficiency.       09 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| <b>RF Amplifiers and Front End Modules for Communications</b> – Gain and Output Power, Return Loss and Reverse Isolation, Noise Figure, Harmonics, Theory of Inter-modulation Distortion and measurement, Efficiency.         Unit –IV       09 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| Loss and Reverse Isolation, Noise Figure, Harmonics, Theory of Inter-modulation Distortion and measurement, Efficiency. Unit –IV 09 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| Unit –IV     09 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| Unit –IV 09 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| a company and the second se                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| Antenna Basics: Introduction, antenna radiation mechanism, basic Antenna parameters, patterns,                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| beam area, radiation intensity, beam efficiency, diversity and gain, antenna apertures, effective                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| height, bandwidth, radiation, efficiency, antenna temperature and antenna field zones. Wire                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| Antennas: Electric dipoles: Introduction, short electric dipole (fields, power density, power radiated,                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| directivity, radiation resistance), Half wave dipoles(field: qualitative analysis power density, power                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| radiated, directivity, radiation resistance).                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| Unit – V IO Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| Antenna Arrays: Introduction, pattern multiplication, Array of two isotropic point sources, N                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| element linear array with uniform spacing and phase(Array factor), Broadside and end fire                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| array(Directivity, location of beam with, Beam width, etc.). Antenna Types: Folded dipole, Yagi-                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| (Qualitative analysis only Construction working)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| (Quantative analysis only: Construction, working).                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| Practical's: Microwayos and Padiating systems lab                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| 1 Study of mode curves of Reflex klystron source                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| <ol> <li>Design and Simulation of Patch Antenna (coavial feed). Dipole and Horn antenna using HFSS.</li> </ol>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| 3 Radiation Characteristics of Pyramidal Horn Antenna (X-hand)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |

- 4. Characterization of Ring resonator, Power divider, Microwave Directional Coupler and Hybrid coupler (Strip line type, C-band)
- 5. Design and Simulation of Waveguide Magic-Tee using HFSS
- 6. Characterization of Microwave Magic Tee, Directional Coupler, Circulator, Tunable Attenuator and Isolator (Waveguide type, X-band)
- 7. Radiation characteristics of Log-periodic and Yagi antenna (C-band)
- 8. Radiation characteristics of Microstrip Patch and Printed Dipole Antenna(X-band)
- 9. Design and Simulation of a Printed Hybrid Ring using HFSS
- 10. Characterization of Lowpass, bandpass and band stop filters (C-Band)

| Course      | e Outcomes: After completing the course, the students will be able to                  |
|-------------|----------------------------------------------------------------------------------------|
| CO1:        | Explain and summarize the working of transmission line, Waveguides, Microwave Passive  |
|             | Devices and Antennas                                                                   |
| <b>CO2:</b> | Analyze wave propagation in transmission line, Waveguides and characterize the passive |
|             | microwave components and Antennas.                                                     |
| CO3:        | Design the transmission lines, passive microwave components and Antennas for given     |
|             | specification and also match the impedance.                                            |
| <b>CO4:</b> | Evaluate S-Parameter, VSWR for transmission lines, Microwave components and radiation  |
|             | pattern for Antennas.                                                                  |

| Refer | ence Books                                                                          |
|-------|-------------------------------------------------------------------------------------|
| 1     | Microwave Engineering, David M Pozar, John Wiley, 3rd Edition, 2004, ISBN-13: 978-  |
| L     | 0471644514                                                                          |
| 2     | Antenna Theory and Design, C A Balanis, John Wiley & sons, Inc. publication, 3rd    |
| 2     | Edition,2005,ISBN-13: 978-0471667827                                                |
| 2     | National Instruments, 'Basics of Power Amplifier and Front End Module Measurements' |
| 3     | White paper, http://www.ni.com/rf/                                                  |
| 4     | Foundations of Microwave Engineering, R E Collin, IEEE Press on Electromagnetic and |
| 4     | Wave Theory, 2 <sup>nd</sup> Edition, ISBN-13: 978-0-7803-6031-0/ 0-7803-6031-1     |
| 5     | Antennas, John D.Krauss, McGraw-Hill International Edition, 3rd Edition, 2006.ISBN- |
|       | 13: 978-0071232012                                                                  |

CIE is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for Assignment/Presentation/Project is 10.

Total CIE is 30(Q) +60(T) +10(A) =100 Marks.

#### Scheme of Continuous Internal Evaluation (CIE); Practical Test for 50 Marks

The Laboratory session is held every week as per the time table and the performance of the student is evaluated in every session. The average marks (AM) over number of weeks is considered for 30 marks. At the end of the semester a test (T) is conducted for 10 marks. The students are encouraged to implement additional innovative experiments (IE) in the lab and are rewarded for 10 marks. Total marks for the laboratory is 50.

Total CIE is 30(AM) +10 (T) +10 (IE) =50 Marks.

#### Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marks is executed by means of an examination. The Question paper for the course contains two parts, Part - A and Part - B. Part - A consists of objective type questions for 20 marks covering

the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

#### Scheme of Semester End Examination (SEE); Practical Exam for 50 Marks

SEE for the practical courses will be based on experiment conduction with proper results, is evaluated for 40 marks and Viva is for 10 marks. Total SEE for laboratory is 50 marks.

#### Semester End Evaluation (SEE): Theory (100 Marks) + Practical (50 Marks) = Total 150 Marks

|       | CO-PO Mapping |     |     |            |     |            |            |            |            |      |      |      |
|-------|---------------|-----|-----|------------|-----|------------|------------|------------|------------|------|------|------|
| CO/PO | <b>PO1</b>    | PO2 | PO3 | <b>PO4</b> | PO5 | <b>PO6</b> | <b>PO7</b> | <b>PO8</b> | <b>PO9</b> | PO10 | PO11 | PO12 |
| CO1   | 3             | 2   | -   | -          | -   | -          | 2          | -          | -          | 2    | -    | 1    |
| CO2   | 3             | 2   | 2   | 1          | -   | -          | 2          | -          | -          | 2    | -    | 1    |
| CO3   | 3             | 3   | 2   | 2          | -   | -          | 2          | -          | -          | 2    | -    | 1    |
| CO4   | 3             | 3   | 3   | 3          | -   | -          | 2          | -          | -          | 2    | -    | 1    |

|                |                                                                                               |             |                        | Semester: VII             |                    |      |                      |
|----------------|-----------------------------------------------------------------------------------------------|-------------|------------------------|---------------------------|--------------------|------|----------------------|
|                |                                                                                               |             | BROAD                  | BAND WIRELESS             | 5 -LTE 4G          |      |                      |
|                |                                                                                               |             |                        | (Theory)                  |                    |      |                      |
| Cou            | rse Code                                                                                      | :           | 16EC72                 | C                         | CIE                | ••   | 100 Marks            |
| Cred           | lits: L:T:P:S                                                                                 | :           | 4:0:0:0                | S                         | EE                 | :    | 100 Marks            |
| Tota           | l Hours                                                                                       | :           | 46L                    | S                         | <b>EE Duration</b> | :    | 03 Hours             |
| Cou            | rse Learning (                                                                                | )bj         | ectives: The stud      | lents will be able to     |                    |      |                      |
| 1              | Identify real l                                                                               | ife         | channels and stat      | tistical characterizati   | ion for them.      |      |                      |
| 2              | Identify GSM                                                                                  | l, it       | s physical layer a     | ind call processing a     | s well as scenari  | os a | ind services.        |
| 3              | Analyze the Synchronizati                                                                     | on.         | concept and a          | pplications of spi        | read spectrum      | te   | chniques including   |
| 4              | Identify physic                                                                               | ical        | layer and call pr      | ocessing protocols f      | for cellular CDM   | A.   |                      |
|                |                                                                                               |             |                        | TT *4 T                   |                    |      | 00 Шта               |
| Dovi           | ow of Logoov                                                                                  | 2-10        | toma                   | Unit-I                    |                    |      | 09 Hrs               |
| Kevi           | ew of Legacy :                                                                                | Sys<br>TT   | tems                   | M. Cincle comion ED       |                    |      | EDE Channel          |
| <b>Key</b>     | Enablers for I                                                                                | - 1 1<br>   | L leatures: OFD        | ing Multiontonno T        | JMA, Single cari   | ner  | FDE, Channel         |
| Arch           | itengure I TE                                                                                 | N IS<br>Nat | work Architectu        | nig, Munitantenna To      | echniques, ir ba   | seu  | Flat network         |
| Wire           | less Fundame                                                                                  | nte         | <b>Is</b> Cellular con | cent Broadband wir        | reless channel (F  | X    | C) Fading in BWC     |
| Mod            | eling BWC _                                                                                   | Бm          | nirical and Stati      | stical models. Mitic      | gation of Narroy   | v h  | and and Broadband    |
| Fadir          |                                                                                               |             | ipiliear and Stati     | stical models, writig     |                    | v U  | and and Droadband    |
| 1 uun          | -8                                                                                            |             | T                      | Init – II                 |                    |      | 09 Hrs               |
| Mult           | ticarrier Mo                                                                                  | հոլ         | ation: OFDM            | basics. OFDM i            | in LTE. Timi       | ng   | and Frequency        |
| Sync           | hronization. PA                                                                               | AR.         | SC-FDE.                |                           | ,                  | 8    |                      |
| OFD            | MA and SC-F                                                                                   | DN          | A: OFDM with           | FDMA. TDMA. CI            | DMA. OFDMA.        | SC   | -FDMA. OFDMA         |
| and S          | SC-FDMA in L                                                                                  | TE          |                        | 7 7 -                     | 7 - 7              |      | <b>y</b> –           |
| Mult           | tiple Antenna                                                                                 | Tra         | ansmission and         | <b>Reception:</b> Spatial | Diversity overv    | iew  | , Receive Diversity, |
| Tran           | smit Diversity,                                                                               | Int         | erference cancell      | ation and signal enh      | ancement, Spati    | al N | Aultiplexing, Choice |
| betw           | een Diversity,                                                                                | Inte        | erference suppres      | sion and Spatial Mu       | ltiplexing         |      | 1 6,                 |
| -              | <b>.</b>                                                                                      |             | U U                    | Init –III                 | 1 0                |      | 09 Hrs               |
| Over           | view and Ch                                                                                   | anr         | nel Structure of       | LTE: Introduction         | n to LTE, Chan     | nel  | Structure of LTE,    |
| Dow            | nlink OFDMA                                                                                   | Ra          | dio Resource, Up       | olink SC-FDMA Rad         | dio Resource .     |      |                      |
| Dow            | nlink Transp                                                                                  | ort         | <b>Channel Proce</b>   | essing: Overview,         | Downlink share     | d    | channels, Downlink   |
| Cont           | rol Channels, E                                                                               | Broa        | adcast channels, l     | Multicast channels, I     | Downlink physic    | al c | channels, H-ARQ on   |
| Dow            | nlink                                                                                         |             |                        |                           |                    |      |                      |
|                |                                                                                               |             | U                      | Init –IV                  |                    |      | 10 Hrs               |
| Upli           | nk Channel 7                                                                                  | [ <b>ra</b> | nsport Processi        | ng: Overview, Upl         | link shared char   | nne  | ls, Uplink Control   |
| Infor          | mation, Uplink                                                                                | Re          | eference signals,      | Random Access Cha         | annels, H-ARQ o    | on u | ıplink               |
| Phys           | ical Layer Pro                                                                                | oce         | dures: Hybrid –        | ARQ procedures, C         | Channel Quality I  | ndi  | cator CQI feedback,  |
| Prece          | Precoder for closed loop MIMO Operations, Uplink channel sounding, Buffer status Reporting in |             |                        |                           |                    |      |                      |
| uplin          | k, Scheduling                                                                                 | an          | d Resource Allo        | ocation, Cell Search      | h, Random Acc      | ess  | Procedures, Power    |
| Cont           | Control in uplink.                                                                            |             |                        |                           |                    |      |                      |
| Unit –V 09 Hrs |                                                                                               |             |                        |                           |                    |      |                      |
| Radi           | o Resource M                                                                                  | ana         | agement and Mo         | bility Managemen          | t:                 | _    |                      |
| PDC            | PDCP overview, MAC/RLC overview, RRC overview, Mobility Management, Inter-cell                |             |                        |                           |                    |      |                      |
| Inter          | Interference Coordination                                                                     |             |                        |                           |                    |      |                      |
| C              | 0.4                                                                                           |             | <b>y 1 1 1</b>         | 1 41 4 1                  |                    |      |                      |
| Cou            | rse Outcomes:                                                                                 | Af          | ter completing t       | ne course, the stud       | ents will be able  | e to |                      |
|                | : Associate to                                                                                | erm         | s in the system a      | renitecture to the fur    | nctional standard  | . sp | ecified in LIE 4G.   |
|                | : Analyze the                                                                                 | e ro        | ble of LTE radio       | interface protocols a     | and EPS Data co    | onv  | ergence protocols to |

set up, reconfigure and release data and voice from users.CO3:Demonstrate the UTRAN and EPS handling processes from set up to release including

|             | mobility management for a variety of data call scenarios.                           |
|-------------|-------------------------------------------------------------------------------------|
| <b>CO4:</b> | Test and Evaluate the Performance of resource management and packet data processing |
|             | and transport algorithms.                                                           |

| Reference Books |                                                                                                                                                             |  |  |  |  |  |  |
|-----------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|--|--|--|--|
| 1               | Fundamentals of LTE, Arunabha Ghosh, Jan Zhang, Jefferey Andrews, Riaz Mohammed,<br>Prentice Hall, Communications Engg and Emerging Technologies.           |  |  |  |  |  |  |
| 2               | LTE for UMTS Evolution to LTE-Advanced', Harri Holma and Antti Toskala,, 2 <sup>nd</sup> Edition - 2011, John Wiley & Sons, Ltd. Print ISBN: 9780470660003. |  |  |  |  |  |  |

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#### Total CIE is 30(Q) +60(T) +10(A) =100 Marks.

#### Semester End Evaluation (SEE); Theory (100 Marks)

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|       | CO-PO Mapping |     |     |     |     |            |            |            |            |      |      |      |
|-------|---------------|-----|-----|-----|-----|------------|------------|------------|------------|------|------|------|
| CO/PO | <b>PO1</b>    | PO2 | PO3 | PO4 | PO5 | <b>PO6</b> | <b>PO7</b> | <b>PO8</b> | <b>PO9</b> | PO10 | PO11 | PO12 |
| CO1   | 3             | 2   | -   | -   | -   | -          | 2          | -          | -          | 2    | -    | 3    |
| CO2   | 3             | 2   | 2   | 1   | -   | -          | 2          | -          | -          | 2    | -    | 3    |
| CO3   | 3             | 3   | 2   | 2   | -   | -          | 2          | -          | -          | 2    | -    | 3    |
| CO4   | 3             | 3   | 3   | 3   | -   | -          | 2          | -          | -          | 2    | -    | 3    |

|                     | VII Semester                                                                        |      |                  |                                   |                        |   |           |  |
|---------------------|-------------------------------------------------------------------------------------|------|------------------|-----------------------------------|------------------------|---|-----------|--|
|                     |                                                                                     |      |                  | MINOR PROJECT                     |                        |   |           |  |
| Cour                | rse Code                                                                            | ••   | 16EC73P          |                                   | CIE                    |   | 100 Marks |  |
| Credits: L: T: P: S |                                                                                     | :    | 0:0:3:0          |                                   | SEE                    | : | 100 Marks |  |
| Hrs/week            |                                                                                     | :    | 06               |                                   | SEE Duration           | : | 3 Hours   |  |
| Cour                | rse Learning O                                                                      | bje  | ctives: The st   | udents will be able to            |                        |   |           |  |
| 1                   | Create interest in                                                                  | n in | novative devel   | opments and preferably interdisci | plinary field.         |   |           |  |
| 2                   | Work independe                                                                      | entl | y, analyze, eva  | luate and solve the given problem |                        |   |           |  |
| 3                   | Inculcate the ski                                                                   | lls  | for good preser  | ntation and improve the technical | report writing skills. |   |           |  |
| 4                   | 4 Recognize the need for planning, preparation, management and financial budgeting. |      |                  |                                   |                        |   |           |  |
| 5                   | Acquire collabo                                                                     | rati | ve skills throug | h working in a team to achieve co | ommon goals.           |   |           |  |

#### Mini Project Guidelines:

- 1. Each project group will have two to four students, they can form their groups amongst their class.
- 2. Each group has to select a current topic that will use the technical knowledge of their program of study after intensive literature survey.
- 3. Guides will be allotted by the department based on the topic chosen.
- 4. The project should result in system/module which can be demonstrated, using the available resources in the college.
- 5. The CIE evaluation will be done by the committee constituted by the department. The committee shall consist of respective guide & two senior faculty members as examiners. The evaluation will be done for each student separately.
- 6. The final copy of the report should be submitted after incorporation of any modifications suggested by the evaluation committee

#### Guidelines for Evaluation:

#### **CIE Assessment:**

The following are the weightages given for the various stages of the project:

- 1. Selection of the topic and formulation of objectives: 10%
- 2. Design and Development of Project methodology: 30%
- 3. Execution of Project: 30%
- 4. Presentation, Demonstration and Discussion: 20%
- 5. Report Writing:10%

#### **Evaluation will be carried out in three phases:**

| Phase | Activity                                                                       | Weightage |
|-------|--------------------------------------------------------------------------------|-----------|
| Ι     | Synopsis submission, approval of the selected topic, formulation of objectives | 20%       |
| II    | Mid-term evaluation to review the progress of work and documentation           | 30%       |
| III   | Submission of report, Final presentation and demonstration                     | 50%       |

#### **SEE** Assessment:

The following are the weightages given during SEE Examination:

- 1. Written presentation of synopsis:10%
- 2. Presentation/Demonstration of the project: 30%
- 3. Methodology and Discussion: 30%
- 4. Technical Report: 10%
- 5. Viva Voce: 20%

#### **Course Outcomes of Mini Project:**

|   | <b>V</b>                                                             |
|---|----------------------------------------------------------------------|
| 1 | Define Specifications, Conceptualize, Design and implement a project |
| 2 | Communicate the work carried out as a technical report and orally    |
| 3 | Work in a team and contribute to team work                           |
| 4 | Indulge in self-learning and be motivated for life-long learning     |

|                                                                                                   |                                                                                                         |            |                        | Semester: VII                                           |                       |           |                         |
|---------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------|------------|------------------------|---------------------------------------------------------|-----------------------|-----------|-------------------------|
|                                                                                                   |                                                                                                         |            | SATELLITE              | COMMUNICA                                               | TIONS & GPS           |           |                         |
| a                                                                                                 | ~ .                                                                                                     | -          | (Group F:              | Professional Co                                         | ore Elective)         | 1         | 100 1 1                 |
| Cou                                                                                               | rse Code                                                                                                | :          | 16EC7F1                |                                                         | CIE                   | :         | 100 Marks               |
| Cred                                                                                              | lits: L:T:P:S                                                                                           | :          | 4:0:0:0                |                                                         | SEE                   | :         | 100 Marks               |
| Tota                                                                                              | l Hours                                                                                                 | :          | 50L                    |                                                         | SEE Duration          | :         | 03 Hours                |
| Cou                                                                                               | rse Learning Ob                                                                                         | jec        | tives: The studer      | nts will be able to                                     |                       |           |                         |
| 1                                                                                                 | Understand the                                                                                          | Sat        | ellite orbits and o    | orbital perturbation                                    | ons.                  |           |                         |
| 2                                                                                                 | Analyze link po                                                                                         | we         | r budget calculat      | ions and losses in                                      | the atmosphere.       |           |                         |
| 3                                                                                                 | Understand the                                                                                          | con        | nponents of the s      | satellite in space a                                    | and Earth stations    |           |                         |
| 4                                                                                                 | Analyze Fixed (                                                                                         | Coc        | ordinate System a      | and GPS C/A Coo                                         | de Signal Structure   | e         |                         |
|                                                                                                   |                                                                                                         |            |                        | []                                                      |                       |           | 10 Hug                  |
| Orres                                                                                             | . View of Setelli                                                                                       | to 6       | watana Introdu         | UIIII-I                                                 | allocation Vanla      | 1.000     | IV IIIS                 |
| Over                                                                                              | r view of Satelli                                                                                       | te S       | ystems: Introdu        | iction, frequency                                       | allocation, Kepler    |           | s, definitions, orbital |
| elem                                                                                              | ent, apogee and                                                                                         | per        | and least most         | bit perturbations,                                      | inclined orbits, c    |           | Casatationary arbity    |
| Intro                                                                                             | duction ontenno                                                                                         | pi<br>1ec  | ane, local mean        | n unne and sun                                          | synchronous ord       | IIS,      | Geostationary orbit:    |
| Intro                                                                                             | duction, antenna,                                                                                       | 100        | ok angles, polar i     | mx antenna, mm                                          | is of visibility, ear | th e      | cupse of saterifie, sun |
| trans                                                                                             | n outage.                                                                                               |            | T                      | nit II                                                  |                       |           | 10 Um                   |
| Dron                                                                                              | agation Impair                                                                                          | nor        | U.<br>Its and Space Li | int – II<br>ink: Introduction                           | atmospheric loss      | iot       | IV IIIS                 |
| ottop                                                                                             | ustion other im                                                                                         | nei        | monte Space L          | ink: Introduction                                       | , autiospheric loss   |           | n lossos link nowor     |
| buda                                                                                              | at system noise                                                                                         | ран<br>СМ  | P uplink down          | link affects of r                                       | in, EINF, transmis    | 551U<br>D | ii iosses, iiik powei   |
| buug                                                                                              | et, system noise,                                                                                       |            | K, upinik, uowi        | nit III                                                 | ani, comoneu Civi     | <u>.</u>  | 10 Um                   |
| Snor                                                                                              | Somont. Intr                                                                                            | du         | otion nower sur        | nly unite altitud                                       | a control station     | kaai      | ing thermal control     |
|                                                                                                   | C transponders                                                                                          | onte       | enon, power sup        | Forth Segment: I                                        | ntroduction receiv    |           | nly home TV system      |
| outde                                                                                             | or unit indoor u                                                                                        | anu<br>nit | MATY CATY              | Tx = Rx earth st                                        | ation                 |           | iny nome i v system,    |
| outu                                                                                              |                                                                                                         | mi,        |                        | $\frac{1}{1} = \frac{1}{1} = \frac{1}{1} = \frac{1}{1}$ |                       |           | 10 Hrs                  |
| GPS                                                                                               | · Introduction Hi                                                                                       | isto       | rv of GPS Devel        | opment A Basic                                          | GPS Receiver An       | nro       | aches of Presentation   |
| Softy                                                                                             | vare Approach                                                                                           | Po         | tential Advanta        | opinion, reduse                                         | tware Approach        | R         | asic GPS Concent:       |
| Intro                                                                                             | duction GPS Per                                                                                         | for        | mance Requirem         | ents Basic GPS                                          | Concept Basic Ed      | niat      | ions for Finding User   |
| Posit                                                                                             | ion Measureme                                                                                           | nt of      | of Pseudo-range        | Solution of Us                                          | er Position from      | Pse       | udo-ranges Position     |
| Solu                                                                                              | tion with more                                                                                          | tha        | n Four Satellite       | es. User Position                                       | in Spherical Co       | oord      | linate System. Earth    |
| Geor                                                                                              | netry. Basic Rela                                                                                       | tior       | ships in an Ellip      | se. Calculation of                                      | f Altitude. Calculat  | tion      | of Geodetic Latitude.   |
| Calc                                                                                              | ulation of a Point                                                                                      | on         | the Surface of t       | he Earth. Satellite                                     | e Selection. Diluti   | on        | of Precision. Satellite |
| Cons                                                                                              | stellation: Introd                                                                                      | ucti       | on, Control Seg        | ment of the GPS                                         | System, Satellite     | Cor       | stellation, Maximum     |
| Diffe                                                                                             | erential Power Le                                                                                       | vel        | from Different         | Satellites, Sidere                                      | al Day, Doppler F     | Freq      | uency Shift, Average    |
| Rate                                                                                              | of Change of the                                                                                        | Do         | ppler Frequency        | , Maximum Rate                                          | of Change of the      | Dot       | opler Frequency, Rate   |
| of C                                                                                              | hange of the Dop                                                                                        | ople       | r Frequency Du         | e to User Accele                                        | ration, Kepler's E    | Eque      | tion, True and Mean     |
| Anomaly, Signal Strength at User Location.                                                        |                                                                                                         |            |                        |                                                         |                       |           |                         |
|                                                                                                   |                                                                                                         |            | U                      | nit –V                                                  |                       |           | 10 Hrs                  |
| Eart                                                                                              | h-Centered, Ear                                                                                         | th-        | Fixed Coordina         | te System : Intro                                       | duction, Direction    | n Co      | osine Matrix, Satellite |
| Orbit Frame to Equator Frame Transform, Vernal Equinox, Earth Rotation, Overall Transform from    |                                                                                                         |            |                        |                                                         |                       |           |                         |
| Orbit Frame to Earth-Centered, Earth-Fixed Frame, Perturbations, Correction of GPS System Time of |                                                                                                         |            |                        |                                                         |                       |           |                         |
| Tran                                                                                              | Transmission, Calculation of Satellite Position, Coordinate Adjustment for Satellites, Ephemeris Data.: |            |                        |                                                         |                       |           |                         |
| GPS                                                                                               | C/A Code Sign                                                                                           | nal        | Structure: Intro       | oduction, Transm                                        | nitting Frequency,    | Co        | de Division-Multiple    |
| Acce                                                                                              | ess (CDMA) Sign                                                                                         | als,       | P Code, C/A C          | ode and Data For                                        | rmat, Generation of   | of C      | A Code, Correlation     |
| Prop                                                                                              | erties of C/A Cod                                                                                       | le, I      | Navigation Data        | Bits, Telemetry                                         | (TLM) and Hand        | Ove       | r Word (HOW), GPS       |
| Time                                                                                              | Time and the Satellite Z Count, Parity Check Algorithm, Navigation Data from sub frame 1, Navigation    |            |                        |                                                         |                       |           |                         |

Data from subframes 2 and 3, Navigation Data from subframes 4 and 5-Support Data, Ionospheric

Model, Tropospheric Model, Selectivity Availability (SA) and Typical Position Errors.

| Course Outcomes: After completing the course, the students will be able to |                                                                             |  |  |  |  |  |
|----------------------------------------------------------------------------|-----------------------------------------------------------------------------|--|--|--|--|--|
| CO1:                                                                       | Analyse the basic concepts of orbital mechanics of satellites and GPS       |  |  |  |  |  |
| <b>CO2:</b>                                                                | Apply the basic concepts to solve problems in satellites and GPS            |  |  |  |  |  |
| CO3:                                                                       | Analyze various transmission losses and components of space & Earth Segment |  |  |  |  |  |
| CO4:                                                                       | Evaluate noise effect and Signal Structure of Satellite and GPS.            |  |  |  |  |  |

#### **Reference Books**

| 1 | Satellite Communications, Dennis Roddy, McGraw-Hill, 4 <sup>th</sup> Edition, 2006, ISBN 0-07-146298-8                                                           |
|---|------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 2 | Satellite Communications, Timothy Pratt, Charles Bostian and Jeremy Allnutt, John Wiley & Sons, 2 <sup>nd</sup> Edition, 2003, ISBN: 978-0-471-37007-9           |
| 3 | Fundamentals of Global Positioning System Receivers: A Software Approach James Bao-Yen, Tsui, John Wiley,2 <sup>nd</sup> Edition , 2005, ISBN: 978-0-471-70647-2 |
| 4 | Fundamentals of Satellite Communication, K. N. Raja Rao, PHI Learning Pvt. Ltd, 2 <sup>nd</sup> Edition, ISBN, 8120324013                                        |

#### Continuous Internal Evaluation (CIE); Theory (100 Marks)

**CIE** is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for Assignment/Presentation/Project is 10.

Total CIE is 30(Q) +60(T) +10(A) =100 Marks.

#### Semester End Evaluation (SEE); Theory (100 Marks)

**SEE** for 100 marks is executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

|       |            |     |     |     | CO-l | PO Ma      | pping      |            |            |      |      |      |
|-------|------------|-----|-----|-----|------|------------|------------|------------|------------|------|------|------|
| CO/PO | <b>PO1</b> | PO2 | PO3 | PO4 | PO5  | <b>PO6</b> | <b>PO7</b> | <b>PO8</b> | <b>PO9</b> | PO10 | PO11 | PO12 |
| CO1   | 3          | 2   | 2   | 2   | -    | -          | -          | -          | -          | 1    | -    | 1    |
| CO2   | 3          | 3   | 2   | 1   | -    | -          | -          | -          | -          | 1    | -    | 1    |
| CO3   | 3          | 1   | 2   | 1   | -    | -          | -          | -          | -          | 1    | -    | 1    |
| CO4   | 3          | 2   | 2   | 1   | -    | -          | -          | -          | -          | 1    | -    | 1    |

Low-1 Medium-2 High-3

|            | Semester: VII                                                                                |          |                     |                |              |    |           |  |
|------------|----------------------------------------------------------------------------------------------|----------|---------------------|----------------|--------------|----|-----------|--|
|            | ARM PROGRAMMING & OPTIMIZATION                                                               |          |                     |                |              |    |           |  |
|            | (Group F: Professional Core Elective)                                                        |          |                     |                |              |    |           |  |
| Cour       | Course Code : 16EC7F2 CIE : 100 Marks                                                        |          |                     |                | 100 Marks    |    |           |  |
| Cred       | lits: L:T:P:S                                                                                | :        | 4:0:0:0             |                | SEE          | :  | 100 Marks |  |
| Tota       | l Hours                                                                                      | :        | 50L                 |                | SEE Duration | :  | 03 Hours  |  |
| Cour       | Course Learning Objectives: The students will be able to                                     |          |                     |                |              |    |           |  |
| 1          | Discuss the b                                                                                | asic     | c principles of ARM | system design. |              |    |           |  |
| 2          | 2 Identify the major hardware components ARM data path architecture.                         |          |                     |                |              |    |           |  |
| 3          | 3 Identify the design issues ARM based embedded system with the basic knowledge of firmware, |          |                     |                |              |    |           |  |
|            | embedded OS & ARM architectures.                                                             |          |                     |                |              |    |           |  |
| 4          | 4 Analyze the execution of instructions/program knowing the basic principles of ARM          |          |                     |                |              |    |           |  |
|            | architecture and assembly language.                                                          |          |                     |                |              |    |           |  |
| 5          | 5 Compare programs written in C & assembly to execute on ARM platform.                       |          |                     |                |              |    |           |  |
|            |                                                                                              |          |                     |                |              |    |           |  |
|            |                                                                                              |          | Un                  | it-I           |              |    | 10 Hrs    |  |
| <b>T</b> . | 1 D .                                                                                        | <b>D</b> |                     | · · · · · ·    |              | τ. |           |  |

| Introduction, Data Path Architecture, Registers, Modes, Exceptions ARM Instruct               | tions: Data   |
|-----------------------------------------------------------------------------------------------|---------------|
| processing instructions, Branch instructions, Load store instructions, software interrupt     | instructions, |
| program status register instructions, loading constants, ARMv5E extension, and                | conditional   |
| execution. Thumb Instructions: Thumb register usage, ARM Thumb inter working, C               | Other branch  |
| instructions, data processing instructions, single register load store instructions, multiple | register load |
| store instructions, stack instructions, software interrupt instruction.                       |               |
| Unit – II                                                                                     | 10 Hrs        |

|                                                                                            | 10 111 5      |
|--------------------------------------------------------------------------------------------|---------------|
| Programming in C for ARM: Overview of C Compilers and optimization, basic C c              | lata types, C |
| looping structures, register allocation, function calls, pointer aliasing, structure arran | igement, bit  |
| fields, unaligned Data and Endianess, division, floating point, inline functions and inlin | ne assembly,  |
| portability issues.                                                                        |               |
|                                                                                            | 10 II.ma      |

| Unit –III                                                                                | 10 Hrs        |
|------------------------------------------------------------------------------------------|---------------|
| Writing and Optimizing ARM Assembly Code: Writing assembly code, profilin                | g and cycle   |
| counting, instruction scheduling, register allocation, conditional execution, looping co | nstructs, Bit |
| manipulation, efficient switches. Handling unaligned data                                |               |
| Unit_IV                                                                                  | 10 Hrs        |

| Cint –i v                                                                               | 10 1115       |
|-----------------------------------------------------------------------------------------|---------------|
| Digital Signal Processing on ARM: Representing a digital signal, Introduction to DSP of | on the ARM,   |
| FIR filters, Realization of filters on ARM7 and Cortex M3, IIR Filters, Realization     | of filters on |
| ARM7 and Cortex M3, CMSIS DSP Library                                                   |               |
|                                                                                         | 1             |

Unit –V10 HrsException and Interrupt Handling Exception Handling, Interrupts, Non-nested Interrupt handler,<br/>Re-entrant Interrupt handler Firmware & Boot loader Embedded Operating Systems Fundamental<br/>Components, Simple Operating System

| Course      | e Outcomes: After completing the course, the students will be able to                       |
|-------------|---------------------------------------------------------------------------------------------|
| CO1:        | Describe the programmer's model of ARM processor and analyse the instruction set            |
|             | architecture to realize complex operations.                                                 |
| <b>CO2:</b> | Apply the optimization methods available for ARM architectures to design embedded           |
|             | software to meet given constraints with the help of modern engineering tools.               |
| CO3:        | Realize real time signal processing applications & primitive OS operations on different ARM |
|             | architectures by making use of software libraries.                                          |
| <b>CO4:</b> | Engage in self-study to formulate, design, implement, analyze and demonstrate an            |
|             | application realized on ARM development boards through assignments.                         |

| Refer | ence Books                                                                                        |
|-------|---------------------------------------------------------------------------------------------------|
| 1     | ARM System Developers Guide, Andrew N Sloss, Dominic Symes, Chris Wright, Elsevier,               |
| 1     | Morgan Kaufman publishers, 2008, ISBN-13:9788181476463                                            |
| 2     | ARM Architecture Reference Manual, David seal, Addison-Wesley, 2 <sup>nd</sup> Edition, 2009,     |
| 2     | ISBN-13:9780201737196                                                                             |
| 3     | ARM System on Chip Architecture, Steve Furber, Pearson Education Limited,2 <sup>nd</sup> Edition, |
| 3     | ISBN-13:9780201675191                                                                             |
| 4     | Technical reference manual for ARM processor cores, including Cortex, ARM 11, ARM 9               |
| 4     | & ARM 7 processor families.                                                                       |
| 5     | User guides and reference manuals for ARM software development and modeling tools.                |

**CIE** is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for Assignment/Presentation/Project is 10.

Total CIE is 30(Q) +60(T) +10(A) =100 Marks.

#### Semester End Evaluation (SEE); Theory (100 Marks)

**SEE** for 100 marks is executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

|       |            |     |     |     | CO- | PO Ma      | pping      |            |            |      |      |      |
|-------|------------|-----|-----|-----|-----|------------|------------|------------|------------|------|------|------|
| CO/PO | <b>PO1</b> | PO2 | PO3 | PO4 | PO5 | <b>PO6</b> | <b>PO7</b> | <b>PO8</b> | <b>PO9</b> | PO10 | PO11 | PO12 |
| CO1   | 2          | 2   | 3   | -   | -   | -          | -          | -          | -          |      | -    | -    |
| CO2   | 3          | 2   | 2   | 3   | -   | -          | -          | 2          | 2          |      | -    | -    |
| CO3   | 2          | 2   | 3   | 3   | -   | -          | -          | 2          | 2          |      | -    | -    |
| CO4   | 3          | 3   | 3   | 3   | 2   | 3          | 2          | 3          | 3          | 3    | 2    | 3    |

|      | Semester: VII                                                                            |       |                  |                               |                     |      |                |  |
|------|------------------------------------------------------------------------------------------|-------|------------------|-------------------------------|---------------------|------|----------------|--|
|      | SPEECH PROCESSING                                                                        |       |                  |                               |                     |      |                |  |
|      |                                                                                          |       | (Group H         | F: Professional Core Electi   | ve)                 |      |                |  |
| Cour | rse Code                                                                                 | :     | 16EC7F3          |                               | CIE                 | :    | 100 Marks      |  |
| Cred | lits: L:T:P:S                                                                            | :     | 4:0:0:0          |                               | SEE                 | :    | 100 Marks      |  |
| Tota | l Hours                                                                                  | :     | 50L              |                               | <b>SEE Duration</b> | :    | 03 Hours       |  |
| Cour | Course Learning Objectives: The students will be able to                                 |       |                  |                               |                     |      |                |  |
| 1    | Develop the s                                                                            | stude | nts mathematic   | al, scientific, and computati | ional skills releva | nt t | o the field of |  |
|      | biomedical signal processing.                                                            |       |                  |                               |                     |      |                |  |
| 2    | 2 Enhance the student's ability in formulating problems and designing analysis tools for |       |                  |                               |                     |      |                |  |
|      | biological signals.                                                                      |       |                  |                               |                     |      |                |  |
| 3    | 3 Increase the students awareness of the complexity of various biological phenomena and  |       |                  |                               |                     |      |                |  |
|      | cultivate an understanding of the same                                                   |       |                  |                               |                     |      |                |  |
| 4    | Foster effecti                                                                           | ve in | teraction skills | and teamwork communicat       | ion                 |      |                |  |

| Unit-I                                                                                            | 10 Hrs         |
|---------------------------------------------------------------------------------------------------|----------------|
| Introduction to digital speech signal processing: Digitization and recording, Hu                  | man speech     |
| production and source filter model, Place and manner at articulation, Articulatory a              | and acoustic   |
| phonetics, Uniform tube modeling of speech processing, Human auditory system, Speech              | n perception.  |
| Unit – II                                                                                         | 10 Hrs         |
| Time Domain Models for Speech Processing: Time dependent representation of speech                 | , Short time   |
| average zero crossing rate, Speech vs. silence discrimination using energy and zero cro           | ossing, pitch  |
| period estimation using parallel processing approach, short time autocorrelation function         | n, Short time  |
| average magnitude difference function, Pitch period estimation using autocorrelation fu           | nction.        |
| Unit –III                                                                                         | 10 Hrs         |
| Short Time Fourier Analysis: introduction, Definitions and properties, Fourie                     | r transform    |
| interpretation, linear filtering interpretation, Sampling rates of X(ejw) in time and frequencies | uency, Filter  |
| bank summation method of short time synthesis, Spectrographic displays.                           |                |
| Unit –IV                                                                                          | 10 Hrs         |
| Feature extraction: Extraction of Fundamental frequency, Frequency domain                         | fundamental    |
| frequency detection algorithm, Segmental and supra segmental features of speech sign              | nal, Cepstral  |
| transform coefficients parameters extraction, Mel-frequency Cepstral coefficients, MF             | CC features    |
| vector.                                                                                           |                |
| Unit –V                                                                                           | 10 Hrs         |
| Speech based Applications: Text to speech synthesis, Automatic speech recognition                 | n, Statistical |
| modelling of automatic speech recognition, and Speech based technology development for            | or e learning. |

| Course      | Course Outcomes: After completing the course, the students will be able to         |  |  |  |  |  |  |
|-------------|------------------------------------------------------------------------------------|--|--|--|--|--|--|
| <b>CO1:</b> | Analyze the basic signal processing techniques in biological signals               |  |  |  |  |  |  |
| CO2:        | Apply basic mathematical, scientific and computational skills necessary to analyze |  |  |  |  |  |  |
|             | biomedical signals.                                                                |  |  |  |  |  |  |
| CO3:        | Formulate and solve basic problems in biomedical signal analysis.                  |  |  |  |  |  |  |
| CO4:        | Design of Signal processing algorithm to be used in DSP Processor                  |  |  |  |  |  |  |

| Refer | ence Books                                                                                                                        |
|-------|-----------------------------------------------------------------------------------------------------------------------------------|
| 1     | Digital Processing of Speech Signals, L R Rabiner and R W Schafer, Pearson Education 2004. ISBN: 0-13-213603-1                    |
| 2     | Digital Speech Processing, Synthesis and Recognition, Sadoaki Furui, Second Edition, Mercel Dekk er 2002. ISBN-13: 978-0824704520 |
| 3     | Fundamentals of Speech Recognition, Rabiner and B.Juang ,Pearson Education, 2004, ISBN-<br>13: 978-0130151575                     |

| 4 | Discrete-Time Speech Signal Processing: Principles and Practice, Thomas F. Quatieri,<br>Prantice Hell: 1 adjition (10 November 2008) ISBN:0-12-242042 X |
|---|---------------------------------------------------------------------------------------------------------------------------------------------------------|
|   | Pfentice Hall, 1 edition (10 November 2008),ISBN:0-13-242942-X                                                                                          |
|   | Theory and Applications of Digital Speech Processing, L. R. Rabiner and R. W. Schafer,                                                                  |
| Э | Pearson; 1 edition (3 March 2010), ISBN: 978-0136034285                                                                                                 |

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Total CIE is 30(Q) +60(T) +10(A) =100 Marks.

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| CO-PO Mapping |            |     |     |     |     |            |            |            |            |      |      |      |
|---------------|------------|-----|-----|-----|-----|------------|------------|------------|------------|------|------|------|
| CO/PO         | <b>PO1</b> | PO2 | PO3 | PO4 | PO5 | <b>PO6</b> | <b>PO7</b> | <b>PO8</b> | <b>PO9</b> | PO10 | PO11 | PO12 |
| CO1           | 3          | 2   | 2   | 1   | 3   | 2          | 1          | 2          | 2          | 3    | 3    | 3    |
| CO2           | 3          | 3   | 3   | 2   | 3   | 1          | 1          | 1          | 3          | 1    | 3    | 3    |
| CO3           | 3          | 3   | 3   | 2   | 3   | 1          | 1          | 1          | 2          | 1    | 3    | 3    |
| <b>CO4</b>    | 3          | 3   | 3   | 3   | 2   | 1          | 1          | 1          | 2          | 1    | 3    | 3    |

|                                            | Semester: VII  |       |                  |                    |                     |     |           |  |  |  |  |
|--------------------------------------------|----------------|-------|------------------|--------------------|---------------------|-----|-----------|--|--|--|--|
| RADIO FREQUENCY INTEGRATED CIRCUITS DESIGN |                |       |                  |                    |                     |     |           |  |  |  |  |
| (Group F: Professional Core Elective)      |                |       |                  |                    |                     |     |           |  |  |  |  |
| Cou                                        | rse Code       | :     | 16EC7F4          |                    | CIE                 | :   | 100 Marks |  |  |  |  |
| Credits: L:T:P:S                           |                | :     | 4:0:0:0          |                    | SEE                 | :   | 100 Marks |  |  |  |  |
| Total Hours                                |                | :     | 50L              | SEE Duration       |                     | :   | 03 Hours  |  |  |  |  |
| Cou                                        | rse Learning ( | Obje  | ctives: The stud | lents will be able | to                  |     |           |  |  |  |  |
| 1                                          | Define and d   | emor  | strate the impo  | rtance of radio fr | equency design.     |     |           |  |  |  |  |
| 2                                          | Analyze the    | funct | ionality and des | sign issues of RF  | circuits and system | ns. |           |  |  |  |  |
| 3                                          | Design and in  | mple  | ment RF transce  | eiver.             | -                   |     |           |  |  |  |  |
| 4                                          | Evaluate the   | diffe | rent performanc  | e parameters use   | ed in RF design.    |     |           |  |  |  |  |

| Unit-I                                                                                    | 10 Hrs       |
|-------------------------------------------------------------------------------------------|--------------|
| Introduction to RF Design and Wireless Technology - various disciplines in RF design,     | RF design    |
| hexagon.                                                                                  | _            |
| Basic concepts in RF design - Units in RF design, Nonlinearity and Time Variance,         | Effects of   |
| nonlinearity - harmonic distortion, gain compression - 1 dB compression point, deser      | nsitization, |
| blocking, cross modulation, intermodulation – third intercept point, cascaded nonlinear s | tages – IM   |

Unit – II10 HrsNoise in RF circuits - Representation of noise in circuits – input referred noise, Noise figure, Noise<br/>figure of cascaded stages, Noise figure of lossy circuits, Sensitivity, dynamic range – spurious free<br/>dynamic range (SFDR).

**Transceiver architectures** – channel selection and band selection, Heterodyne – constant LO and constant IF downconversion, problem of image, image rejection vs channel selection, dual IF topology, Homodyne – simple homodyne and homodyne with quadrature down conversion, issues in homodyne receivers, Image Reject – Hartley & Weaver architecture. Transmitter architectures - Direct conversion and two-step transmitters.

| Unit –III                                                                                                                                                                                | 10 Hrs                   |  |  |  |  |  |  |  |  |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------|--|--|--|--|--|--|--|--|
| <b>Passive impedance transformation</b> – Quality factor, series to parallel conversion, basic matching                                                                                  |                          |  |  |  |  |  |  |  |  |
| networks- L, T, Pi-match networks, tapped inductor and capacitor networks                                                                                                                |                          |  |  |  |  |  |  |  |  |
| <b>Low noise Amplifier -</b> Performance parameters, Problem of Input matching, CS stage with load, Cascode CS stage with inductive degeneration (MOSFET circuits only), No calculation. | inductive<br>vise figure |  |  |  |  |  |  |  |  |
| Unit –IV                                                                                                                                                                                 | 10 Hrs                   |  |  |  |  |  |  |  |  |

**Mixer** - Performance parameters, Mixer noise figures, single balanced and double balanced (active and passive) – working (MOSFET circuits only)

**Oscillators** - Performance parameters, Feedback view and one port view of oscillators, Cross coupled oscillator, three point oscillators, (MOSFET circuits only), Ring oscillators.

Unit -V10 HrsPhase Locked Loops - Basic concepts - Phase detector, Type I PLL, Dynamics of simple PLL,<br/>Drawbacks of simple PLL, Type II PLLs - PFD, charge pump, charge pump PLL, PFD/CP<br/>Nonidealities (concepts only) – Up and Down Skew and Width Mismatch, Charge Injection and<br/>clock feedthrough.

| Course      | Course Outcomes: After completing the course, the students will be able to       |  |  |  |  |  |  |  |  |
|-------------|----------------------------------------------------------------------------------|--|--|--|--|--|--|--|--|
| CO1:        | Investigate the functionality of a typical RF system.                            |  |  |  |  |  |  |  |  |
| <b>CO2:</b> | Analyze CMOS circuits and its impact on Radio frequency IC design.               |  |  |  |  |  |  |  |  |
| CO3:        | Design and implement RF transceiver chain with specification.                    |  |  |  |  |  |  |  |  |
| CO4:        | Evaluate the different performance parameters used in RF design using CAD tools. |  |  |  |  |  |  |  |  |

spectra in a cascade.

| Refer | ence Books                                                                                |
|-------|-------------------------------------------------------------------------------------------|
| 1     | RF Microelectronics, Behzad Razavi, 2nd Edition Pearson Education, 2012                   |
| 2     | The Design of CMOS Radio Frequency Integrated Circuits, Thomas H Lee, 2nd Edition,        |
| 4     | Cambridge University Press, 2004                                                          |
| 3     | Radio Frequency Integrated Circuits Design, John Rogers ,Calvin Plett, Artech House, 2003 |
| 4     | VLSI for Wireless Communications, Bosco Leung, Pearson Education, 2004                    |

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Total CIE is 30(Q) +60(T) +10(A) =100 Marks.

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| CO1           | 3          | 2   | -   | -   | -   | -          | -          | -          | -          | -    | -    | 2    |
| CO2           | 3          | 2   | -   | -   | -   | -          | -          | -          | -          | -    | -    | 2    |
| CO3           | 3          | 3   | 2   | -   | 2   | -          | -          | 3          | 2          | -    | -    | 2    |
| CO4           | 3          | 3   | -   | -   | 2   | -          | -          | -          | -          | -    | -    | 2    |

| Semester: VII                                            |                |           |                      |                                  |                          |        |                     |  |  |  |  |
|----------------------------------------------------------|----------------|-----------|----------------------|----------------------------------|--------------------------|--------|---------------------|--|--|--|--|
| HIGH PERFORMANCE COMPUTING                               |                |           |                      |                                  |                          |        |                     |  |  |  |  |
|                                                          |                |           | (Group F             | : Professional C                 | ore Elective)            |        |                     |  |  |  |  |
| Cours                                                    | se Code        | :         | 16EC7F5              |                                  | CIE : 100 Marks          |        |                     |  |  |  |  |
| Credi                                                    | its: L:T:P:S   | :         | 4:0:0:0              |                                  | SEE                      | :      | 100 Marks           |  |  |  |  |
| Total                                                    | Hours          | :         | 50L                  |                                  | SEE Duration             | :      | 03 Hours            |  |  |  |  |
| Course Learning Objectives: The students will be able to |                |           |                      |                                  |                          |        |                     |  |  |  |  |
| 1                                                        | To review th   | e tre     | ends in parallel pr  | ogramming.                       |                          |        |                     |  |  |  |  |
| 2                                                        | To demonstr    | ate       | the basic ideas of   | multiprocessing                  | and parallel operat      | ions   | with case studies.  |  |  |  |  |
| 3                                                        | To expose to   | bas       | sics of parallel pro | ogramming.                       |                          |        |                     |  |  |  |  |
| 4                                                        | To demonstr    | ate       | parallel programm    | ning using MPI,                  | OpenAcc and Open         | nMF    |                     |  |  |  |  |
|                                                          |                |           |                      |                                  |                          |        |                     |  |  |  |  |
|                                                          |                |           |                      | Unit-I                           |                          |        | 10 Hrs              |  |  |  |  |
| Multi                                                    | processors a   | nd '      | Thread level par     | allelism:                        |                          |        |                     |  |  |  |  |
| Introd                                                   | luction, Symr  | neti      | ic shared memor      | y architectures; I               | Performance of syn       | nme    | etric shared-memory |  |  |  |  |
| multip                                                   | processors,    | Dist      | ributed shared       | memory and                       | directory-based          | coh    | erence, Basics of   |  |  |  |  |
| synch                                                    | ronization, M  | ode       | els of memory cor    | isistency.                       |                          |        | 10 11               |  |  |  |  |
| D (                                                      |                |           |                      | $\bigcup$ <b>nit</b> – <b>II</b> |                          |        | 10 Hrs              |  |  |  |  |
| Data-                                                    | Level Parall   | elis      | m in Vector, SIN     | 1D, and GPU Ai                   | chitectures:             |        |                     |  |  |  |  |
| Introd                                                   | luction, Vect  | or        | Architecture, SIN    | AD Instruction S                 | Set Extensions for       | r M    | ultimedia, Graphics |  |  |  |  |
| Proces                                                   | ssing Units, L | vete      | cting and Enhanci    | ing Loop-Level P                 | arallelism, Mobile       | vers   | sus Server GPUs and |  |  |  |  |
| Testa                                                    | versus Core 1  | 1.        | T                    | T                                |                          |        | 10 11               |  |  |  |  |
| Intro                                                    | duction to De  | rol       | lol Programmin       | J <b>nit –111</b>                |                          |        | 10 Hrs              |  |  |  |  |
| Motiv                                                    | ation Scope    | of        | Parallal Computi     | 5.<br>ng Principles of           | Darallal Algorith        | n da   | sign. Proliminarias |  |  |  |  |
| Decor                                                    | nnosition Tec  | 01<br>hni | ques Characterist    | tics of Tasks and                | Interactions Mann        | in u   | Techniques for Load |  |  |  |  |
| Balan                                                    | cing Method    | s fo      | r containing Inter   | action Overheads                 | Parallel Algorith        | me l   | Models              |  |  |  |  |
| Dalan                                                    | eing, wiethou  | 5 10      | I containing inter   | Init –IV                         | s, i aranci i tigoriti   | 1115 1 | 10 Hrs              |  |  |  |  |
| Progr                                                    | amming Usi     | no        | the Using Messa      | ge Passing Para                  | liom•                    |        | 10 1115             |  |  |  |  |
| Princi                                                   | nles of Mess   | ne<br>age | Passing Program      | ming Ruilding                    | Blocks MPI Ton           | പിറം   | ies and Embedding   |  |  |  |  |
| Overla                                                   | apping Com     | miii      | ication with co      | mputation Coll                   | ective Communic          | atio   | n and computation   |  |  |  |  |
| operat                                                   | tions Groups   | and       | Communicators        | inputation, con                  | cetive commune           | uno    | in und computation  |  |  |  |  |
| operat                                                   | lions, croups  | unc       |                      | Unit _V                          |                          |        | 10 Hrs              |  |  |  |  |
| GPU                                                      | Programmin     | 19 11     | sing Open ACC:       | Serial to paralle                | l programming usi        | ng (   | DenACC: A Simple    |  |  |  |  |
| Data-I                                                   | Parallel Loop  | . Ta      | sk-Parallel Exam     | ple. Amdahl's La                 | w and Scaling. Par       | allel  | Execution and Race  |  |  |  |  |
| Condi                                                    | itions. Lock-I | Free      | Programming.         | Controlling Paral                | lel Resources. <b>Pi</b> | oelir  | ing data transfers  |  |  |  |  |
| with (                                                   | OpenACC: 1     | ntro      | oduction to Pipel    | ining, Mandelbr                  | ot Generator, Pip        | elini  | ng Across Multiple  |  |  |  |  |
| Devic                                                    | es.            |           | I -                  | 0,                               | · 1                      |        | <b>C</b> 1          |  |  |  |  |
|                                                          |                |           |                      |                                  |                          |        |                     |  |  |  |  |
| Cours                                                    | se Outcomes    | : Af      | fter completing t    | he course, the st                | udents will be ab        | e to   |                     |  |  |  |  |
| C01:                                                     | Explore the    | e fu      | ndamentals of high   | h-performance c                  | omputing concepts        | 5.     |                     |  |  |  |  |

- **CO2:** Analyze the performance of parallel programming.
- **CO3:** Design parallel computing constructs for different applications.
- **CO4:** Demonstrate Parallel computing concepts for suitable applications.

#### **Reference Books**

| 1 | Ananth Grama, Anshul Gupta, George Karypis, Vipin Kumar, Introduction to Parallel                 |
|---|---------------------------------------------------------------------------------------------------|
|   | Computing, 2 <sup>nd</sup> Edition, 2013, Pearson Education, ISBN 13: <u>9788131708071</u> .      |
| 2 | CUDA Programming: A Developers Guide to Parallel Computing with GPUs, Shane Cook, 1 <sup>st</sup> |
|   | Edition, 2013, Morgan Kaufmann, ISBN:9780124159334.                                               |
| 3 | Parallel Programming with Open ACC, Rob Farber, 1 <sup>st</sup> Edition, 2016, Morgan Kaufmann    |
|   | (MK) Publication, ISBN :9780124103979.                                                            |

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| CO/PO | <b>PO1</b>    | PO2 | PO3 | PO4 | PO5 | <b>PO6</b> | <b>PO7</b> | <b>PO8</b> | PO9 | PO10 | PO11 | PO12 |  |  |
| CO1   | 3             | 2   | -   | -   | -   | -          | -          | -          | -   | 1    | -    | 1    |  |  |
| CO2   | 3             | 2   | 2   | 1   | -   | -          | -          | -          | -   | 1    | -    | 1    |  |  |
| CO3   | 3             | 3   | 2   | 2   | 2   | -          | -          | -          | -   | 1    | -    | 1    |  |  |
| CO4   | 3             | 3   | 3   | 3   | 2   | -          | -          | -          | -   | 1    | -    | 1    |  |  |

|                  | Semester: VII                                                                            |      |                      |                             |            |     |                 |  |  |
|------------------|------------------------------------------------------------------------------------------|------|----------------------|-----------------------------|------------|-----|-----------------|--|--|
|                  | INTEGRATED PHOTONICS                                                                     |      |                      |                             |            |     |                 |  |  |
|                  |                                                                                          |      | (Group F: l          | Professional Core Elective) |            |     |                 |  |  |
| Cou              | rse Code                                                                                 | ••   | 16EC7F6              | CIE                         |            | :   | 100 Marks       |  |  |
| Credits: L:T:P:S |                                                                                          | ••   | 4:0:0:0              | SEE                         |            | ••  | 100 Marks       |  |  |
| Tota             | l Hours                                                                                  | ••   | 52L                  | SEE Du                      | ration     | ••  | 03 Hours        |  |  |
| Cou              | rse Learning (                                                                           | )bj  | ectives: The studen  | ts will be able to          |            |     |                 |  |  |
| 1                | Learn the fu                                                                             | nda  | amental principles   | of photonics and light-ma   | tter inter | rac | tions           |  |  |
| 2                | Explain and                                                                              | illı | ustrate light guidir | ng, calculate wave propaga  | tion in w  | vav | veguide systems |  |  |
| 3                | 3 Calculate characteristics of optical resonators                                        |      |                      |                             |            |     |                 |  |  |
| 4                | 4 Develop the ability to formulate problems related to photonic structures/processes and |      |                      |                             |            |     |                 |  |  |
|                  | analyze them                                                                             |      |                      |                             |            |     |                 |  |  |

| Unit-I                                                                                           | 10 Hrs      |  |  |  |  |  |  |
|--------------------------------------------------------------------------------------------------|-------------|--|--|--|--|--|--|
| Introduction to EM theory: EM wave in dielectric media, Monochromatic EM waves, Absorption       |             |  |  |  |  |  |  |
| and Dispersion, Pulse propagation in Dispersive media, Polarization of light, Reflection and     |             |  |  |  |  |  |  |
| Refraction, Optics in Anisotropic media.                                                         |             |  |  |  |  |  |  |
| Unit – II                                                                                        |             |  |  |  |  |  |  |
| Interaction of optical waves: with dielectric and metal interfaces, matrix optics. Comp          | outational  |  |  |  |  |  |  |
| methods for integrated photonics. Propagation-matrix approach, multilayered and periodic         | media.      |  |  |  |  |  |  |
| Unit –III                                                                                        | 11 Hrs      |  |  |  |  |  |  |
| Waveguide optics: Symmetric dielectric waveguides. Asymmetric dielectric wa                      | veguides.   |  |  |  |  |  |  |
| Rectangular waveguides. Optical fibers. Attenuation and dispersion in optical waveguide          | es. Signal  |  |  |  |  |  |  |
| distortion in optical waveguides, group delay.                                                   |             |  |  |  |  |  |  |
| Silicon waveguides: fabrication, waveguide loss, scattering, absorption, radiation. D            | ispersion   |  |  |  |  |  |  |
| engineering. Optical nonlinearities in silicon waveguides. Coupling to waveguide: edge           | , grating,  |  |  |  |  |  |  |
| evanescent coupling, spot-size converters.                                                       |             |  |  |  |  |  |  |
| Unit –IV                                                                                         | 10 Hrs      |  |  |  |  |  |  |
| Coupled optical waveguides: Mach-Zehnder interferometer, cascaded MZI optical fi                 | lters, star |  |  |  |  |  |  |
| couplers. Filters figures of merit. Optical ring resonators. Add-drop multiplexers. Wavegui      | ide Bragg   |  |  |  |  |  |  |
| gratings. Polarization dependence and management. Waveguide polarization splitters and           | l rotators. |  |  |  |  |  |  |
| Optical isolation.                                                                               |             |  |  |  |  |  |  |
| Unit –V                                                                                          | 10 Hrs      |  |  |  |  |  |  |
| Photonic modulators: electro-optical and thermo-optical effects. Phase and amplitude modulators. |             |  |  |  |  |  |  |
| Thermal phase shifter, thermo-optic switch.                                                      |             |  |  |  |  |  |  |
| Non-linear optics: Non-linear media, Second-order Non-linear optics, Third-order Non-linear      |             |  |  |  |  |  |  |
| optics.                                                                                          |             |  |  |  |  |  |  |
|                                                                                                  |             |  |  |  |  |  |  |
| Course Outcomes: After completing the course, the students will be able to                       |             |  |  |  |  |  |  |
| CO1. Define and emploin the monoportion of light in conducting and non-conducting man            | 1:          |  |  |  |  |  |  |

| Course      | course outcomes: After completing the course, the students will be usie to            |  |  |  |  |  |  |  |  |
|-------------|---------------------------------------------------------------------------------------|--|--|--|--|--|--|--|--|
| CO1:        | Define and explain the propagation of light in conducting and non-conducting media.   |  |  |  |  |  |  |  |  |
| <b>CO2:</b> | Define and explain the physics governing laser behaviour and light matter interaction |  |  |  |  |  |  |  |  |
| CO3:        | Apply wave optics and diffraction theory to a range of problems                       |  |  |  |  |  |  |  |  |
| <b>CO4:</b> | Calculate properties of and design modern optical fibres and photonic crystals.       |  |  |  |  |  |  |  |  |

| Refere | ence Books                                                                                                                            |
|--------|---------------------------------------------------------------------------------------------------------------------------------------|
| 1      | Fundamentals of Photonics, B.E.A. Saleh, M.C. Teich, Wiley India Pvt Ltd; 2 <sup>nd</sup> edition, 2012, ISBN: 9788126537747          |
| 2      | Photonics - Optical Electronics in Modern Communications, A. Yariv and P. Yeh, Oxford University Press, 6th Edition, ISBN: 0195179463 |

|   | Photonic Crystals – Molding the Flow of Light, John D. Joannopoulos, Steven G.            |
|---|-------------------------------------------------------------------------------------------|
| 3 | Johnson, Joshua N. Winn, and Robert D. Meade, Princeton University Press; 2 <sup>nd</sup> |
|   | Revised edition, 2013, ISBN-10: 0691124566                                                |
| 4 | Silicon Photonics - Fundamentals and Devices, M. Jamal Deen and P.K. Basu, John Wiley     |
| 4 | & Sons Ltd., 3rd Edition 2010, ISBN: 0-321-26977-2                                        |

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| CO1           | 3          | 2   | -   | -   | -   | -          | -          | -          | -          | 1    | -    | 1    |
| CO2           | 3          | 2   | 2   | 1   | -   | -          | -          | -          | -          | 1    | -    | 1    |
| CO3           | 3          | 3   | 2   | 2   | -   | -          | -          | -          | -          | 1    | -    | 1    |
| CO4           | 3          | 3   | 3   | 3   | -   | -          | -          | -          | -          | 1    | -    | 1    |

|               | Semester: VII                                                                               |      |                   |                    |                     |      |                       |  |  |  |
|---------------|---------------------------------------------------------------------------------------------|------|-------------------|--------------------|---------------------|------|-----------------------|--|--|--|
|               |                                                                                             |      | N                 | ANOELECTRO         | DNICS               |      |                       |  |  |  |
|               |                                                                                             |      | (Group l          | F: Professional    | Core Elective)      |      |                       |  |  |  |
| Cou           | Course Code:16EC7F7CIE:100 Marks                                                            |      |                   |                    |                     |      |                       |  |  |  |
| Cred          | lits: L:T:P:S                                                                               | :    | 4:0:0:0           |                    | SEE                 | :    | 100 Marks             |  |  |  |
| Tota          | l Hours                                                                                     | :    | 50L               |                    | SEE Duration        | :    | 03 Hours              |  |  |  |
| Cou           | rse Learning (                                                                              | Obj  | ectives: The stud | dents will be able | e to                |      |                       |  |  |  |
| 1             | Develop su                                                                                  | bst  | antial understa   | nding of cont      | temporary releva    | nce  | and potential of      |  |  |  |
|               | nanoelectron                                                                                | ics; |                   |                    |                     |      |                       |  |  |  |
| 2             | Develop app                                                                                 | reci | ation of how fac  | ctors like scaling | g and dimension le  | ad   | to novel behaviour of |  |  |  |
|               | nanoelectron                                                                                | ic c | omponents;        |                    |                     |      |                       |  |  |  |
| 3             | Develop und                                                                                 | erst | anding of the in  | portance of qua    | ntum ideas and th   | eir  | place in modelling of |  |  |  |
|               | nanoelectron                                                                                | ic p | henomena and d    | evices;            |                     |      |                       |  |  |  |
| 4             | Expose to a v                                                                               | ari  | ety of nanoelectr | onic phenomena     | , nanoelectronic co | mp   | onents and their      |  |  |  |
|               | possible applications.                                                                      |      |                   |                    |                     |      |                       |  |  |  |
|               |                                                                                             |      |                   |                    |                     |      |                       |  |  |  |
| Unit-I 10 Hrs |                                                                                             |      |                   |                    |                     |      |                       |  |  |  |
| Revi          | Review of Electrons Quantum mechanics: Electrons wave particle duality, Wave equation, Wave |      |                   |                    |                     |      |                       |  |  |  |
| pack          | ets and uncert                                                                              | ain  | ty, Schrodinger'  | s Equation, The    | Time Independen     | nt S | Schrödinger Equation, |  |  |  |
| Stati         | Stationary States, The Infinite Square Well, Harmonic Oscillator-Algebraic method           |      |                   |                    |                     |      |                       |  |  |  |

| Unit – II                                                                            | 10 Hrs         |
|--------------------------------------------------------------------------------------|----------------|
| Free and confined electrons: Free electrons, Periodic boundary conditions, Electrons | Confined to    |
| a Bounded Region of Space, and Quantum Numbers, Fermi level and Chemical potent      | ial, Partially |
| Confined Electrons- Finite Potential Wells, Quantum Dots, Wires, and Wells           |                |

Unit –III10 HrsElectrons subject to a periodic potential: Electrons in periodic potential, Kronig-Penney of Band<br/>structure- Effective Mass, Band theory of Solids: Interacting system model, Band structure,<br/>electronic band transition, graphene and carbon nanotube10 Hrs

Unit –IV10 HrsTunnel junctions and applications of tunneling: Tunneling Through a Potential Barrier, Potential<br/>Energy Profiles for Material Interfaces, Applications of Tunneling, Field Emission, Gate—Oxide<br/>Tunneling and Hot Electron Effects in MOSFETs, Scanning Tunneling Microscope, Double Barrier<br/>Tunneling and the Resonant Tunneling Diode

Unit –V10 HrsCoulomb blockade and the single-electron transistor: Tunnel Junction Excited by a CurrentSource, Coulomb Blockade in a Quantum Dot Circuit, The Single-Electron Transistor, Single-Electron Transistor Logic, Other SET and FET Structures, Carbon Nanotube Transistors (FETs andSETs), Semiconductor Nanowire FETs and SETs, Molecular SETs and Molecular Electronics

| Course      | Course Outcomes: After completing the course, the students will be able to               |  |  |  |  |  |  |  |  |
|-------------|------------------------------------------------------------------------------------------|--|--|--|--|--|--|--|--|
| CO1:        | Define novel behaviour of nanoelectronics devices and quantum behaviour of matter at the |  |  |  |  |  |  |  |  |
|             | nano scale & modelling of nanoelectronics devices.                                       |  |  |  |  |  |  |  |  |
| <b>CO2:</b> | Comprehend principles of devices such as tunneling diodes, single electron transistor,   |  |  |  |  |  |  |  |  |
|             | spintronic devices.                                                                      |  |  |  |  |  |  |  |  |
| CO3:        | Analysis fundamental concepts and methods of Analysis quantum tunneling, resonant        |  |  |  |  |  |  |  |  |
|             | tunneling, Coulomb blockade, density of quantum states, quantum statistics and quantum   |  |  |  |  |  |  |  |  |
|             | modelling.                                                                               |  |  |  |  |  |  |  |  |
| <b>CO4:</b> | Evaluate nano scale effects in futuristic electron devices & quantum level computing     |  |  |  |  |  |  |  |  |

| Refer    | ence Books                                                                                         |
|----------|----------------------------------------------------------------------------------------------------|
| 1        | Fundamentals of Nanoelectronics, George W. Hanson, Pearson, 1 <sup>st</sup> edition, (2009), ISBN: |
| L        | 978-8131726792                                                                                     |
| •        | Introduction to Quantum Mechanics, J. Griffiths David, Pearson Education, 2 <sup>nd</sup> edition  |
| <u> </u> | (2015), ISBN-13: 978-9332542891                                                                    |
|          | Introduction to Nanotechnology, Charles P. Poole, Jr., Frank J. Owens, Wiley (15 January           |
| 3        | 2007), ISBN:978-8126510993                                                                         |
| 4        | Nanoelectronics and Information Technology, Rainer Waser, Wiley VCH; 3rd Revised                   |
| 4        | edition edition(2012), ISBN: 978-3527409273                                                        |

**CIE** is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for Assignment/Presentation/Project is 10.

Total CIE is 30(Q) +60(T) +10(A) =100 Marks.

#### Semester End Evaluation (SEE); Theory (100 Marks)

**SEE** for 100 marks is executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

| CO-PO Mapping |                                                          |   |   |   |   |   |   |   |   |   |   |   |
|---------------|----------------------------------------------------------|---|---|---|---|---|---|---|---|---|---|---|
| CO/PO         | CO/PO PO1 PO2 PO3 PO4 PO5 PO6 PO7 PO8 PO9 PO10 PO11 PO12 |   |   |   |   |   |   |   |   |   |   |   |
| CO1           | 3                                                        | 2 | - | - | - | 1 | 2 | - | - | - | - | 2 |
| CO2           | 3                                                        | 2 | 1 | - | - | 1 | 2 | - | - | - | - | 2 |
| CO3           | 3                                                        | 3 | 2 | - | 2 | 1 | 2 | - | - | - | - | 2 |
| CO4           | 3                                                        | 3 | 3 | 2 | 2 | 1 | 2 | - | - | - | - | 2 |

|                                  | Semester: VII                                                                     |       |                   |                          |                     |   |           |  |  |
|----------------------------------|-----------------------------------------------------------------------------------|-------|-------------------|--------------------------|---------------------|---|-----------|--|--|
|                                  | RADAR & NAVIGATION                                                                |       |                   |                          |                     |   |           |  |  |
|                                  |                                                                                   |       | (Group G          | <b>F: Professional C</b> | ore Elective)       |   |           |  |  |
| Course Code:16EC7G1CIE:100 Marks |                                                                                   |       |                   |                          |                     |   | 100 Marks |  |  |
| Credits: L:T:P:S                 |                                                                                   | :     | 4:0:0:0           |                          | SEE                 | : | 100 Marks |  |  |
| Total Hours                      |                                                                                   | :     | 48L               |                          | <b>SEE Duration</b> | : | 03 Hours  |  |  |
| Cou                              | rse Learning (                                                                    | Obje  | ctives: The stude | ents will be able to     | )                   |   |           |  |  |
| 1                                | Understand t                                                                      | he ba | sic operation of  | pulse and CW rac         | lar systems.        |   |           |  |  |
| 2                                | 2 Evaluate the radar performance based on pulse width, peak power and beam width. |       |                   |                          |                     |   |           |  |  |
| 3                                | 3 Choose suitable tracking radar for a given problem.                             |       |                   |                          |                     |   |           |  |  |
| 4                                | 4 Understand the working of phased array radars and navigational aids             |       |                   |                          |                     |   |           |  |  |

| Unit-I                                                                                                   | 10 Hrs        |  |  |  |  |  |  |  |  |
|----------------------------------------------------------------------------------------------------------|---------------|--|--|--|--|--|--|--|--|
| Radar and Radar Equation: Introduction, Radar block diagram and operation,                               | frequencies,  |  |  |  |  |  |  |  |  |
| applications, types of displays, derivation of radar equation, minimum detectable signal, probability of |               |  |  |  |  |  |  |  |  |
| false alarm and threshold detection, radar cross-section, system losses.                                 |               |  |  |  |  |  |  |  |  |
| Unit – II                                                                                                | 10 Hrs        |  |  |  |  |  |  |  |  |
| <b>CW Radar</b> : Doppler Effect, CW Radar, applications, FM – CW radar, altimeter, Multiple Frequency   |               |  |  |  |  |  |  |  |  |
| Radar. Pulse Radar - MTI, Delay Line Canceller, Multiple Frequencies, Range-gated Doppler Filters,       |               |  |  |  |  |  |  |  |  |
| Non-coherent MTI, Pulse Doppler Radar                                                                    |               |  |  |  |  |  |  |  |  |
| Unit –III                                                                                                |               |  |  |  |  |  |  |  |  |
| Tracking Radar: Sequential lobing, conical scanning, monopulse, phase comparison                         | monopulse,    |  |  |  |  |  |  |  |  |
| tracking in range, comparison of trackers.                                                               |               |  |  |  |  |  |  |  |  |
| Unit –IV                                                                                                 | <b>09 Hrs</b> |  |  |  |  |  |  |  |  |
| <b>Detection:</b> Introduction, Matched Filter, Detection Criteria, Detector characteristics.            |               |  |  |  |  |  |  |  |  |
| Unit –V                                                                                                  |               |  |  |  |  |  |  |  |  |
| Phased Arrays: Basic concepts, feeds, phase shifters, frequency scan arrays, mul                         | tiple beams,  |  |  |  |  |  |  |  |  |
| applications advantages and limitations Navigational Aids: Direction Finder VOR II S                     | and Loran     |  |  |  |  |  |  |  |  |

| Course      | Course Outcomes: After completing the course, the students will be able to      |  |  |  |  |  |  |  |  |  |  |
|-------------|---------------------------------------------------------------------------------|--|--|--|--|--|--|--|--|--|--|
| CO1:        | Understand the basic operation of pulse and CW radar systems.                   |  |  |  |  |  |  |  |  |  |  |
| <b>CO2:</b> | Evaluate the radar performance based on pulse width, peak power and beam width. |  |  |  |  |  |  |  |  |  |  |
| CO3:        | Choose suitable tracking radar for a given problem.                             |  |  |  |  |  |  |  |  |  |  |
| CO4:        | Select appropriate criterion for detecting a target.                            |  |  |  |  |  |  |  |  |  |  |

| Refere | ence Books                                                                                             |
|--------|--------------------------------------------------------------------------------------------------------|
| 1      | Understanding Automotive Electronics, Williams. B. Ribbens, Elsevier science, 6 <sup>th</sup> Edition, |
| L      | Newness publication,2003, ISBN-9780080481494.                                                          |
| 2      | Automotive Electronics Handbook, Robert Bosch, John Wiley and Sons, 2004                               |
| 2      | Automotive Embedded Systems Handbook, Nicolas Navet, F Simonot-Lion, Industrial                        |
| 3      | Information Technology Series, CRC press.                                                              |
| 4      | Automotive Control Systems Engine, Uwekiencke and lars Nielsen, Driveline and vehicle",                |
| 4      | Springer, 2 <sup>nd</sup> Edition, 2005, ISBN 0-387-95368X                                             |

**CIE** is executed by way of quizzes (Q), tests (T) and Assignment. A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for assignment is 10. The total marks of CIE are 100.

#### Semester End Evaluation (SEE); Theory (100 Marks)

**SEE** for 100 marks is executed by means of an examination. The Question paper for each course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

| CO-PO Mapping |            |     |     |     |     |            |            |            |            |      |      |      |
|---------------|------------|-----|-----|-----|-----|------------|------------|------------|------------|------|------|------|
| CO/PO         | <b>PO1</b> | PO2 | PO3 | PO4 | PO5 | <b>PO6</b> | <b>PO7</b> | <b>PO8</b> | <b>PO9</b> | PO10 | PO11 | PO12 |
| CO1           | 3          | 1   | 2   | 1   | -   | -          | -          | -          | -          | -    | -    | 1    |
| CO2           | 3          | 2   | 2   | 1   | -   | 1          | -          | -          | -          | -    | -    | 1    |
| CO3           | 3          | 2   | 2   | 1   | -   | 1          | -          | -          | -          | -    | -    | 1    |
| CO4           | 3          | 1   | 2   | 1   | -   | 1          | -          | -          | -          | -    | -    |      |

Low-1 Medium-2 High-3

|                                       |                                                                                                 |       |                    | Semester: VII           |                 |       |                                        |  |  |  |  |  |
|---------------------------------------|-------------------------------------------------------------------------------------------------|-------|--------------------|-------------------------|-----------------|-------|----------------------------------------|--|--|--|--|--|
| AUTOMOTIVE ELECTRONICS                |                                                                                                 |       |                    |                         |                 |       |                                        |  |  |  |  |  |
| (Group G: Professional Core Elective) |                                                                                                 |       |                    |                         |                 |       |                                        |  |  |  |  |  |
| Cou                                   | rse Code                                                                                        | :     | 16EC7G2            | CI                      | E               | :     | 100 Marks                              |  |  |  |  |  |
| Cred                                  | lits: L:T:P:S                                                                                   | :     | 4:0:0:0            | SE                      | E               | :     | 100 Marks                              |  |  |  |  |  |
| Total Hours:48LSEE Duration:03 Hours  |                                                                                                 |       |                    |                         |                 |       |                                        |  |  |  |  |  |
| Cou                                   | <b>Course Learning Objectives:</b> The students will be able to                                 |       |                    |                         |                 |       |                                        |  |  |  |  |  |
| 1                                     | Acquire the                                                                                     | kno   | wledge of aut      | omotive domain fur      | ndamentals, n   | eed   | of Electronics and                     |  |  |  |  |  |
|                                       | communication interfaces in Automotive systems.                                                 |       |                    |                         |                 |       |                                        |  |  |  |  |  |
| 2                                     | 2 Apply various types of sensors, actuators and Motion Control techniques in Automotive systems |       |                    |                         |                 |       |                                        |  |  |  |  |  |
| 3                                     | Understand d                                                                                    | ligit | al engine contro   | ol systems and Embe     | edded Softwar   | re's  | and ECU's used in                      |  |  |  |  |  |
|                                       | automotive sy                                                                                   | ster  | ns.                |                         |                 |       |                                        |  |  |  |  |  |
| 4                                     | Analyse the co                                                                                  | once  | epts of Diagnosti  | cs, safety and advance  | es in Automotiv | ve e  | lectronic Systems.                     |  |  |  |  |  |
|                                       |                                                                                                 |       |                    |                         |                 |       |                                        |  |  |  |  |  |
|                                       |                                                                                                 |       | 1                  | J <b>nit-I</b>          |                 |       | 10 Hrs                                 |  |  |  |  |  |
| Func                                  | lamentals of .                                                                                  | Aut   | omotive: Use o     | of Electronics in Aut   | tomotive, Evo   | lutio | on of Electronics in                   |  |  |  |  |  |
| Auto                                  | motive, Autom                                                                                   | otiv  | e Systems, The l   | Engine, Engine Contro   | ol, Internal Co | mbı   | stion Engines, Spark                   |  |  |  |  |  |
| Ignit                                 | ion Engines and                                                                                 | l Al  | ternative Engine   | s. Ignition System, Ign | nition Timing,  | Dri   | vetrain, Suspensions,                  |  |  |  |  |  |
| Brak                                  | es and Steering                                                                                 | Sys   | tems, Demonstra    | ation of Four Cylinder  | manual transn   | niss  | ion Engine.                            |  |  |  |  |  |
| Basi                                  | cs of electronic                                                                                | en    | gine control: Mo   | otivation for Electroni | c Engine Cont   | rol · | <ul> <li>Exhaust Emissions,</li> </ul> |  |  |  |  |  |
| Fuel                                  | Economy, Co                                                                                     | nce   | pt of an Electro   | onic Engine control     | system, Defin   | itio  | n of General terms,                    |  |  |  |  |  |
| Defin                                 | nition of Engine                                                                                | e pe  | rformance terms    | , Engine mapping, Ef    | fect of Air/Fue | el ra | tio, spark timing and                  |  |  |  |  |  |
| EGR                                   | on performance                                                                                  | e, (  | Control Strategy,  | Electronic Fuel contr   | ol system, An   | alys  | is of intake manifold                  |  |  |  |  |  |
| press                                 | ure, Electronic                                                                                 | Ign   | ition.             |                         |                 |       |                                        |  |  |  |  |  |
|                                       |                                                                                                 |       | U                  | nit – II                |                 |       | 10 Hrs                                 |  |  |  |  |  |
| Auto                                  | motive Sensor                                                                                   | s ar  | d Actuators:       |                         |                 |       |                                        |  |  |  |  |  |
| Syste                                 | em Approach to                                                                                  | Co    | ntrol and Instrum  | nentation: Concept of A | A System, Ana   | alog  | and Digital Systems,                   |  |  |  |  |  |
| Basic                                 | c Measurement                                                                                   | Sy    | stems, Analog a    | nd Digital Signal Pr    | ocessing, Auto  | ome   | tive Control System                    |  |  |  |  |  |
| Appl                                  | ications of Sens                                                                                | sors  | and Actuators,     |                         |                 |       |                                        |  |  |  |  |  |
| Sens                                  | ors: Air Flow                                                                                   | Se    | nsor, Engine Cr    | ankshaft Angular Po     | sition Sensor,  | Th    | rottle Angle Sensor,                   |  |  |  |  |  |
| Tem                                   | perature Sensor                                                                                 | :, Se | ensors for Feedb   | ack Control, Sensors    | for Driver As   | ssist | ance System: Radar,                    |  |  |  |  |  |
| Lida                                  | r, Video Techno                                                                                 | olog  | у.                 |                         |                 |       |                                        |  |  |  |  |  |
| Actu                                  | ators: Solenoic                                                                                 | ls, F | Piezo Electric For | ce Generators, Electri  | ic Motors and S | Swi   | tches.                                 |  |  |  |  |  |
|                                       |                                                                                                 |       | U                  | nit –III                |                 |       | 10 Hrs                                 |  |  |  |  |  |
| Digit                                 | tal Engine Cor                                                                                  | ntro  | l Systems: Digi    | tal Engine control fea  | atures, Control | l mo  | odes for fuel Control                  |  |  |  |  |  |
| (Seve                                 | en Modes), EC                                                                                   | GR (  | Control, Electron  | nic Ignition Control    | - Closed Loop   | p Ig  | nition timing, Spark                   |  |  |  |  |  |
| Adva                                  | ance Correction                                                                                 | n So  | cheme, Integrate   | d Engine Control S      | ystem - Secon   | ndaı  | ry Air Management,                     |  |  |  |  |  |
| Evap                                  | orative Emissic                                                                                 | ons ( | Canister Purge, A  | utomatic System Adj     | ustment, Syste  | m E   | Diagnostics.                           |  |  |  |  |  |
| Vehi                                  | cle Motion Co                                                                                   | ontr  | ol: Typical Crui   | ise Control System, I   | Digital Cruise  | Co    | ntrol System, Digital                  |  |  |  |  |  |
| Spee                                  | d Sensor, Thro                                                                                  | ottle | Actuator, Digita   | al Cruise Control con   | nfiguration, Cr | uise  | control Electronics                    |  |  |  |  |  |
| (Digi                                 | ital only), Antil                                                                               | ock   | Brake System (A    | ABS)                    |                 |       |                                        |  |  |  |  |  |
|                                       |                                                                                                 |       | U                  | nit –IV                 |                 |       | 09 Hrs                                 |  |  |  |  |  |
| Auto                                  | motive Comm                                                                                     | uni   | cation Systems:    |                         |                 |       |                                        |  |  |  |  |  |
| Auto                                  | motive networ                                                                                   | king  | g: Bus systems,    | Technical principles    | s, network top  | polo  | gy. Buses in motor                     |  |  |  |  |  |
| vehic                                 | cles: CAN, Flex                                                                                 | Ra    | y, LIN, Ethernet,  | IP, PSI5, MOST, D2      | B and DSI.      |       |                                        |  |  |  |  |  |
| Auto                                  | motive Embed                                                                                    | ldec  | l Software Deve    | lopment                 |                 |       |                                        |  |  |  |  |  |
| Fund                                  | amentals of Sof                                                                                 | twa   | re and software d  | evelopment lifecycles   | . Overview of A | AU    | TOSAR methodology                      |  |  |  |  |  |
| and p                                 | principles of AU                                                                                | JTO   | SAR Architectur    | e. Use of MoTeC M80     | 00 ECU in eng   | ine   | management and data                    |  |  |  |  |  |
| Acqu                                  | isition Solution                                                                                | ıs.   |                    |                         | e               |       | -                                      |  |  |  |  |  |
|                                       |                                                                                                 |       | U                  | nit –V                  |                 |       | 09 Hrs                                 |  |  |  |  |  |

**Diagnostics and Safety in Automotive:** 

Timing Light, Engine Analyzer, Electronic Control System Diagnostics: Onboard diagnostics, Offboard diagnostics, Expert Systems, Occupant Protection Systems - Accelerometer based Air Bag systems, Case study on ON-BOARD, OFF-BOARD diagnostics.

Advances in Automotive Electronic Systems: Alternative Fuel Engines, Electric and Hybrid vehicles, Fuel cell powered cars, Collision Avoidance Radar warning Systems, Navigation: Navigation Sensors, Radio Navigation, dead reckoning navigation, Video based driver assistance systems, Night vision Systems

| Cours       | e Outcomes: After completing the course, the students will be able to                         |
|-------------|-----------------------------------------------------------------------------------------------|
| CO1:        | Acquire the knowledge of automotive domain fundamentals, need of Electronics and              |
|             | communication interfaces in Automotive systems.                                               |
| <b>CO2:</b> | Apply various types of sensors, actuators and Motion Control techniques in Automotive systems |
|             |                                                                                               |
| CO3:        | Analyze digital engine control systems and Embedded Software's and ECU's used in automotive   |
|             | systems.                                                                                      |
| <b>CO4:</b> | Illustrate the concepts of Diagnostics, safety and advances in Automotive electronic Systems. |
|             |                                                                                               |

#### **Reference Books**

- 1. Understanding Automotive Electronics, Williams. B. Ribbens, 6<sup>th</sup> Edition, 2003, Elsevier science, Newness publication, ISBN-9780080481494.
- 2. Automotive Electronics Handbook, Robert Bosch, 2004, John Wiley and Sons,

#### Continuous Internal Evaluation (CIE); Theory (100 Marks)

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#### Semester End Evaluation (SEE); Theory (100 Marks)

**SEE** for 100 marks is executed by means of an examination. The Question paper for each course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

| CO-PO Mapping |            |     |     |     |     |            |            |            |            |      |      |      |
|---------------|------------|-----|-----|-----|-----|------------|------------|------------|------------|------|------|------|
| CO/PO         | <b>PO1</b> | PO2 | PO3 | PO4 | PO5 | <b>PO6</b> | <b>PO7</b> | <b>PO8</b> | <b>PO9</b> | PO10 | PO11 | PO12 |
| CO1           | 3          | 1   | 2   | 1   | -   | -          | -          | -          | -          | -    | -    | 1    |
| CO2           | 3          | 2   | 2   | 1   | -   | 1          | -          | -          | -          | -    | -    | 1    |
| CO3           | 3          | 2   | 2   | 1   | -   | 1          | -          | -          | -          | -    | -    | 1    |
| CO4           | 3          | 1   | 2   | 1   | -   | 1          | -          | -          | -          | -    | -    |      |

Low-1 Medium-2 High-3

| Semester: VII                         |                                                                               |       |                  |                     |                      |      |                        |  |  |  |
|---------------------------------------|-------------------------------------------------------------------------------|-------|------------------|---------------------|----------------------|------|------------------------|--|--|--|
| MULTIMEDIA COMMUNICATION              |                                                                               |       |                  |                     |                      |      |                        |  |  |  |
| (Group G: Professional Core Elective) |                                                                               |       |                  |                     |                      |      |                        |  |  |  |
| Cou                                   | Course Code         :         16EC7G3         CIE         :         100 Marks |       |                  |                     |                      |      |                        |  |  |  |
| Cred                                  | Credits: L:T:P:S :                                                            |       | 4:0:0:0          |                     | SEE                  | :    | 100 Marks              |  |  |  |
| Tota                                  | l Hours                                                                       | :     | 48L              |                     | <b>SEE Duration</b>  | :    | 03 Hours               |  |  |  |
| Cou                                   | rse Learning (                                                                | Obje  | ctives: The stuc | dents will be able  | to                   |      |                        |  |  |  |
| 1                                     | Understand t                                                                  | he ba | sics of analog a | and digital video:  | video representation | on a | and transmission       |  |  |  |
| 2                                     | Analyze anal                                                                  | og ai | nd digital video | signals and syste   | ems                  |      |                        |  |  |  |
| 3                                     | Analyze the                                                                   | fund  | amental video p  | processing technic  | ques & acquire the   | bas  | sic skill of designing |  |  |  |
|                                       | video compre                                                                  | essio | n                | -                   | _                    |      |                        |  |  |  |
| 4                                     | Design video                                                                  | tran  | smission system  | ns: error control a | and rate control     |      |                        |  |  |  |

|                                                                                                | -           |  |  |  |  |  |  |  |
|------------------------------------------------------------------------------------------------|-------------|--|--|--|--|--|--|--|
| Unit-I                                                                                         | 10 Hrs      |  |  |  |  |  |  |  |
| Multimedia Communications: multimedia information representation, multimedia                   | networks,   |  |  |  |  |  |  |  |
| multimedia applications, network QoS and application QoS                                       |             |  |  |  |  |  |  |  |
| Unit – II                                                                                      | 10 Hrs      |  |  |  |  |  |  |  |
| Text and image compression, compression principles, text compression- Runlength, Huffman, LZW, |             |  |  |  |  |  |  |  |
| Image compression- GIF, TIFF and JPEG.                                                         |             |  |  |  |  |  |  |  |
| Unit –III                                                                                      |             |  |  |  |  |  |  |  |
| Audio and video compression: Introduction, audio compression, DPCM, ADPCM, APC, LPC, video     |             |  |  |  |  |  |  |  |
| compression, video compression principles,                                                     |             |  |  |  |  |  |  |  |
| Unit –IV                                                                                       |             |  |  |  |  |  |  |  |
| Video compression standards: H.261, H.263, MPEG, MPEG 1, MPEG 2, MPEG-4 and                    | Reversible  |  |  |  |  |  |  |  |
| VLCs,                                                                                          |             |  |  |  |  |  |  |  |
| Unit –V                                                                                        | 09 Hrs      |  |  |  |  |  |  |  |
| The Internet: Introduction, IP datagrams, fragmentation, Ip address, ARP and RARP, QoS         | . Transport |  |  |  |  |  |  |  |
| Protocol: Introduction, TCP/IP, TCP, UDP, RTP and RTCP.                                        | -           |  |  |  |  |  |  |  |

| Course | Course Outcomes: After completing the course, the students will be able to        |  |  |  |  |  |  |  |  |  |
|--------|-----------------------------------------------------------------------------------|--|--|--|--|--|--|--|--|--|
| CO1:   | Describe and describe various multimedia data.                                    |  |  |  |  |  |  |  |  |  |
| CO2:   | Analyze the representation of multimedia data.                                    |  |  |  |  |  |  |  |  |  |
| CO3:   | Describe the concept involved in MPEG4 standards.                                 |  |  |  |  |  |  |  |  |  |
| CO4:   | Develop algorithms for protocols like RTP,RTCP for multimedia communication .over |  |  |  |  |  |  |  |  |  |
|        | mobile networks.                                                                  |  |  |  |  |  |  |  |  |  |

| Refer | ence Books                                                                                                                                        |
|-------|---------------------------------------------------------------------------------------------------------------------------------------------------|
| 1     | Multimedia Communications, Fred Halsall, Pearson education, 2001. ISBN: 8131709949, 978-8131709948                                                |
| 2     | Multimedia Communication Systems, K. R. Rao, Zoran S. Bojkovic, Dragorad A. Milovanovic, Pearson education, 2004.ISBN: 013031398X978-0130313980   |
| 3     | Multimedia: Computing, Communications and Applications, Raif steinmetz, Klara Nahrstedt, Pearson education, 2002,ISBN: 3540408673, 978-3540408673 |
| 4     | Multimedia : An Introduction, John Billamil, Louis Molina, PHI, 2002, ISBN: 1575765578, 978-1575765570                                            |

**CIE** is executed by way of quizzes (Q), tests (T) and Assignment. A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for assignment is 10. The total marks of CIE are 100.

#### Semester End Evaluation (SEE); Theory (100 Marks)

**SEE** for 100 marks is executed by means of an examination. The Question paper for each course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

| CO-PO Mapping |            |     |     |            |     |            |            |            |            |      |      |      |
|---------------|------------|-----|-----|------------|-----|------------|------------|------------|------------|------|------|------|
| CO/PO         | <b>PO1</b> | PO2 | PO3 | <b>PO4</b> | PO5 | <b>PO6</b> | <b>PO7</b> | <b>PO8</b> | <b>PO9</b> | PO10 | PO11 | PO12 |
| CO1           | 3          | 1   | 2   | 1          | -   | -          | -          | -          | -          | -    | -    | 1    |
| CO2           | 3          | 2   | 2   | 1          | -   | 1          | -          | -          | -          | -    | -    | 1    |
| CO3           | 3          | 2   | 2   | 1          | -   | 1          | -          | -          | -          | -    | -    | 1    |
| <b>CO4</b>    | 3          | 1   | 2   | 1          | -   | 1          | -          | -          | -          | -    | -    |      |

Low-1 Medium-2 High-3

| Semester: VII                         |                                                                                             |   |         |  |              |   |           |  |  |
|---------------------------------------|---------------------------------------------------------------------------------------------|---|---------|--|--------------|---|-----------|--|--|
| VLSI TESTING FOR ICs                  |                                                                                             |   |         |  |              |   |           |  |  |
| (Group G: Professional Core Elective) |                                                                                             |   |         |  |              |   |           |  |  |
| Course Code                           |                                                                                             | : | 16EC7G4 |  | CIE          |   | 100 Marks |  |  |
| Credits: L:T:P:S                      |                                                                                             | : | 4:0:0:0 |  | SEE          | : | 100 Marks |  |  |
| Total Hours                           |                                                                                             | : | 48L     |  | SEE Duration | : | 03 Hours  |  |  |
| Cou                                   | Course Learning Objectives: The students will be able to                                    |   |         |  |              |   |           |  |  |
| 1                                     | Understand different types of faults associated with logic circuits and types of testing by |   |         |  |              |   |           |  |  |
|                                       | employing fault models to the logic circuits.                                               |   |         |  |              |   |           |  |  |
| 2                                     | 2 Understand advanced methods of simulation and digital testing algorithms and use the      |   |         |  |              |   |           |  |  |
|                                       | appropriate methods for achieving fault coverage specifications in design.                  |   |         |  |              |   |           |  |  |
| 3                                     | Explain the concepts Design for Testability                                                 |   |         |  |              |   |           |  |  |
| 4                                     | 4 Recognize different techniques in Built In Self-Test (BIST) such as MBIST and LBIST.      |   |         |  |              |   |           |  |  |

| Unit-I                                                                                            | 10 Hrs    |  |  |  |  |  |  |
|---------------------------------------------------------------------------------------------------|-----------|--|--|--|--|--|--|
| Introduction to Testing- Introduction to Testing, Role of testing VLSI circuits, VLSI trends      |           |  |  |  |  |  |  |
| affecting testing, Faults in digital circuits.                                                    |           |  |  |  |  |  |  |
| Fault Modeling- Functional Testing, Structural Testing, Types of Fault Models, Stuck-at Faults,   |           |  |  |  |  |  |  |
| Bridging Faults, cross point faults, Fault Equivalence, Fault Dominance                           |           |  |  |  |  |  |  |
| Unit – II                                                                                         | 10 Hrs    |  |  |  |  |  |  |
| Fault Simulation - Fault Simulation algorithm - Serial, Parallel, Deductive and Concurre          | ent Fault |  |  |  |  |  |  |
| Simulation.                                                                                       |           |  |  |  |  |  |  |
| Testability Measure - Controllability, Observability, SCOAP measures for combinational and        |           |  |  |  |  |  |  |
| sequential circuits.                                                                              |           |  |  |  |  |  |  |
| Unit –III                                                                                         |           |  |  |  |  |  |  |
| ATPG for Combinational Circuits- Path Sensitization Methods, Roth's D- Algorithm, Boolean         |           |  |  |  |  |  |  |
| Difference, Complexity of Sequential ATPG, Time Frame Expansion.                                  |           |  |  |  |  |  |  |
| Design for Testability- Ad-hoc, Structured DFT- Scan method, Scan Design Rules, Overheads of Scan |           |  |  |  |  |  |  |
| Design, partial scan methods, multiple chain scan methods.                                        |           |  |  |  |  |  |  |
| Unit –IV                                                                                          |           |  |  |  |  |  |  |
| Self-test And Test Algorithms-Built-In self-Test, test pattern generation for BIST, response      |           |  |  |  |  |  |  |
| compaction - Parity checking, Ones counting, Transition Count, Signature analyser (SISR and       |           |  |  |  |  |  |  |
| MISR).                                                                                            |           |  |  |  |  |  |  |
| Circular BIST, BIST Architectures.                                                                |           |  |  |  |  |  |  |
| Unit –V                                                                                           |           |  |  |  |  |  |  |
| Memory Testing-Testable Memory Design Test Algorithms, Reduced Functional Faults-MARCH and        |           |  |  |  |  |  |  |
| MAT+ algorithm. Test generation for Embedded RAMs. MBIST                                          |           |  |  |  |  |  |  |
|                                                                                                   |           |  |  |  |  |  |  |

| Course Outcomes: After completing the course, the students will be able to |                                                                                         |  |  |  |  |  |  |
|----------------------------------------------------------------------------|-----------------------------------------------------------------------------------------|--|--|--|--|--|--|
| <b>CO1:</b>                                                                | Attain knowledge about testing, fault modeling & collapsing.                            |  |  |  |  |  |  |
| <b>CO2:</b>                                                                | Explore various fault simulation methods.                                               |  |  |  |  |  |  |
| CO3:                                                                       | Evaluate the significance of combinational ATPG and sequential test pattern generation. |  |  |  |  |  |  |
| <b>CO4:</b>                                                                | Get complete knowledge about different methods of LBIST and MBIST associated            |  |  |  |  |  |  |
|                                                                            | with testing.                                                                           |  |  |  |  |  |  |

| Reference Books |                                                                                            |  |  |  |  |  |  |
|-----------------|--------------------------------------------------------------------------------------------|--|--|--|--|--|--|
| 1               | VLSI Test Principles and Architectures, L. T. Wang, C. W. Wu, and X. Wen, Morgan           |  |  |  |  |  |  |
|                 | Kaufmann, 2006, ISBN-13: 978-0-12-370597-6, ISBN-10: 0-12-370597-5.                        |  |  |  |  |  |  |
| 2               | Digital Circuit Testing and Testability, Parag.K.Lala, Academic Press.                     |  |  |  |  |  |  |
| 3               | Essentials of Electronic Testing for Digital, Memory, and Mixed-Signal VLSI Circuits M. L. |  |  |  |  |  |  |
|                 | Bushnell and V. D. Agrawal, Kluwer Academic Publishers, 2000, ISBN: 0-7923-7991-8.         |  |  |  |  |  |  |

| 4 | Digital Systems Testing and Testable Design M. Abramovici, M. A. Breuer, and A. D. |
|---|------------------------------------------------------------------------------------|
|   | Friedman, Computer Science Press, 1990, ISBN: 0-7167-8179-4.                       |

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#### Semester End Evaluation (SEE); Theory (100 Marks)

**SEE** for 100 marks is executed by means of an examination. The Question paper for each course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

| CO-PO Mapping |            |     |     |     |     |            |            |            |            |      |      |      |
|---------------|------------|-----|-----|-----|-----|------------|------------|------------|------------|------|------|------|
| CO/PO         | <b>PO1</b> | PO2 | PO3 | PO4 | PO5 | <b>PO6</b> | <b>PO7</b> | <b>PO8</b> | <b>PO9</b> | PO10 | PO11 | PO12 |
| CO1           | 2          | 2   | 2   | -   | 2   | -          | -          | -          | -          | 1    | -    | 1    |
| CO2           | 2          | 2   | 2   | 1   | 2   | -          | -          | -          | -          | 1    | -    | 1    |
| CO3           | 2          | 3   | 2   | 2   | 2   | -          | -          | -          | -          | 1    | -    | 1    |
| CO4           | 2          | 3   | 2   | 3   | 2   | -          | -          | -          | -          | 1    | -    | 1    |

Low-1 Medium-2 High-3
| Semester: VII |                                                                                                  |     |                    |                      |               |   |           |
|---------------|--------------------------------------------------------------------------------------------------|-----|--------------------|----------------------|---------------|---|-----------|
|               |                                                                                                  |     | HIGH S             | SPEED DIGITAI        | L DESIGN      |   |           |
|               |                                                                                                  |     | (Group G           | : Professional Co    | ore Elective) |   |           |
| Cou           | rse Code                                                                                         | :   | 16EC7G5            |                      | CIE           | : | 100 Marks |
| Crec          | lits: L:T:P:S                                                                                    | :   | 4:0:0:0            |                      | SEE           | : | 100 Marks |
| Tota          | Total Hours                                                                                      |     | 48L                |                      | SEE Duration  | : | 03 Hours  |
| Cou           | rse Learning (                                                                                   | Dbj | jectives: The stud | lents will be able t | 0             |   |           |
| 1             | Understand analog circuit principles relevant to high speed digital design.                      |     |                    |                      |               |   |           |
| 2             | Analyze power distribution and noise in Power supply network and signaling over                  |     |                    |                      |               |   |           |
|               | transmission lines.                                                                              |     |                    |                      |               |   |           |
| 3             | <b>3</b> Demonstrate the functionality of different clocked and non-clocked digital circuits and |     |                    |                      |               |   |           |
|               | memory elements.                                                                                 |     |                    |                      |               |   |           |
| 4             | Analyze the performance of clocked, non-clocked and latching circuits.                           |     |                    |                      |               |   |           |

| Unit-I                                                                                            | 10 Hrs        |  |  |  |  |
|---------------------------------------------------------------------------------------------------|---------------|--|--|--|--|
| The Interconnect: Introduction, Interconnect Modelling, Resistance, Capacitance, Inductance, Skin |               |  |  |  |  |
| Effect, Temperature Dependence, Interconnect Impact: Delay, Energy, Crosstalk, Induc              | tive Effects, |  |  |  |  |
| An Aside on Effective Resistance and Elmore Delay, Interconnect Engineering, Width, S             | Spacing, and  |  |  |  |  |
| Layer, Repeaters, Crosstalk Control, Low-Swing Signalling, Regenerators, Logical                  | Effort with   |  |  |  |  |
| Wires.                                                                                            |               |  |  |  |  |
| Unit – II                                                                                         | 10 Hrs        |  |  |  |  |

| Introduction to high speed digital design: Frequency, time and distance issues in a     | ligital VLSI |
|-----------------------------------------------------------------------------------------|--------------|
| design. Capacitance and inductance effects, high speed properties of logic gates, speed | and power.   |
| Modeling of wires, geometry and electrical properties of wires, Electrical model        | s of wires,  |
| transmission lines, lossless LC transmission lines, lossy RLC transmission lines        | and special  |
| transmission lines.                                                                     |              |

Unit –III10 HrsPower distribution and Noise: Power supply network, local power regulation, IR drops, area<br/>bonding. On-chip bypass capacitors and symbiotic bypass capacitors. Power supply isolation. Noise<br/>sources in digital systems, power supply noise, crosstalk and inter symbol interference. Power<br/>distribution on chips.

| Unit –IV                                                                         | 09 Hrs      |
|----------------------------------------------------------------------------------|-------------|
| Clocked & non clocked Logics:Non clocked Logic Styles: Static CMOS, DCVS         | Logic, Non- |
| Clocked Pass Gate FamiliesClocked Logic Styles: Single-Rail Domino Logic, Dual-F | Rail Domino |
| Structures                                                                       |             |

Unit –V09 HrsLatching Strategies:Basic Latch Design, and Latching single-ended logic and Differential Logic,<br/>Race Free Latches for Pre-charged Logic Asynchronous Latch Techniques, DDR memories.

| Course Outcomes: After completing the course, the students will be able to |                                                                                         |  |  |  |  |
|----------------------------------------------------------------------------|-----------------------------------------------------------------------------------------|--|--|--|--|
| CO1:                                                                       | Investigate the special requirements that are imposed on high speed digital design.     |  |  |  |  |
| <b>CO2:</b>                                                                | Analyze the characteristics of transmission lines and high speed latches and circuits.  |  |  |  |  |
| CO3:                                                                       | Analyze the Signaling convention in transmission media and high speed digital logics.   |  |  |  |  |
| <b>CO4:</b>                                                                | Evaluate the performance of various transmission lines and high speed digital circuits. |  |  |  |  |

| Refere | Reference Books                                                                       |  |  |  |  |  |
|--------|---------------------------------------------------------------------------------------|--|--|--|--|--|
| 1      | Digital Systems Engineering, William S. Dally & John W. Poulton, Cambridge University |  |  |  |  |  |
|        | Press, 1998. ISBN 0-521-59292-5                                                       |  |  |  |  |  |
| 2      | CMOS VLSI Design: A Circuit and Systems Perspective, Neil H. E. Weste David Money     |  |  |  |  |  |
|        | Harris Pearson Publication, 4th Edition, 2011, ISBN 13: 978-0-321-54774-3             |  |  |  |  |  |
|        | High Speed CMOS Design Styles, Kerry Bernstein, Keith M. Carrig, Christopher M.       |  |  |  |  |  |
| 3      | Durham, Patrick R. Hansen, David Hogenmiller, Edward J. Nowak, Norman J. Rohrer,      |  |  |  |  |  |
|        | Kluwer Academic Publishers in 1999, ISBN 978-1-4613-7549-4.                           |  |  |  |  |  |

| 4 | High Speed Digital Circuits, Masakazu Shoji, Addison Wesley Publishing Company, 1996. ISBN 978-0201634839.                                               |
|---|----------------------------------------------------------------------------------------------------------------------------------------------------------|
| 5 | High Speed Digital Design, Howard Johnson & Martin Graham, A Handbook of Black Magic, Prentice Hall PTR, 1993.                                           |
| 6 | Digital Integrated Circuits: A Design Perspective, Jan M.Rabaey, Anantha Chadrakasan,<br>Borivoje Nikolic, (2/e), Pearson 2016, ISBN-13: 978-0130909961. |

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## Semester End Evaluation (SEE); Theory (100 Marks)

|       |            |     |     |            | CO-l | PO Ma      | pping      |            |            |      |      |      |
|-------|------------|-----|-----|------------|------|------------|------------|------------|------------|------|------|------|
| CO/PO | <b>PO1</b> | PO2 | PO3 | <b>PO4</b> | PO5  | <b>PO6</b> | <b>PO7</b> | <b>PO8</b> | <b>PO9</b> | PO10 | PO11 | PO12 |
| CO1   | 3          | 2   | 2   | 1          | -    | -          | -          | -          | -          | 1    | -    | 1    |
| CO2   | 3          | 2   | 2   | 1          | 1    | -          | -          | -          | -          | 1    | -    | 1    |
| CO3   | 3          | 2   | 1   | 1          | 2    | -          | -          | -          | -          | 1    | -    | 1    |
| CO4   | 3          | 3   | 3   | 3          | 3    | -          | -          | -          | -          | 1    | -    | 1    |

Low-1 Medium-2 High-3

| Semester: VII |                                                                                  |     |                    |                    |                |   |           |
|---------------|----------------------------------------------------------------------------------|-----|--------------------|--------------------|----------------|---|-----------|
|               | MEMS AND SMART SYSTEMS                                                           |     |                    |                    |                |   |           |
|               |                                                                                  |     | (Group G           | : Professional C   | Core Elective) |   |           |
| Cou           | rse Code                                                                         | :   | 16EC7G6            |                    | CIE            | : | 100 Marks |
| Cred          | Credits: L:T:P:S                                                                 |     | 4:0:0:0            | SEE                |                | : | 100 Marks |
| Total Hours   |                                                                                  | :   | 48L                |                    | SEE Duration   | : | 03 Hours  |
| Cou           | rse Learning (                                                                   | Obj | jectives: The stud | lents will be able | to             |   |           |
| 1             | 1 Explain the operation principles of advanced micro- and smart systems.         |     |                    |                    |                |   |           |
| 2             | <b>2</b> Describe the technology to fabricate advanced micro- and smart systems. |     |                    |                    |                |   |           |
| 3             | <b>3</b> Understand different methods to fabricate MEMS devices.                 |     |                    |                    |                |   |           |
| 4             | Present the basics of implementation of MEMS into products                       |     |                    |                    |                |   |           |

| Unit-I                                                                                           | 10 Hrs         |  |  |  |  |
|--------------------------------------------------------------------------------------------------|----------------|--|--|--|--|
| Introduction to Micro and Smart Systems: Introduction, Microsystem vs MEMS, Sma                  | art Materials, |  |  |  |  |
| structures and system, Integrated Microsystems, Application of Smart Materials and Microsystems. |                |  |  |  |  |
| Feynman's vision, Evolution of micro-manufacturing. Multi-disciplinary aspects. Applic           | ations areas.  |  |  |  |  |
| Commercial products.                                                                             |                |  |  |  |  |
| Modelling: Scaling issues, Scaling in geometry, Scaling in rigid body dynamics                   | , scaling in   |  |  |  |  |
| electrostatic forces, scaling in electromagnetic forces, scaling in electricity, scaling in flu  | id dynamics.   |  |  |  |  |
| scaling effects in the optical domain, scaling in biochemical phenomena.                         | •              |  |  |  |  |
| Unit – II                                                                                        | 10 Hrs         |  |  |  |  |
| Micro and Smart Devices and Systems: Principles                                                  |                |  |  |  |  |
| Definitions and salient features of sensors, actuators, and systems. Sensors: silico             | n capacitive   |  |  |  |  |
| accelerometer, piezo-resistive pressure sensor, Actuators: silicon micro-mirror array            | s, magnetic    |  |  |  |  |
| micro relay, piezo-electric based inkjet printhead, electro-thermal actuator. portable blo       | od analyzer,   |  |  |  |  |
| fiber optic sensors, Electrostatic Comb drive, Microsystems at Radio frequency.                  | •              |  |  |  |  |
| Unit –III                                                                                        | 10 Hrs         |  |  |  |  |
| Materials: Introduction, Substrates and Wafers, Active substrate materials, Si as a substr       | ate material,  |  |  |  |  |
| Si compounds, Si Piezoresistors, Gallium Arsenide, Quartz, Piezoelectric Crystals and I          | Polymers.      |  |  |  |  |
| Micro Manufacturing and Material Processing: Silicon wafer processing, Oxidation, CVD, PVD       |                |  |  |  |  |
| , lithography, thin-film deposition, etching (wet and dry), wafer-bonding, and metalliza         | tion, Silicon  |  |  |  |  |
| micromachining: surface, bulk, bonding based process flows.                                      | 1              |  |  |  |  |
| Unit –IV                                                                                         | 09 Hrs         |  |  |  |  |
| Electronics Circuits for Micro and Smart Systems: Electronic Amplifiers, Signal (                | Conditioning   |  |  |  |  |
| Circuits: Differential Amplifier, Instrumentation Amplifier, Wheatstone Bridge, Phase L          | ocked Loop,    |  |  |  |  |
| Analog to Digital Conversion, Practical Signal Conditioning Circuits: Differen                   | itial Charge   |  |  |  |  |
| Measurement, Switched Capacitor circuits, Circuits for frequency measurement shifts.             | T              |  |  |  |  |
| Unit –V                                                                                          | 09 Hrs         |  |  |  |  |
| Electronics, Circuits and Packaging: Micro Systems Packaging, objectives and spec                | ial issues in  |  |  |  |  |
| micro system packaging, Types of Microsystem Packages, Packaging Technologies                    |                |  |  |  |  |
| Case study of devices Cantilevers, Pressure sensors, accelerometers, micro heater.               |                |  |  |  |  |
|                                                                                                  |                |  |  |  |  |
| Course Outcomes: After completing the course, the students will be able to                       |                |  |  |  |  |
| CO1: Describe main principles of MEMS and smart systems.                                         |                |  |  |  |  |
| CO2: Demonstrate confidence in MEMS and smart systems through practical expe                     | rience using   |  |  |  |  |
| typical modern Computer Aided Design software for this task                                      |                |  |  |  |  |

|             | typical modern Computer Anded Design software for this task.                             |
|-------------|------------------------------------------------------------------------------------------|
| <b>CO3:</b> | Apply a concept of a micro- and smart systems into a real device considering the scaling |
|             | laws and boundary conditions involved.                                                   |
| <b>CO4:</b> | Evaluate the principles and processes involved in the implementation of MEMS devices     |

| Refer | ence Books                                                                          |
|-------|-------------------------------------------------------------------------------------|
| 1     | MEMS & Microsystems: Design and Manufacture, Tai-Ran Tsu, Tata Mc-Graw-Hill.ISBN-   |
| -     | 13:9780070487093                                                                    |
| 2     | Micro and Smart Systems, K.J.Vinoy, G.K.Ananthasuresh, S.Gopalakrishnan, K.N.Bhat,  |
|       | Wiley India, ISBN: 9788126527151                                                    |
| 3     | Microsystems Design, S. D. Senturia, Kluwer Academic Publishers, Boston, USA, 2001, |
|       | ISBN 0-7923-7246-8.                                                                 |
| 4     | Analysis and Design Principles of MEMS Devices, Minhang Bao, Elsevier, Amsterdam,   |
|       | Netherlands, ISBN 0-444-51616-6.                                                    |

**CIE** is executed by way of quizzes (Q), tests (T) and Assignment. A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for assignment is 10. The total marks of CIE are 100.

# Semester End Evaluation (SEE); Theory (100 Marks)

| CO-PO Mapping |            |     |     |            |     |            |            |            |            |      |      |      |
|---------------|------------|-----|-----|------------|-----|------------|------------|------------|------------|------|------|------|
| CO/PO         | <b>PO1</b> | PO2 | PO3 | <b>PO4</b> | PO5 | <b>PO6</b> | <b>PO7</b> | <b>PO8</b> | <b>PO9</b> | PO10 | PO11 | PO12 |
| CO1           | 3          | 3   | 2   | 3          | 2   | -          | 1          | -          | -          | -    | -    | 1    |
| CO2           | -          | -   | 2   | -          | 2   | 1          | 1          | -          | 2          | -    | -    | 1    |
| CO3           | 3          | 1   | 2   | 3          | 2   | 1          | 1          | 1          | 1          | 1    | -    | 1    |
| CO4           | 1          | 3   | 3   | 3          | 2   | 1          | 1          | 1          | 1          | 1    | -    | 1    |

Low-1 Medium-2 High-3

|      | Semester: IV                                                                                     |      |                       |                        |                          |      |                |  |  |
|------|--------------------------------------------------------------------------------------------------|------|-----------------------|------------------------|--------------------------|------|----------------|--|--|
|      | NANOTECHNOLOGY                                                                                   |      |                       |                        |                          |      |                |  |  |
|      |                                                                                                  |      | (Grou                 | p H: Global Elective   | e)                       |      |                |  |  |
| Cour | rse Code                                                                                         | :    | 16G7H01               |                        | CIE                      | :    | 100 Marks      |  |  |
| Cred | lits: L:T:P:S                                                                                    | :    | 3:0:0:0               |                        | SEE                      | ••   | 100 Marks      |  |  |
| Tota | l Hours                                                                                          | :    | 36L                   |                        | SEE Duration             | :    | 3.00 Hours     |  |  |
| Cour | rse Learning C                                                                                   | )bje | ectives: The students | will be able to        |                          |      |                |  |  |
| 1    | To have the b                                                                                    | asic | knowledge of nano     | materials and the proc | cess.                    |      |                |  |  |
| 2    | Describe met                                                                                     | hod  | s of nanoscale manu   | facturing and characte | erization can be enal    | oled | l.             |  |  |
| 3    | To learn abou                                                                                    | t Na | ano sensors and their | applications in mecha  | anical, electrical, elec | ctro | nic, Magnetic, |  |  |
|      | Chemical field.                                                                                  |      |                       |                        |                          |      |                |  |  |
| 4    | 4 To understand the concept for a nanoscale product based on sensing, transducing, and actuating |      |                       |                        |                          |      |                |  |  |
|      | mechanism.                                                                                       |      |                       |                        |                          |      |                |  |  |
| 5    | To have awar                                                                                     | ene  | ss about the nanosca  | le products used in m  | ultidisciplinary field   | ls.  |                |  |  |

| Unit-I                                                                                                                                                                                                                                                                                                                                                          | 06 Hrs                             |  |  |  |  |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------|--|--|--|--|
| Introduction to Nanomaterials: History of Nanotechnology, structures and properties of                                                                                                                                                                                                                                                                          | of carbon                          |  |  |  |  |
| based: Fullerenes (Bucky Ball, Nanotubes), metal based: Nano Shells, Quantum Dots, Des                                                                                                                                                                                                                                                                          | ndrimers,                          |  |  |  |  |
| Diamond like carbon (DLC) Nanocarriers, bionanomaterails: protein & DNA based nanos                                                                                                                                                                                                                                                                             | tructures,                         |  |  |  |  |
| Hybrids: hybrid biological/inorganic, Nanosafety Issues: Toxicology health effects ca                                                                                                                                                                                                                                                                           | aused by                           |  |  |  |  |
| nanoparticles.                                                                                                                                                                                                                                                                                                                                                  |                                    |  |  |  |  |
| Unit – II                                                                                                                                                                                                                                                                                                                                                       | <b>08 Hrs</b>                      |  |  |  |  |
| <b>Characterization of Nanostructures: Spectroscopy</b> : UV-Visible spectroscopy, Fourier T infrared spectroscopy (FTIR), Raman Spectroscopy, X-ray spectroscopy. <b>Electron mic</b> Scanning electron microscopy (SEM), Transmission electron microscopy (TEM). <b>Scannin microscopy</b> : Atomic Force microscopy (AFM), Scanning tunnel microscopy (STM). | Transform<br>Croscopy:<br>ng probe |  |  |  |  |
| Nano Synthesis and Fabrication: Introduction & overview of Nanofabrication: Bottom up<br>down approaches using processes like Ball milling, Sol-gel Process, Chemical Vapour d<br>(CVD), plsma arching and various lithography techniques (Hard & Soft lithography).                                                                                            | o and Top<br>eposition             |  |  |  |  |
| Unit –III                                                                                                                                                                                                                                                                                                                                                       | 09 Hrs                             |  |  |  |  |
| Nanosensors: Overview of nanosensors, prospects and market. Types of Nanosensors                                                                                                                                                                                                                                                                                | and their                          |  |  |  |  |
| applications. Electromagnetic nanosensors: Electronic nose and electronic tongue,                                                                                                                                                                                                                                                                               | Magnetic                           |  |  |  |  |
| nanosensors. Mechanical nanosensors: Cantilever Nanosensors, Mechanics of CNTs, Bi                                                                                                                                                                                                                                                                              | osensors:                          |  |  |  |  |
| Biosensors in modern medicine.                                                                                                                                                                                                                                                                                                                                  |                                    |  |  |  |  |
| Unit –IV                                                                                                                                                                                                                                                                                                                                                        | 06 Hrs                             |  |  |  |  |
| Micro & Nano-Electromechanical systems and Microfluidics: MEMS/NEMS: Magnetic,<br>Chemical and Mechanical Transducers –Sensing and Actuators. Microfludics: Laminar flow, Hagen-<br>Peouiselle equation, basic fluid ideas, Special considerations of flow in small channels, mixing,<br>microvalves & micropumps.                                              |                                    |  |  |  |  |
| Unit –V                                                                                                                                                                                                                                                                                                                                                         | 07 Hrs                             |  |  |  |  |
| Applications of Nanotechnology: Molecular electronics, molecular switches, mechanic                                                                                                                                                                                                                                                                             | al cutting                         |  |  |  |  |

**Applications of Nanotechnology:** Molecular electronics, molecular switches, mechanical cutting tools, machine components, DLC coated grinding wheels. solar cells, Batteries, fuel cells, Nanofilters. Medical nanotechnology: in Diagnostics, Therapeutics, Drug delivery and Nanosurgery.

| Course      | Course Outcomes: After completing the course, the students will be able to                                               |  |  |  |  |  |  |
|-------------|--------------------------------------------------------------------------------------------------------------------------|--|--|--|--|--|--|
| CO1:        | Remember, understand, and apply knowledge about of nanomaterials and their uses.                                         |  |  |  |  |  |  |
| <b>CO2:</b> | Interpret and apply the techniques of manufacturing and characterization processes                                       |  |  |  |  |  |  |
| CO3:        | Apply the knowledge of Nanosensors, related to nanosensors in electronics, mechanical, chemical, and biological systems. |  |  |  |  |  |  |
| <b>CO4:</b> | Create and evaluate nano Design, Devices and Systems in various disciplines                                              |  |  |  |  |  |  |

# Reference Books1Textbook of Nanosciences and Nanotechnology, B.S. Murty., P. Shankar., B.Raj, B..B.1Rath, and J. Murday, Springer, Co-publication with University Press (India) Pvt. Ltd. VCH,<br/>XII.1st Edition, 2013, ISBN- 978-3-642-28030-6.2Physical, Chemical and Biological, V. K. Khanna, Nano sensors, CRC press, 1st<br/>edition, 2013, ISBN 9781439827123 (Unit III).3Nanostructured materials, Nanostructured materials, C. C. Kock, William Andrew<br/>Publishing, 2nd edition, 2007, ISBN 0-8155-1534-0.4Nanotechnology, M.Wilson., K. Kannangara., G.Smith., M.Simmons., B. Raguse, overseas<br/>Press (India) Private Ltd., 1st edition, 2005, ISBN 81-88689-20-3.

## **Continuous Internal Evaluation (CIE); Theory (100 Marks)**

**CIE** is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for Assignment/Presentation/Project 10. **Total CIE is 30(Q) + 60(T) + 10(A) = 100 Marks**.

#### Semester End Evaluation (SEE); Theory (100 Marks)

| Semester: VII                                                                        |                  |      |                         |                        |                      |       |                 |  |  |
|--------------------------------------------------------------------------------------|------------------|------|-------------------------|------------------------|----------------------|-------|-----------------|--|--|
| INDUSTRIAL SAFETY AND RISK MANAGEMENT                                                |                  |      |                         |                        |                      |       |                 |  |  |
| (Group H: Global Elective)                                                           |                  |      |                         |                        |                      |       |                 |  |  |
| Cours                                                                                | e Code           | :    | 16G7H02                 |                        | CIE                  | :     | 100 Marks       |  |  |
| Credit                                                                               | ts: L:T:P:S      | :    | 3:0:0:0                 |                        | SEE                  | :     | 100 Marks       |  |  |
| Total 2                                                                              | Hours            | :    | 36L                     |                        | SEE Duration         | :     | 3.00 Hours      |  |  |
| Cours                                                                                | e Learning (     | Obj  | ectives: The studen     | ts will be able to     |                      |       |                 |  |  |
| 1 Understand the basics of risk assessment methodologies                             |                  |      |                         |                        |                      |       |                 |  |  |
| 2 Select appropriate risk assessment techniques                                      |                  |      |                         |                        |                      |       |                 |  |  |
| 3                                                                                    | Analyze put      | olic | and individual perc     | eption of risk         |                      |       |                 |  |  |
| 4                                                                                    | Relate safet     | y, e | rgonomics and hum       | an factors             |                      |       |                 |  |  |
| 5                                                                                    | Carry out ris    | sk a | ssessment in proces     | s industries           |                      |       |                 |  |  |
|                                                                                      |                  |      |                         |                        |                      |       |                 |  |  |
|                                                                                      |                  |      | Ţ                       | J <b>nit-I</b>         |                      |       | 08 Hrs          |  |  |
| Gener                                                                                | al Risk Iden     | tifi | cation Methods – I      | •                      |                      |       |                 |  |  |
| Hazard                                                                               | l identification | n ı  | nethodologies, risk     | assessment methods     | s-PHA, HAZOP, M      | ICA   | , consequence   |  |  |
| analysi                                                                              | is, hazards ir   | ı w  | orkplaces-nature an     | d type of work place   | ces, types of hazard | ds, h | nazards due to  |  |  |
| improp                                                                               | per housekee     | oing | g, hazards due to fir   | e in multi floor indu  | stries and buildings | •     |                 |  |  |
|                                                                                      |                  |      | U                       | nit — II               |                      |       | 07 Hrs          |  |  |
| Risk A                                                                               | Assessment N     | /let | hods – II:              |                        |                      |       |                 |  |  |
| Risk a                                                                               | djusted disco    | unt  | ed rate method, cert    | ainty equivalent coef  | fficient method, qua | antit | ative analysis, |  |  |
| probab                                                                               | oility distribu  | tio  | n, coefficient of va    | ariation method, Sir   | nulation method, S   | Shac  | kle approach,   |  |  |
| Hiller                                                                               | 's model, Hei    | tz l | Model.                  |                        |                      |       | I               |  |  |
|                                                                                      |                  |      | UI                      | nit –III               |                      |       | 07 Hrs          |  |  |
| Risk N                                                                               | Aanagement       | _]   | II:                     |                        |                      |       |                 |  |  |
| Emerg                                                                                | ency relief S    | Syst | ems, Diers prograr      | n, bench scale expe    | riments, design of   | em    | ergency relief  |  |  |
| system                                                                               | ıs, risk m       | ana  | gement plan, man        | datory technology      | option analysis,     | risk  | management      |  |  |
| alterna                                                                              | tives, risk n    | nan  | agement tools, risl     | k management plan      | s, risk index meth   | 10d,  | Dowfire and     |  |  |
| explos                                                                               | ion method,      | Mo   | nd index Method.        |                        |                      |       |                 |  |  |
|                                                                                      |                  | _    | U                       | nit –IV                |                      |       | 07 Hrs          |  |  |
| Risk A                                                                               | Assurance an     | d A  | Assessment – IV:        |                        |                      | -     |                 |  |  |
| Proper                                                                               | ty insurance,    | tra  | insport insurance, li   | iability insurance, ri | sk Assessment, lov   | v Pr  | obability high  |  |  |
| consequence events. Fault tree analysis, Event tree analysis.                        |                  |      |                         |                        |                      |       |                 |  |  |
| Unit –V 07Hrs                                                                        |                  |      |                         |                        |                      |       |                 |  |  |
| Risk A                                                                               | Analysis in (    | Ch   | emical Industries       | V: Handling and s      | storage of chemical  | ls, p | process plants, |  |  |
| personnel protection equipment's. International environmental management system.     |                  |      |                         |                        |                      |       |                 |  |  |
|                                                                                      |                  |      |                         |                        |                      |       |                 |  |  |
| Cours                                                                                | e Outcomes:      | A    | fter completing the     | course, the studen     | ts will be able to   |       |                 |  |  |
| CO1:                                                                                 | Recall ris       | x as | sessment technique      | s used in process ind  | lustry               |       |                 |  |  |
| CO2:                                                                                 | Interpret t      | he   | various risk assessm    | nent tools             |                      |       |                 |  |  |
| CO3:                                                                                 | Use hazar        | d ic | lentification tools for | or safety managemen    | ıt                   |       |                 |  |  |
| <b>CO4:</b> Analyze tools and safety procedures for protection in process industries |                  |      |                         |                        |                      |       |                 |  |  |

**CO4:** Analyze tools and safety procedures for protection in process industries

| Refere | Reference Books                                                                                                                                                                                             |  |  |  |  |  |  |
|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|--|--|--|--|
| 1      | Functional Safety in the Process Industry : A Handbook of practical Guidance in the application of IEC61511 and ANSI/ISA-84, Kirkcaldy K.J.D Chauhan, North corolina, Lulu publication,2012,ISBN:1291187235 |  |  |  |  |  |  |
| 2      | Safety Instrumented Systems Verification Practical probabilistic calculations, Goble and William M., Pensulvania ISA publication,2005,ISBN:155617909X                                                       |  |  |  |  |  |  |
| 3      | Industrial safety and risk Management, Laird Wilson and Doug Mc Cutcheon, The University of Alberta press, Canada, 1 <sup>st</sup> Edition, 2003, ISBN: 0888643942.                                         |  |  |  |  |  |  |
| 4      | Environmental Engineering – A Design Approach, Sincero A P and Sincero G A, Prentice                                                                                                                        |  |  |  |  |  |  |

|   | Hall of India, New Delhi, 1996, ISBN: 0024105643                                         |
|---|------------------------------------------------------------------------------------------|
| 5 | Risks in Chemical units, Pandya C G, Oxford and IBH publications, New Delhi, 1992, ISBN: |
| 5 | 8120406907                                                                               |

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#### Total CIE is 30(Q) +60(T) +10(A) =100 Marks.

#### Semester End Evaluation (SEE); Theory (100 Marks)

|      | Semester: VII                                                       |             |                       |                     |            |   |            |  |  |
|------|---------------------------------------------------------------------|-------------|-----------------------|---------------------|------------|---|------------|--|--|
|      |                                                                     |             | INTELLIGEN            | T TRANSPORT SYST    | ГЕМ        |   |            |  |  |
|      |                                                                     |             | (Group                | H: Global Elective) |            |   |            |  |  |
| Cou  | urse Code                                                           |             | 16G7H03               | CII                 | E          | : | 100 Marks  |  |  |
| Crec | lits: L:T:P:S                                                       |             | 3:0:0:0               | SEI                 | E          | : | 100 Marks  |  |  |
| Tot  | al Hours                                                            | Hours : 36L |                       | SEI                 | E Duration | : | 3.00 Hours |  |  |
| Cou  | rse Learning (                                                      | Obje        | ectives: The student  | s will be able to   |            |   |            |  |  |
| 1    | Understand b                                                        | asic        | traffic flow and con  | ntrol for ITS       |            |   |            |  |  |
| 2    | 2 Understand user services for application in transportation system |             |                       |                     |            |   |            |  |  |
| 3    | 3 Understand ITS architecture and its planning at various levels    |             |                       |                     |            |   |            |  |  |
| 4    | Evaluate user                                                       | ser         | vices at various leve | els                 |            |   |            |  |  |

| Unit – I                                                                                            | 08 Hrs     |  |  |  |  |
|-----------------------------------------------------------------------------------------------------|------------|--|--|--|--|
| Introduction: -Historical Background, Definition, Future prospectus, ITS training and ed            | lucational |  |  |  |  |
| needs.                                                                                              |            |  |  |  |  |
| Fundamentals of Traffic Flow and Control- Traffic flow elements, Traffic flow models, Shock waves   |            |  |  |  |  |
| in Traffic streams, Traffic signalization and control principles, Ramp metering, Traffic simulation |            |  |  |  |  |
| Unit – II                                                                                           | 06 Hrs     |  |  |  |  |
| ITS User services-User services bundles, Travel and Traffic management, Public Trans                | sportation |  |  |  |  |
| Operations, Electronic Payment, Commercial Vehicles Operations, Emergency Mar                       | agement,   |  |  |  |  |
| Advanced Vehicle Control and safety systems, Information Management, Maintena                       | ance and   |  |  |  |  |
| construction Management                                                                             |            |  |  |  |  |
| Unit –III                                                                                           | 07 Hrs     |  |  |  |  |
| ITS Applications and their benefits-Freeway and incident management systems-o                       | bjectives, |  |  |  |  |
| functions, traffic Surveillance and incident detection, Ramp control, incident management, A        | Advanced   |  |  |  |  |
| arterial traffic control systems- historical development, Adaptive traffic control algorithms, A    | Advanced   |  |  |  |  |
| Public Transportation Systems-Automatic vehicle location systems, Transit Operations soft           | ware and   |  |  |  |  |
| information systems, Electronic fare payment systems, Multimodal Traveler Information systems       | tems       |  |  |  |  |
| Unit –IV                                                                                            | 07 Hrs     |  |  |  |  |
| ITS Architecture-Regional and Project ITS Architecture, Need of ITS architecture, co                | oncept of  |  |  |  |  |
| Operations, National ITS Architecture, Architecture development tool.                               | D1 .       |  |  |  |  |
| <b>TTS Planning</b> -Transportation planning and ITS, Planning and the National ITS Architecture,   | Planning   |  |  |  |  |
| for ITS, Integrating ITS into Transportation Planning, relevant case studies.                       |            |  |  |  |  |
| Unit –V                                                                                             | 08 Hrs     |  |  |  |  |
| <b>ITS Standards</b> -Standard development process, National ITS architecture and standards, ITS    | standards  |  |  |  |  |
| application areas, National Transportation Communications for ITS Protocol, Standards testi         | ng.        |  |  |  |  |
| <b>TTS Evaluation</b> – Project selection at the planning level, Deployment Tracking, Impact As     | sessment,  |  |  |  |  |
| Benefits by 115 components, Evaluation Guidelines, Challenges and Opportunities.                    |            |  |  |  |  |

| Course       | Course Outcomes: After completing the course, the students will be able to |  |  |  |  |
|--------------|----------------------------------------------------------------------------|--|--|--|--|
| CO1:         | Identify various applications of ITS                                       |  |  |  |  |
| <b>CO2:</b>  | Apply ITS applications at different levels.                                |  |  |  |  |
| CO3:         | Examine ITS architecture for planning process.                             |  |  |  |  |
| <b>CO4</b> : | Define the significance of ITS for various levels                          |  |  |  |  |

| Refere | ence Books                                                                                                                                                                                             |
|--------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1      | Fundamentals of Intelligent Transportation Systems Planning, Choudury M A and Sadek A, Artech House publishers (31 March 2003); ISBN-10: 1580531601                                                    |
| 2      | Intelligent transportation systems standards, Bob Williams, Artech House, London, 2008. ISBN-13: 978-1-59693-291-3.                                                                                    |
| 3      | Intelligent Transport Systems: Technologies and Applications, Asier Perallos, Unai Hernandez-Jayo, Enrique Onieva, Ignacio Julio García Zuazola, Wiley Publishing ©2015, ISBN:1118894782 9781118894781 |
| 4      | ITS Hand Book 2000 Recommendations for World Road Association (PIARC) by Kan Paul Chen, John Miles.                                                                                                    |
| 5      | Intelligent Transport Systems, Dominique Luzeaux ,Jean-René Ruault, Michel Chavret, 7<br>MAR 2013 Copyright © 2010 by John Wiley & Sons, Inc<br>DOI: 10.1002/9781118557495.ch6                         |

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# Semester End Evaluation (SEE); Theory (100 Marks)

| Semester: VII |                                                                              |     |                       |                       |                       |       |            |  |  |
|---------------|------------------------------------------------------------------------------|-----|-----------------------|-----------------------|-----------------------|-------|------------|--|--|
|               | INTELLIGENT SYSTEMS                                                          |     |                       |                       |                       |       |            |  |  |
|               |                                                                              |     | (Grou                 | p H: Global Electiv   | <b>ve</b> )           |       |            |  |  |
| Cou           | rse Code                                                                     | :   | 16G7H04               |                       | CIE                   |       | 100 Marks  |  |  |
| Cred          | lits: L:T:P:S                                                                | :   | 3:0:0:0               |                       | SEE                   |       | 100 Marks  |  |  |
| Tota          | l Hours                                                                      | :   | 35L                   | SEE Duration          |                       |       | 3.00 Hours |  |  |
| Cou           | rse Learning (                                                               | Dbj | ectives: The studen   | ts will be able to    |                       |       |            |  |  |
| 1             | Understand for                                                               | und | amental AI concept    | s and current issues. |                       |       |            |  |  |
| 2             | Understand a                                                                 | nd  | apply a range of AI   | techniques including  | g search, logic-based | l rea | asoning,   |  |  |
|               | neural networks and reasoning with uncertain information.                    |     |                       |                       |                       |       |            |  |  |
| 3             | 3 Recognize computational problems suited to an intelligent system solution. |     |                       |                       |                       |       |            |  |  |
| 4             | Identify and I                                                               | ist | the basic issues of k | nowledge representa   | ation, blind and heur | isti  | c search.  |  |  |

| 0/11/5                                                                                                  |
|---------------------------------------------------------------------------------------------------------|
| Introduction: The Foundations of Artificial Intelligence, History of Artificial Intelligence, The State |
| of the Art, Intelligent Agent: Introduction, How Agents Should Act, Structure of Intelligent Agents,    |
| Problem-solving: Solving Problems by Searching Search Strategies, Avoiding Repeated States              |
| ,Avoiding Repeated States                                                                               |

Unit – II07 HrsInformed Search Methods: Best-First Search, Heuristic Functions, Memory Bounded Search,<br/>Iterative Improvement AlgorithmsSearch

**Game Playing:** Introduction: Games as Search Problems, Perfect Decisions in Two-Person, Games Imperfect Decisions, Alpha-Beta Pruning, Games That Include an Element of Chance

| nit –III |
|----------|
|----------|

**Knowledge Inference** 

Knowledge representation -Production based system, Frame based system. Inference - Backward chaining, Forward chaining, Rule value approach, Fuzzy reasoning - Certainty factors, Bayes Rule, Uncertainty Principles, Bayesian Theory-Bayesian Network-Dempster - Shafer theory.

| Unit –IV                                                                             | 07 Hrs   |
|--------------------------------------------------------------------------------------|----------|
| Learning from Observations: A General Model of Learning Agents, Inductive Learning,  | Learning |
| Decision Trees, Using Information Theory, Learning General Logical Descriptions, Why | Learning |
| Works: Computational Learning Theory                                                 |          |
| Reinforcement Learning: Passive Learning in a Known Environment, Passive Learni      | ng in an |
| Unknown Environment, Active Learning in an Unknown Environment                       |          |
|                                                                                      |          |
| <b>T</b> T •4 <b>T</b> T                                                             |          |

| Unit – v                                                                                 | 0/Hrs      |
|------------------------------------------------------------------------------------------|------------|
| Expert Systems, Components, Production rules, Statistical reasoning, certainty factors,m | easure of  |
| belief and disbelief, Meta level knowledge, Introspection. Expert systems - Architecture | of expert  |
| systems, Roles of expert systems - Knowledge Acquisition -Meta knowledge, Heuristics     | 3. Typical |
| expert systems - MYCIN, DART, XOON, Expert systems shells.                               |            |

| Course      | Course Outcomes: After completing the course, the students will be able to               |  |  |  |  |  |  |  |
|-------------|------------------------------------------------------------------------------------------|--|--|--|--|--|--|--|
| CO1:        | Understand and explore the basic concepts and challenges of Artificial Intelligence.     |  |  |  |  |  |  |  |
| <b>CO2:</b> | Analyze and explain basic intelligent system algorithms to solve problems.               |  |  |  |  |  |  |  |
| CO3:        | Apply Artificial Intelligence and various logic-based techniques in real world problems. |  |  |  |  |  |  |  |
| <b>CO4:</b> | Assess their applicability by comparing different Intelligent System techniques          |  |  |  |  |  |  |  |

07 Hrs

| Refere | ence Books                                                                                                                         |
|--------|------------------------------------------------------------------------------------------------------------------------------------|
| 1      | AI – A Modern Approach ,Stuart Russel, Peter Norvig , 2 <sup>nd</sup> Edition, Pearson Education, 2010, ISBN-13: 978-0137903955.   |
| 2      | Artificial Intelligence (SIE) ,Kevin Night, Elaine Rich, Nair B., ,McGraw Hill, 1 <sup>st</sup> Edition, 2008, ISBN: 9780070087705 |
| 3      | Introduction to AI and ES ,Dan W. Patterson, Pearson Education, 1 <sup>st</sup> Edition ,2007. ISBN: 0132097680                    |
| 4      | Introduction to Expert Systems ,Peter Jackson, 3 <sup>rd</sup> Edition, Pearson Education, 2007, ISBN-<br>978-0201876864           |

**CIE** is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 60 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for Assignment/Presentation/Project 10. **Total CIE is 30(Q) + 60(T) + 10(A) = 100 Marks**.

## Semester End Evaluation (SEE); Theory (100 Marks)

**SEE** for 100 marks is executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

| CO-PO Mapping |            |     |     |     |     |            |            |            |            |      |      |      |
|---------------|------------|-----|-----|-----|-----|------------|------------|------------|------------|------|------|------|
| CO/PO         | <b>PO1</b> | PO2 | PO3 | PO4 | PO5 | <b>PO6</b> | <b>PO7</b> | <b>PO8</b> | <b>PO9</b> | PO10 | PO11 | PO12 |
| CO1           | 3          | 3   | 3   | 3   | 3   | 2          | 2          | 1          | 2          | -    | 2    | 2    |
| CO2           | 3          | 3   | 3   | 3   | 3   | 2          | 2          | 1          | 2          | -    | 2    | 2    |
| CO3           | 3          | 3   | 3   | 3   | 3   | 2          | 1          | 1          | 2          | -    | 2    | 2    |
| CO4           | 3          | 3   | 3   | 3   | 3   | 1          | 2          | 1          | 1          | 1    | 2    | 2    |

High-3: Medium-2 : Low-1

|                                                                                                 | Semester: VII                                                       |                             |                                                                                          |                                                                                  |                                                            |            |                                  |  |
|-------------------------------------------------------------------------------------------------|---------------------------------------------------------------------|-----------------------------|------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------|------------------------------------------------------------|------------|----------------------------------|--|
| IMAGE PROCESSING AND MACHINE LEARNING                                                           |                                                                     |                             |                                                                                          |                                                                                  |                                                            |            |                                  |  |
| (Group H: Global Elective)                                                                      |                                                                     |                             |                                                                                          |                                                                                  |                                                            |            |                                  |  |
| Cou                                                                                             | rse Code                                                            | :                           | 16G7H05                                                                                  |                                                                                  | CIE                                                        | :          | 100 Marks                        |  |
| Crea                                                                                            | lits: L:T:P:S                                                       | :                           | 3:0:0:0                                                                                  |                                                                                  | SEE                                                        | :          | 100 Marks                        |  |
| Tota                                                                                            | l Hours                                                             | :                           | 40L                                                                                      |                                                                                  | SEE Duration                                               | :          | 03 Hours                         |  |
| Cou                                                                                             | rse Learning (                                                      | Obj                         | ectives: The studen                                                                      | ts will be able to                                                               |                                                            |            |                                  |  |
| 1                                                                                               | Understand th                                                       | ne r                        | najor concepts and                                                                       | techniques in image                                                              | processing and Mac                                         | chine      | e Learning                       |  |
| 2                                                                                               | To explore, n                                                       | nani                        | pulate and analyze                                                                       | image processing tec                                                             | chniques                                                   |            |                                  |  |
| 3                                                                                               | To become fa                                                        | mil                         | iar with regression                                                                      | methods, classificati                                                            | on methods, cluster                                        | ing        | methods.                         |  |
| 4                                                                                               | Demonstrate                                                         | ima                         | ige processing and I                                                                     | Machine Learning kr                                                              | nowledge by design                                         | ing a      | and                              |  |
|                                                                                                 | implementing                                                        | g alg                       | gorithms to solve pr                                                                     | actical problems                                                                 |                                                            |            |                                  |  |
|                                                                                                 |                                                                     |                             |                                                                                          |                                                                                  |                                                            |            |                                  |  |
|                                                                                                 |                                                                     |                             | J                                                                                        | U <b>nit-I</b>                                                                   |                                                            |            | 08 Hrs                           |  |
| Intro                                                                                           | oduction to im                                                      | age                         | e processing:                                                                            |                                                                                  |                                                            |            |                                  |  |
| Imag                                                                                            | ges, Pixels, Im                                                     | age                         | resolution, PPI and                                                                      | d DPI, Bitmap imag                                                               | ges, Lossless and lo                                       | ossy       | compression,                     |  |
| Imag                                                                                            | ge file formats                                                     | , C                         | olor spaces, Bezier                                                                      | curve, Ellipsoid, C                                                              | Gamma correction,                                          | Adv        | vanced image                     |  |
| conc                                                                                            | epts                                                                |                             |                                                                                          |                                                                                  |                                                            |            |                                  |  |
|                                                                                                 |                                                                     |                             | U                                                                                        | nit – II                                                                         |                                                            |            | 08 Hrs                           |  |
| uploa<br>simil                                                                                  | cs of python, values of python, values adding & view larities.      | vari<br>ving                | ables & data types<br>an image, Image                                                    | , data structures, co<br>resolution, gamma                                       | a correction, deter                                        | min        | al statements,<br>ing structural |  |
|                                                                                                 |                                                                     |                             | Uı                                                                                       | nit —III                                                                         |                                                            |            | 08 Hrs                           |  |
| Adva<br>Blen<br>, Me<br>Thre                                                                    | anced Image J<br>ding Two Imag<br>dian Filter ,Ga<br>sholding ,Calc | oro<br>ges,<br>auss<br>ulat | cessing using Open<br>Changing Contrast<br>ian Filter ,Bilateral<br>ing Gradients , Perf | a <b>CV</b><br>and Brightness Addi<br>Filter ,Changing th<br>Forming Histogram E | ing Text to Images S<br>le Shape of Images<br>Equalization | Smo<br>,Ef | othing Images<br>fecting Image   |  |
|                                                                                                 |                                                                     |                             | Uı                                                                                       | nit –IV                                                                          |                                                            |            | 08 Hrs                           |  |
| Mac                                                                                             | hine Learning                                                       | ; Te                        | echniques in Image                                                                       | e Processing                                                                     |                                                            |            |                                  |  |
| Baye                                                                                            | esian Classifica                                                    | tio                         | n, Maximum Likelil                                                                       | nood Methods, Neura                                                              | al Networks; Non-p                                         | aran       | netric models;                   |  |
| Man                                                                                             | ifold estimation                                                    | n, S                        | upport Vector Mac                                                                        | hines, Logistic Regre                                                            | ession                                                     |            |                                  |  |
|                                                                                                 |                                                                     |                             | U                                                                                        | nit –V                                                                           |                                                            |            | <b>08 Hrs</b>                    |  |
| Intro                                                                                           | o <mark>duction to</mark> ob                                        | jec                         | t Tracking , Model                                                                       | ling & Recognition                                                               |                                                            |            |                                  |  |
| Exhaustive vs. Stochastic Search, Shapes, Contours, and Appearance Models. Mean-shift tracking; |                                                                     |                             |                                                                                          |                                                                                  |                                                            |            |                                  |  |
| Contour-based models, Adaboost approaches: Face Detection / Recognition, Tracking.              |                                                                     |                             |                                                                                          |                                                                                  |                                                            |            |                                  |  |
|                                                                                                 |                                                                     |                             |                                                                                          |                                                                                  |                                                            |            |                                  |  |
| Cou                                                                                             | rse Outcomes                                                        | : Af                        | ter completing the                                                                       | course, the studen                                                               | ts will be able to                                         |            |                                  |  |
| <b>CO1</b>                                                                                      | : Gain know                                                         | ledg                        | ge about basic conc                                                                      | epts of Image Proces                                                             | sing                                                       |            |                                  |  |
| CO2                                                                                             | Lentify ma                                                          | ichi                        | ne learning techniq                                                                      | ues suitable for a giv                                                           | ren problem                                                |            |                                  |  |
| <b>CO3</b>                                                                                      | : Write prog                                                        | ram                         | s for specific applic                                                                    | cations in image proc                                                            | essing                                                     |            |                                  |  |

**CO4:** Apply different techniques for various applications using machine learning techniques.

| Refe | erence Books                                                                               |
|------|--------------------------------------------------------------------------------------------|
| 1    | Practical Machine Learning and Image Processing: For Facial Recognition, Object Detection, |
| -    | and Pattern Recognition Using Python, by Himanshu Singh, Apress publisher.                 |
| 2    | Pattern Recognition and Machine Learning, by Christopher Bishop, Springer, 2008            |
| 3    | Computer Vision: A modern Approach by David Forsyth and Jean Ponce, Prentice Hall India    |
|      | 2004.                                                                                      |
| 4    | Machine Vision : Theory Algorithms Practicalities , by E.R. Davies Elsevier 2005.          |
| 5    | Digital Image Processing, Rafael C. Gonzalez and Richard E. Woods Pearson Education, Ed,   |
| 3    | 2001.                                                                                      |

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## Semester End Evaluation (SEE); Theory (100 Marks)

|                                                                                                                                                                                                                                                |               |                | SEMESTER: '              | VII                        |       |        |                 |  |  |  |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------|----------------|--------------------------|----------------------------|-------|--------|-----------------|--|--|--|
| DESIGN OF RENEWABLE ENERGY SYSTEMS                                                                                                                                                                                                             |               |                |                          |                            |       |        |                 |  |  |  |
| ~ ~ ~                                                                                                                                                                                                                                          | r –           |                | (Group H: Global E       | lective)                   |       | 100    |                 |  |  |  |
| Course Code                                                                                                                                                                                                                                    | :             | 16G7H06        |                          | CIE Marks                  | :     | 100    |                 |  |  |  |
| Credits: L:T:P:S                                                                                                                                                                                                                               | :             | 3:0:0:0        |                          | SEE Marks                  | :     | 100    | )               |  |  |  |
| Total Hours                                                                                                                                                                                                                                    |               | 40L            |                          | SEE Duration               | :     | 3.0    | 0 Hours         |  |  |  |
| Lourse Learning (                                                                                                                                                                                                                              | Jbje          | cuves:         | to to month on multidia  | inlinent projects          |       |        |                 |  |  |  |
| <ol> <li>To provide opportunity for students to work on multidisciplinary projects.</li> <li>To familiarize the students with the basic concerts of renegatively and students with the basic concerts of renegatively and students.</li> </ol> |               |                |                          |                            |       |        |                 |  |  |  |
| 2 To tamiliarize the students with the basic concepts of nonconventional energy sources and allied technological systems for energy conversion                                                                                                 |               |                |                          |                            |       |        |                 |  |  |  |
| <b>3</b> To impart skill to formulate, solve and analyze basic Non – conventional energy problems and prepare                                                                                                                                  |               |                |                          |                            |       |        |                 |  |  |  |
| them for gradua                                                                                                                                                                                                                                | te sti        | idies.         |                          | n conventional energy      | prot  |        | , and propulo   |  |  |  |
| 4 To enable the st                                                                                                                                                                                                                             | uden          | t to design pr | imarily solar and wind   | power systems.             |       |        |                 |  |  |  |
| 5 To expose the st                                                                                                                                                                                                                             | uder          | nts to various | applications of solar, v | vind and tidal systems.    |       |        |                 |  |  |  |
|                                                                                                                                                                                                                                                |               |                | UNIT – I                 | 2                          |       |        | 07 Hrs          |  |  |  |
| An introduction to                                                                                                                                                                                                                             | ene           | rgy sources:   |                          |                            |       |        |                 |  |  |  |
| Industry overview,                                                                                                                                                                                                                             | ince          | entives for re | enewable, utility persp  | ective, Relevant problem   | ns d  | iscus  | sion, current   |  |  |  |
| positions of renewa                                                                                                                                                                                                                            | ble e         | nergy conditi  | ons                      |                            |       |        |                 |  |  |  |
|                                                                                                                                                                                                                                                |               |                | UNIT – II                |                            |       |        | 09 Hrs          |  |  |  |
| <b>PV Technology:</b>                                                                                                                                                                                                                          |               |                |                          |                            |       |        |                 |  |  |  |
| photovoltaic power                                                                                                                                                                                                                             | , PV          | projects, Buil | lding-integrated PV sy   | stem, PV cell technologie  | es, s | olar e | energy maps,    |  |  |  |
| Technology trends,                                                                                                                                                                                                                             | Phot          | tovoltaic Pow  | ver Systems: PV cell, N  | Module and Array, Equiva   | alen  | t elec | trical circuit, |  |  |  |
| open-circuit voltage                                                                                                                                                                                                                           | e and         | short-circuit  | current, I-V and P-V c   | curves, Array design (diff | erer  | it met | thodologies),   |  |  |  |
| peak-power operation                                                                                                                                                                                                                           | on, s         | ystem compo    | nents.                   |                            |       |        |                 |  |  |  |
|                                                                                                                                                                                                                                                |               |                | UNIT – III               |                            |       |        | 09 Hrs          |  |  |  |
| Wind Speed and E                                                                                                                                                                                                                               | nerg          | gy:            |                          |                            |       |        |                 |  |  |  |
| Speed and power re                                                                                                                                                                                                                             | elatio        | ns, power ext  | tracted from the wind,   | Air density, Global wind   | l pa  | tterns | , wind speed    |  |  |  |
| distribution (parame                                                                                                                                                                                                                           | eters         | calculations)  | , wind speed predictio   | n, Wind Power Systems      | : sy  | vstem  | components      |  |  |  |
| , turbine rating , po                                                                                                                                                                                                                          | wer v         | vs. speed and  | TSR, maximum energ       | y capture, maximum pow     | er o  | operat | tion, system-   |  |  |  |
| design trade-offs, s                                                                                                                                                                                                                           | yster         | n control requ | uirements, environmen    | tal aspects.               |       |        |                 |  |  |  |
|                                                                                                                                                                                                                                                |               |                | UNIT – IV                |                            |       |        | 07 Hrs          |  |  |  |
| Geothermal and o                                                                                                                                                                                                                               | cean          | energy:        |                          |                            |       |        |                 |  |  |  |
| Geothermal power,                                                                                                                                                                                                                              | , geo         | pressured s    | sources, Geothermal      | well drilling, advantage   | s ai  | nd di  | sadvantages,    |  |  |  |
| Comparison of flash                                                                                                                                                                                                                            | ned s         | team and tota  | l flow concept           |                            |       |        | -               |  |  |  |
| Energy from ocean                                                                                                                                                                                                                              | <b>n</b> : O] | FEC power ge   | eneration, OPEN and C    | CLOSED cycle OTEC. Es      | stim  | ate of | f Energy and    |  |  |  |
| power in simple sin                                                                                                                                                                                                                            | gle b         | asin tidal and | l double basin tidal sys | tem                        |       |        |                 |  |  |  |
|                                                                                                                                                                                                                                                |               |                | UNIT – V                 |                            |       |        | 08 Hrs          |  |  |  |
| Stand-alone system                                                                                                                                                                                                                             | n:            |                |                          |                            |       |        |                 |  |  |  |
| PV stand-alone, Ele                                                                                                                                                                                                                            | ectric        | vehicle, win   | d standalone, hybrid s   | ystems (case study), syst  | em    | sizing | g, wind farm    |  |  |  |
| sizing.                                                                                                                                                                                                                                        |               |                |                          |                            |       |        |                 |  |  |  |
| Grid-Connected S                                                                                                                                                                                                                               | ystei         | ms: introduct  | tion, interface require  | nents, synchronizing wit   | h th  | ne gri | id, operating   |  |  |  |
| limit, Energy storage and load scheduling, Grid stability issues, distributed power generation.                                                                                                                                                |               |                |                          |                            |       |        |                 |  |  |  |
| Course outcomes:                                                                                                                                                                                                                               |               | 1 / 1          |                          |                            | c     | NT     | . 1             |  |  |  |
| COI: Demonstrate                                                                                                                                                                                                                               | an ı          | understanding  | g of the scientific pri  | nciples of methodology     | of    | Non-   | conventional    |  |  |  |
| energy.                                                                                                                                                                                                                                        | rin ~ 1       | knowledge of   | different Denewskie      | normy agionas related to   | ioc   |        |                 |  |  |  |
| CO2: Acquire work                                                                                                                                                                                                                              | ung l         | the exetern    | lated concents offer the | volv in the wind an area 1 | ucs.  | nina   |                 |  |  |  |
| COA: Studente will                                                                                                                                                                                                                             | uyze          | able to desid  | a the appropriate pro-   | very in the wind energy de | -81g  | ung.   | a model her     |  |  |  |
| developed pr                                                                                                                                                                                                                                   | nerl          |                | e de appropriate proc    | cours to ensure that the   | e w   | UIKIII | g model has     |  |  |  |
| developed pro                                                                                                                                                                                                                                  | operl         | у.             |                          |                            |       |        |                 |  |  |  |

| Refer | ence Books                                                                                                                      |
|-------|---------------------------------------------------------------------------------------------------------------------------------|
| 1.    | Wind and Solar Power Systems Design, Analysis and operation, Mukund R Patel, 2 <sup>nd</sup> Edition, 2006,                     |
|       | Taylor and Francis publishers, ISBN 978-0-8493-1570-1.                                                                          |
| 2.    | Non-Conventional sources of energy, G.D.Rai, 4th Edition, 2009, Khanna Publishers, ISBN                                         |
|       | 8174090738, 9788174090737,                                                                                                      |
| 3.    | Solar Energy, Sukhatme, 4 <sup>th</sup> Edition, 2017, McGraw Hill Education, <b>ISBN-13</b> : 978-9352607112                   |
| 4.    | Renewable energy sources, John Twidell, Tony Weir, 3 <sup>rd</sup> Edition, 2015, Routledge Publisher, ISBN-13: 978-0415584388. |

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## Total CIE is 30(Q) +60(T) +10(A) =100 Marks.

## Semester End Evaluation (SEE); Theory (100 Marks)

|                                                                                               |                                                                                                           |      |                        | VII Semester                      |                       |       |               |            |  |
|-----------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------|------|------------------------|-----------------------------------|-----------------------|-------|---------------|------------|--|
| SYSTEMS ENGINEERING                                                                           |                                                                                                           |      |                        |                                   |                       |       |               |            |  |
| (Group H: Global Elective)                                                                    |                                                                                                           |      |                        |                                   |                       |       |               |            |  |
| Coι                                                                                           | irse Code                                                                                                 | :    | 16G7H07                |                                   | CIE Marks             | :     | 100           |            |  |
| Cre                                                                                           | dits: L:T:P:S                                                                                             | :    | 3:0:0:0                |                                   | SEE Marks             | :     | 100           |            |  |
| Tot                                                                                           | al Hours                                                                                                  | :    | 33L                    |                                   | SEE Duration          | :     | 03 Hours      | 6          |  |
| Coι                                                                                           | irse Learning                                                                                             | Ob   | jectives:              |                                   |                       |       |               |            |  |
| 1                                                                                             | Develop an ap                                                                                             | pre  | eciation and unc       | lerstanding of the role of system | s engineering proce   | esse  | s and syster  | ms         |  |
|                                                                                               | management i                                                                                              | n p  | producing produ        | icts and services.                |                       |       |               |            |  |
| 2                                                                                             | Document sys                                                                                              | ster | natic measurem         | ent approaches for generally cr   | oss disciplinary dev  | velo  | pment effor   | rt.        |  |
| 3                                                                                             | Discuss capab                                                                                             | ilit | ty assessment m        | odels to evaluate and improve     | orgnizational system  | ns e  | engineering   |            |  |
|                                                                                               | capabilities.                                                                                             |      |                        |                                   |                       |       |               |            |  |
|                                                                                               |                                                                                                           |      |                        |                                   |                       |       |               |            |  |
|                                                                                               |                                                                                                           |      |                        | Unit-I                            |                       |       | 07 H          | <b>irs</b> |  |
| Sys                                                                                           | tem Engineeri                                                                                             | ng   | and the Wor            | d of Modem System: What i         | is System Enginee     | ring  | ?, Origins    | of         |  |
| Sys                                                                                           | tem Engineerii                                                                                            | ıg,  | Examples of            | Systems Requiring Systems         | Engineering, Sys      | tem   | Engineerii    | ng         |  |
| viev                                                                                          | vpoint, Systems                                                                                           | s Ei | ngineering as a        | Profession, The power of Syste    | ms Engineering, pr    | oble  | ems.          |            |  |
| Stru                                                                                          | ucture of Com                                                                                             | ple  | <b>x Systems:</b> Sys  | tem building blocks and interfa   | ces, Hierarchy of C   | Com   | plex system   | ns,        |  |
| Sys                                                                                           | tem building bl                                                                                           | ock  | s, The system e        | environment, Interfaces and Inte  | eractions.            |       |               |            |  |
| The                                                                                           | e System Devel                                                                                            | op   | ment Process:          | Systems Engineering through t     | the system Life Cy    | cle,  | Evolutiona    | ıry        |  |
| Cha                                                                                           | racteristics of t                                                                                         | he   | development p          | rocess, The system engineering    | method, Testing th    | irou  | ghout syste   | em         |  |
| dev                                                                                           | elopment, probl                                                                                           | em   | 18.                    |                                   |                       |       |               |            |  |
|                                                                                               |                                                                                                           |      |                        | Unit – II                         |                       |       | 07 H          | írs        |  |
| Sys                                                                                           | tems Engineer                                                                                             | in   | g Managemen            | t: Managing systems develop       | ment and risks, V     | Vor   | k breakdov    | wn         |  |
| stru                                                                                          | cture (WBS), S                                                                                            | sys  | tem Engineerin         | g Management Plan (SEMP),         | Risk Management       | Or    | ganization    | of         |  |
| Sys                                                                                           | tems Engineeri                                                                                            | ng   | , Systems Eng          | ineering Capability Maturity      | Assessment, Syste     | ems   | Engineerii    | ng         |  |
| stan                                                                                          | dards, Problem                                                                                            | • .  |                        |                                   |                       |       |               |            |  |
| Nee                                                                                           | ds Analysis: O                                                                                            | rıg  | inating a new sy       | stem, Operations analysis, Fun    | ctional analysis, Fe  | asıb  | ility analys  | 51S,       |  |
| Fea                                                                                           | sibility definition                                                                                       | m,   | Needs validatio        | on, System operational requirem   | ients, problems.      |       |               |            |  |
| Cor                                                                                           | icept Explora                                                                                             | tio  | <b>n:</b> Developing   | the system requirements, (        | Operational requir    | eme   | nts analys:   | 51S,       |  |
| Per                                                                                           | formance requir                                                                                           | em   | ents formulation       | on, Implementation concept exp    | oloration, Performa   | nce   | requiremen    | nts        |  |
| valı                                                                                          | dation, problem                                                                                           | IS.  |                        |                                   |                       |       |               |            |  |
| a                                                                                             |                                                                                                           |      | <u> </u>               | Unit – III                        |                       |       | <u> </u>      | lrs        |  |
| Cor                                                                                           | icept Definitio                                                                                           | n:   | Selecting the          | system concept, Performance       | requirements ana      | lysı  | s, Function   | nal        |  |
| ana                                                                                           | lysis and formu                                                                                           | lat: | ion, Concept se        | lection, Concept validation, Sys  | stem Development      | plan  | ining, Syste  | em         |  |
| Fun                                                                                           | ctional Specific                                                                                          | at1  | ons, problems          |                                   |                       |       |               |            |  |
| Adv                                                                                           | vanced Develo                                                                                             | pm   | ient: Reducing         | program risks, Requirements       | analysis, Function    | nal   | Analysis ai   | nd         |  |
| Des                                                                                           | ign, Prototype o                                                                                          | lev  | elopment, Devo         | elopment testing, Risk reduction  | n, problems.          |       |               |            |  |
|                                                                                               |                                                                                                           |      |                        | Unit – IV                         |                       |       | <u> </u>      | lrs        |  |
| Eng                                                                                           | gineering Desi                                                                                            | gn   | Implementing           | the System Building blocks,       | requirements ana      | lysi  | s, Function   | nal        |  |
| analysis and design, Component design, Design validation, Configuration Management, problems. |                                                                                                           |      |                        |                                   |                       |       |               |            |  |
| Inte                                                                                          | egration and E                                                                                            | va   | <b>luation:</b> Integr | ating, Testing and evaluating     | the total system, T   | est . | planning a    | nd         |  |
| prep                                                                                          | preparation, System integration, Developmental system testing, Operational test and evaluation, problems. |      |                        |                                   |                       |       |               |            |  |
| -                                                                                             | ~                                                                                                         |      |                        | Unit – V                          |                       | -     | <u>  06 H</u> | lrs        |  |
| Pro                                                                                           | duction: Syste                                                                                            | em   | s Engineering          | in the factory, Engineering       | tor production,       | Tra   | nsition fro   | )m         |  |
| dev                                                                                           | elopment to pro                                                                                           | du   | ction, Productio       | on operations, Acquiring a prod   | uction knowledge b    | ase   | , problems.   |            |  |
| Op                                                                                            | erations and s                                                                                            | ւթ   | port: Installing       | , maintenance and upgrading t     | he system, Installa   | tion  | and test, I   | ln-        |  |
| serv                                                                                          | nce support, M                                                                                            | lajo | or system upgr         | ades: Modernization, Operation    | nal factors in system | em    | developme     | nt,        |  |
| prol                                                                                          | olems.                                                                                                    |      |                        |                                   |                       |       |               |            |  |

| Course     | Course Outcomes: After completing the course, the students will be able to                  |  |  |  |  |
|------------|---------------------------------------------------------------------------------------------|--|--|--|--|
| CO1        | Understand the Life Cycle of Systems.                                                       |  |  |  |  |
| CO2        | Explain the role of Stake holders and their needs in organizational systems.                |  |  |  |  |
| CO3        | Develop and Document the knowledge base for effective systems engineering processes.        |  |  |  |  |
| <b>CO4</b> | Apply available tools, methods and technologies to support complex high technology systems. |  |  |  |  |
| CO5        | Create the frameworks for quality processes to ensure high reliability of systems.          |  |  |  |  |

## **Reference Books**

| 1 | Systems Engineering – Principles and Practice, Alexander Kossoakoff, William N Sweet, 2012,            |
|---|--------------------------------------------------------------------------------------------------------|
| 1 | John Wiley & Sons, Inc, ISBN: 978-81-265-2453-2                                                        |
| 2 | Systems Engineering and Analysis, Blanchard, B., and Fabrycky W, 5 <sup>th</sup> Edition, 2010, Saddle |
| 4 | River, NJ, USA: Prentice Hall.                                                                         |
| 3 | Handbook of Human Systems Integration, Booher, H. (ed.) 2003. Hoboken, NJ, USA: Wiley.                 |
| 4 | Systems Engineering: A 21 <sup>st</sup> Century Methodology, Hitchins, D., 2007. Chichester, England:  |
| 4 | Wiley.                                                                                                 |

# Continuous Internal Evaluation (CIE); Theory (100 Marks)

**CIE** is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for Assignment/Presentation/Project 10.

Total CIE is 30(Q) +60(T) +10(A) =100 Marks.

## Semester End Evaluation (SEE); Theory (100 Marks)

| . <u></u>                                                                                       |                  |            |                    | Semester: VII                 |                               |       |                   |
|-------------------------------------------------------------------------------------------------|------------------|------------|--------------------|-------------------------------|-------------------------------|-------|-------------------|
|                                                                                                 |                  |            | MEN                | IS AND APPLICAT               | IONS                          |       |                   |
| l                                                                                               |                  |            | (Gi                | roup H: Global Elect          | tive)                         |       |                   |
| Cou                                                                                             | rse Code         | :          | 16G7H08            |                               | CIE                           | :     | 100 Marks         |
| Crec                                                                                            | lits: L:T:P:S    | :          | 3:0:0:0            |                               | SEE                           | :     | 100 Marks         |
| Tota                                                                                            | l Hours          | :          | 35L                |                               | SEE Duration                  | :     | 3.00 Hours        |
| Cou                                                                                             | rse Learning (   | )bje       | ectives: The stude | ents will be able to          |                               |       |                   |
| 1                                                                                               | Understand th    | ne ru      | idiments of Micro  | o fabrication techniqu        | es.                           |       |                   |
| 2                                                                                               | Identify and a   | ISSO       | ciate the various  | sensors and actuators         | to applications.              |       |                   |
| 3                                                                                               | Analyze diffe    | rent       | materials used for | or MEMS.                      |                               |       |                   |
| 4                                                                                               | Design applic    | atic       | ons of MEMS to c   | lisciplines.                  |                               |       |                   |
|                                                                                                 |                  |            |                    |                               |                               |       |                   |
|                                                                                                 |                  |            |                    | Unit - I                      |                               |       | 06 Hrs            |
| Over                                                                                            | rview of MEM     | IS 8       | k Microsystems:    | MEMS and Microsy              | stems, Typical MEM            | S and | d micro system    |
| prod                                                                                            | ucts, Evolution  | of         | micro fabrication  | , Microsystems and n          | nicroelectronics, Mult        | idisc | iplinary nature   |
| of M                                                                                            | licrosystems, L  | Des1       | gn and manufact    | ure, Applications of          | Microsystems in auto          | mot   | ve, healthcare,   |
| aeros                                                                                           | space and other  | ind        | lustries.          | · · · · · · · · · · · ·       | <i>\C</i> '                   |       |                   |
| Wor                                                                                             | King Principle   | 0I .       | Microsystems: E    | siomedical and biosen         | sors. Micro sensors: A        | Acou  | stic, Chemical,   |
| Optio                                                                                           | cal, Pressure, 1 | ner        | nal.               | TI:4 TT                       |                               |       | 00 II             |
| Umt – II 08 Hrs                                                                                 |                  |            |                    |                               |                               |       |                   |
| foreas MEMS with micro actuators. Microgrimors, micrometers, microsoluce and micropumps, micro  |                  |            |                    |                               |                               |       |                   |
| 2000                                                                                            | arometers mic    | rofl       | uidies             | crogrippers, inicromo         | iors, microvarves and         | mer   | opumps, micro     |
| Intr                                                                                            | elonicies, inc   | alin       | a. Scaling in Geo  | metry Scaling in Rigi         | d body dynamics. Sea          | ling  | in Electrostatic  |
| force                                                                                           | s scaling in ele | ectr       | magnetic forces    | and scaling in fluid m        | echanics                      | img   | III Electrostatic |
| 10100                                                                                           | s, seaming in en | cour       | sindghette forees  | Unit – III                    | leenames.                     |       | 08 Hrs            |
| Mat                                                                                             | erials for MEN   | AS :       | and Microsysten    | <b>is:</b> Substrates and waf | fers. Active substrate        | nate  | rials. Silicon as |
| subs                                                                                            | trate material.  | Sil        | icon Compound      | s. Si-Piezo resistors.        | GaAs. Ouartz. Pie             | zoele | ectric Crystals.  |
| Poly                                                                                            | mers and packa   | gin        | g materials. Thre  | e level of Microsysten        | n packaging, Die leve         | pac   | kaging, Device    |
| level                                                                                           | packaging, Sy    | /stei      | m level packagir   | ng. Interfaces in micr        | osystem packaging. I          | Essei | tial packaging    |
| technologies: die preparation, Surface bonding, Wire bonding, Sealing, 3D packaging.            |                  |            |                    |                               |                               |       |                   |
| Unit – IV 06 Hrs                                                                                |                  |            |                    |                               |                               |       |                   |
| Mic                                                                                             | osystem Fabri    | icat       | ion Process: Intr  | oduction to microsyst         | ems, Photolithograph          | y, Io | n Implantation,   |
| Diffusion, Oxidation, CVD, PVD-Sputtering, Deposition of Epiaxy, Etching, LIGA process: General |                  |            |                    |                               |                               |       |                   |
| description, Materials for substrates and photoresists, Electroplating and SLIGA process.       |                  |            |                    |                               |                               |       |                   |
| Unit – V 07 Hrs                                                                                 |                  |            |                    |                               |                               |       |                   |
| Tacti                                                                                           | ile and Flow se  | ensc       | ors – Piezoelectri | c sensors and actuate         | ors – piezoelectric eff       | ects  | - piezoelectric   |
| mate                                                                                            | rials – Applicat | tion       | s to Inertia, Acou | stic, Tactile and Flow        | v sensors.                    |       |                   |
|                                                                                                 | wiow Applico     | 4.         | Fabrication D      | manage in Application         |                               |       |                   |
| Over                                                                                            | view, Applica    | tior       | i, radrication ri  | rocess in Application         | S:                            |       |                   |
| <b>Ove</b><br>Silic                                                                             | on Capacitive A  | dor<br>Acc | elerometer, Piezo  | o resistive Pressure se       | s:<br>ensor, Electrostatic Co | omb   | drive, Portable   |

| Course Outcomes: After completing the course, the students will be able to |                                                                                  |  |  |  |
|----------------------------------------------------------------------------|----------------------------------------------------------------------------------|--|--|--|
| CO1:                                                                       | Understand the operation of micro devices, micro systems and their applications. |  |  |  |
| <b>CO2:</b>                                                                | Apply the principle of material science to sensor design.                        |  |  |  |
| CO3:                                                                       | Analyze the materials used for sensor designs.                                   |  |  |  |
| <b>CO4:</b>                                                                | Conceptualize and design micro devices, micro systems.                           |  |  |  |

| Refere | ence Books                                                                                   |
|--------|----------------------------------------------------------------------------------------------|
| 1      | MEMS & Microsystems Design and Manufacture, Tai-Ran Hsu, 2 <sup>nd</sup> Edition, 2002, Tata |
|        | McGraw Hill Education, New Delhi, ISBN-13:978-0-07-048709-3.                                 |
| 2      | Foundations of MEMS, Chang Liu, 2012, Pearson Education Inc., ISBN-13:978-0-13-249736-       |
|        | 7.                                                                                           |
| 2      | Smart Material Systems and MEMS, Vijay K Varadan, K. J. Vinoy, S. Gopalakrishnan, 2006,      |
| 3      | Wiley-INDIA, ISBN-978-81-265-3170-7.                                                         |
| 4      | Micro and Smart Systems, G.K. Ananthasuresh, K.J. Vinoy, K.N. Bhat, V.K. Aatre, 2015, Wiley  |
|        | Publications, ISBN-:978-81-265-2715-1.                                                       |

**CIE** is executed by way of quizzes (Q), tests (T) and Self-Study(S). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for assignment is 10. The marks component for Assignment is 10. Total CIE is 30(Q) + 60(T) + 10(A) = 100.

## Semester End Evaluation (SEE); Theory (100 Marks)

|                  | Semester: VII                                                               |   |             |                       |            |            |
|------------------|-----------------------------------------------------------------------------|---|-------------|-----------------------|------------|------------|
|                  |                                                                             |   | INTRODUCTIO | N TO INTERNET OF TH   | INGS       |            |
|                  |                                                                             |   | (Grou       | o H: Global Elective) |            |            |
| Cou              | rse Code                                                                    | : | 16G7H09     | CIE                   | :          | 100 Marks  |
| Credits: L:T:P:S |                                                                             | : | 3:0:0:0     | SEE                   | :          | 100 Marks  |
| Total Hours      |                                                                             | : | 39L         | SEE I                 | Duration : | 3.00 Hours |
| Cou              | Course Learning Objectives: The students will be able to                    |   |             |                       |            |            |
| 1                | 1 Learn the fundamentals of IoT                                             |   |             |                       |            |            |
| 2                | 2 Understands the hardware, networks & protocols used in IoT development    |   |             |                       |            |            |
| 3                | 3 Illustrate smart applications using IoT devices and building applications |   |             |                       |            |            |
| 4                | 4 Know more advanced concepts like cloud connectivity in IoT                |   |             |                       |            |            |
| 5                | Learn the fundamentals of IoT                                               |   |             |                       |            |            |

| Unit-I                                                                                                    | 06 Hrs    |  |  |  |
|-----------------------------------------------------------------------------------------------------------|-----------|--|--|--|
| <b>Fundamentals Of IOT:</b> Introduction, Physical design of IoT, Logical design of IoT, IoT              |           |  |  |  |
| technologies, IoT Levels and Deployment Templates, , IoTvs M2M                                            |           |  |  |  |
| Unit – II                                                                                                 | 06 Hrs    |  |  |  |
| <b>IOT Design Methodology:</b> Need for IoT systems management, IoT Design Methodology                    |           |  |  |  |
| Internet of Things Strategic Research and Innovation Agenda: Internet of Things Vi                        | sion, IoT |  |  |  |
| Strategic Research and Innovation Directions, IoT Smart-X Applications, Internet of Th                    | nings and |  |  |  |
| Related Future Internet Technologies.                                                                     |           |  |  |  |
| Unit –III                                                                                                 | 11 Hrs    |  |  |  |
| <b>IOT Systems</b> - Logical Design using Python: Provides an introduction to Python, installing Python,  |           |  |  |  |
| Python data types & data structures, control flow, functions, modules, packages, file input/output,       |           |  |  |  |
| data/time operations and classes.                                                                         |           |  |  |  |
| Unit –IV                                                                                                  | 09 Hrs    |  |  |  |
| IOT Physical Devices & Endpoints: What is an IoT device, Raspberry Pi device, About t                     | he board, |  |  |  |
| Linux on Raspberry Pi, Raspberry Pi interfaces, Programming Raspberry Pi with Python.                     |           |  |  |  |
| Unit –V                                                                                                   | 07 Hrs    |  |  |  |
| <b>IOT Physical Servers &amp; Cloud Offerings:</b> Provides an introduction to the use of cloud platforms |           |  |  |  |
| and frameworks such as Xively and AWS for developing IoT applications.                                    |           |  |  |  |
|                                                                                                           |           |  |  |  |
| Course Outcomes: After completing the course, the students will be able to                                |           |  |  |  |
| CO1: Understand the fundamentals of IoT.                                                                  |           |  |  |  |

| <b>CO2:</b> | Analyse the IoT devices, programming, networking requirements and protocols for |
|-------------|---------------------------------------------------------------------------------|
|             | building IoT products.                                                          |
| CO3:        | Apply the concepts to design and develop IoT applications                       |

**CO4:** Creating applications of IoT using physical devices and interfacing with cloud.

# **Reference Books**

| nerere | Acc Books                                                                                                                                                                                                                                                                            |
|--------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1      | Internet of Things (A Hands-on-Approach), Vijay Madisetti and ArshdeepBahga, 1 <sup>st</sup> Edition, VPT, 2014, ISBN-13: 978-0996025515.                                                                                                                                            |
| 2      | Internet of Things – From Research and Innovation to Market Deployment,<br>OvidiuVermesan, Peter Friess, River Publishers Series in Communication, River Publishers,<br>2014, ISBN: ISBN: 978-87-93102-94-1 (Hard copy), 978-87-93102-95-8 (Ebook) (UnitsII<br>2 <sup>nd</sup> part) |
| 3      | Rethinking the Internet of Things: A Scalable Approach to Connecting Everything, Francis daCosta, , 1 <sup>st</sup> Edition, Apress Publications, 2013, ISBN-13: 978-1430257400.                                                                                                     |
| 4      | Meta products - Building the Internet of Things, WimerHazenberg, Menno Huisman, BIS Publishers, 2012, ISBN: 9789863692515.                                                                                                                                                           |

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## Semester End Evaluation (SEE); Theory (100 Marks)

|                                                                                               |          |                         | Semester: VII          |                       |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
|-----------------------------------------------------------------------------------------------|----------|-------------------------|------------------------|-----------------------|----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| INDU                                                                                          | ST       | RY 4.0- SMART N         | ANUFACTURIN            | G FOR THE FUT         | URF      | C                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|                                                                                               |          | (Grou                   | o H: Global Electiv    | e)                    |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| Course Code                                                                                   | :        | 16G7H10                 |                        | CIE                   | :        | 100 Marks                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| Credits: L:T:P:S                                                                              | :        | 3:0:0:0                 |                        | SEE                   | :        | 100 Marks                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| Total Hours                                                                                   | :        | 39L                     |                        | SEE Duration          | :        | 3.00 Hours                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| Course Learning                                                                               | Obi      | ectives: The studen     | ts will be able to     | 522 2 41 40 00        |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| 1 Understand t                                                                                | he ir    | mportance and role      | of Smart Manufactu     | ring Systems IoT a    | nd I     | ЮТ                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| 2 Explain impo                                                                                | ortar    | nce of automation te    | chnologies, sensors.   | Robotics and Macl     | nine     | vision.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| 3 Understand a                                                                                | nnli     | ication of artificial i | ntelligence and the n  | eed for data transfor | mat      | ion handling                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| storing and se                                                                                | ecur     | ity.                    | interingenee and the h |                       | mat      | , indiana, india |
| 4 Understand s                                                                                | imu      | lation, predictive a    | nd knowledge model     | ing along with anal   | vsis     |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| 5 Learn networ                                                                                | king     | g sustainable techn     | ology and factory ne   | etworks               | <u> </u> |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
|                                                                                               |          | 5, sustainuore teenin   | ology and factory in   |                       |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
|                                                                                               |          | Ī                       | Init-I                 |                       |          | 06 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| Smart Manufactu                                                                               | ring     | and Industry 4.0        |                        |                       |          | 00 1115                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| Need for Smart N                                                                              | Man      | ufacturing Advan        | tages Emerging te      | chnologies in Sma     | nt m     | anufacturing                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| CAD Architecture                                                                              | surr     | ounding 3D Model        | (B-rep and CSG)        | MEMS Industry 4 (     | )_Int    | eroperability                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| Information transr                                                                            | oare     | ncy. Technical as       | sistance. Decentral    | lized decision-mak    | ing.     | Internet of                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| Things(IoT). Indust                                                                           | trv I    | Internet of Things (    | IoT). Future of Mar    | ufacturing industrie  | es.      |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| 8-(,,                                                                                         | <u> </u> | <u>U</u> I              | nit – II               | 8                     | -        | 09 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| Manufacturing Au                                                                              | utor     | nation                  |                        |                       |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| Technology intensi                                                                            | ve n     | nanufacturing and c     | vber-physical syste    | ms. Automation usi    | ng R     | Robotics. Data                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| storage, retrieval,                                                                           | man      | ipulation and pres      | entation: Mechanisn    | ns for sensing sta    | te a     | nd modifying                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| processes Material handling systems controlling material movement and machine flow            |          |                         |                        |                       |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| Mechatronics. Transducers and sensors. Proximity sensors. Biosensors. Acceleration Machine    |          |                         |                        |                       |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| Vision-Flaw detect                                                                            | tion     | , Positioning, Ident    | ification, Verificatio | on and Measureme      | nt–A     | Application of                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| Machine Vision in                                                                             | indu     | ustries                 | ,                      |                       |          | 11                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|                                                                                               |          | Uı                      | nit –III               |                       |          | 09 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| Data handling using                                                                           | ng F     | Embedded System         | 5                      |                       |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| Data transformation–Mathematical functions, Regression, Need for different functions, Data    |          |                         |                        |                       |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| merging-Discrete and Random variables. Transformation languages. Interfacing systems-         |          |                         |                        |                       |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| Microprocessors, I                                                                            | Dire     | ct memory access        | , Data transfer sch    | emes and systems      | , Co     | ommunication                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| systems-Modulatio                                                                             | on,      | Time domain             | and frequency de       | omain, Industrial     | Ne       | etwork Data                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| Communications, I                                                                             | Data     | Security Artificial     | Intelligence – Intel   | ligent systems, Fuz   | zy lo    | ogics, Neural                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| networks – Supervised, Unsupervised and Reinforced learning                                   |          |                         |                        |                       |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| Unit –IV 06 Hrs                                                                               |          |                         |                        |                       |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| Simulation, Model                                                                             | ling     | and Analysis            |                        |                       |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| Simulation - system                                                                           | n en     | tities, input variable  | es, performance mea    | sures, and Function   | al re    | lationships,                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| types of simulation. Predictive modeling and simulation tools. Knowledge Modeling –types and  |          |                         |                        |                       |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| technology options, Functional analysis of control systems – Linear and Non-linear,           |          |                         |                        |                       |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| Functional decomposition, Functional sequencing, Information / dataflow, Interface            |          |                         |                        |                       |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| Unit –V 09 Hrs                                                                                |          |                         |                        |                       |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| Performance Measures of Smart Manufacturing Systems- Smart manufacturing- Sensing and         |          |                         |                        |                       |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| Perception, Manipulation, Mobility and Autonomy, Factory Networks, Information Modeling and   |          |                         |                        | Modeling and          |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| Testing, Performance Measurement and Optimization, Engineering System integration, Production |          |                         |                        |                       |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| Network integration, Production network data quality, Sustainable Processes and Resources,    |          |                         |                        |                       |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| Integration Infrastructure for Sustainable Manufacturing                                      |          |                         |                        |                       |          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |

| Course      | Course Outcomes: After completing the course, the students will be able to                       |  |  |  |  |  |
|-------------|--------------------------------------------------------------------------------------------------|--|--|--|--|--|
| CO1:        | Explain role and importance of Smart Manufacturing Systems, IoT and IIoT                         |  |  |  |  |  |
| <b>CO2:</b> | Explain importance of automation technologies, sensors, robotics and machine vision              |  |  |  |  |  |
| CO3:        | Illustrate the application of artificial intelligence and need for data transformation, handling |  |  |  |  |  |
| CO4:        | Explain analytical and simulation for performance study of smart technologies and                |  |  |  |  |  |
|             | networks                                                                                         |  |  |  |  |  |

| Refere | Reference Books                                                                                    |  |  |  |  |
|--------|----------------------------------------------------------------------------------------------------|--|--|--|--|
|        | Smart Manufacturing Innovation and Transformation: Interconnection And Intelligence                |  |  |  |  |
| 1      | Zongwei Luo, 1 <sup>st</sup> Edition, IGI Global Publications, 2014, ISBN-13: 978-1466658363 ISBN- |  |  |  |  |
|        | 10: 1466658363                                                                                     |  |  |  |  |
| 2      | Simon Frechette, Yan Lu. KC Morris, Smart Manufacturing Standards, NIST, 1st Edition,              |  |  |  |  |
| 2      | 2016, Project report.                                                                              |  |  |  |  |

**CIE** is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for Assignment/Presentation/Project 10. **Total CIE is 30(Q) + 60(T) + 10(A) = 100 Marks**.

# Semester End Evaluation (SEE); Theory (100 Marks)

| Semester: VII                                                                                                                                                                                                                                                                                                                                                                   |                                                                                                                 |                                                                               |                                                                                       |                                             |             |                                   |  |  |  |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|---------------------------------------------|-------------|-----------------------------------|--|--|--|
| SPACE TECHNOLOGY AND APPLICATIONS                                                                                                                                                                                                                                                                                                                                               |                                                                                                                 |                                                                               |                                                                                       |                                             |             |                                   |  |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                 |                                                                                                                 | ((                                                                            | Froup H: Global Elective)                                                             | CIE                                         | -           | 100 1 1                           |  |  |  |
| Course Code                                                                                                                                                                                                                                                                                                                                                                     | :                                                                                                               | 16G/HII                                                                       |                                                                                       |                                             | :           | 100 Marks                         |  |  |  |
| Credits: L:T:P:S                                                                                                                                                                                                                                                                                                                                                                | :                                                                                                               | 3:0:0:0                                                                       |                                                                                       | SEE //                                      | :           | 100 Marks                         |  |  |  |
| Hrs/Week                                                                                                                                                                                                                                                                                                                                                                        |                                                                                                                 | 35L                                                                           |                                                                                       | SEE Duration                                | :           | 3.00 Hours                        |  |  |  |
| Course Learning Objectives: The students will be able to                                                                                                                                                                                                                                                                                                                        |                                                                                                                 |                                                                               |                                                                                       |                                             |             |                                   |  |  |  |
| Define the earth concepts.                                                                                                                                                                                                                                                                                                                                                      | 1 Define the earth environment and its behavior, launching vehicles for satellites and its associated concepts. |                                                                               |                                                                                       |                                             |             |                                   |  |  |  |
| 2 Analyze satellite                                                                                                                                                                                                                                                                                                                                                             | es in                                                                                                           | terms of technologies                                                         | ology, structure and commu                                                            | inications.                                 |             |                                   |  |  |  |
| <b>3</b> Use satellites for                                                                                                                                                                                                                                                                                                                                                     | r spa                                                                                                           | ace applications                                                              | , remote sensing and metro                                                            | logy.                                       |             |                                   |  |  |  |
| <b>4</b> Apply the space                                                                                                                                                                                                                                                                                                                                                        | tech                                                                                                            | nnology, techno                                                               | logy mission and advanced                                                             | space systems to n                          | atic        | on's growth.                      |  |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                 |                                                                                                                 |                                                                               |                                                                                       |                                             |             |                                   |  |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                 |                                                                                                                 |                                                                               | UNIT-I                                                                                |                                             |             | 07 Hrs                            |  |  |  |
| Earth's environr                                                                                                                                                                                                                                                                                                                                                                | nen                                                                                                             | t: Atmosphere                                                                 | , ionosphere, Magnetosp                                                               | ohere, Van Allen                            | Ra          | diation belts,                    |  |  |  |
| Interplanetary med                                                                                                                                                                                                                                                                                                                                                              | ium                                                                                                             | , Solar wind, So                                                              | olar- Earth Weather Relatio                                                           | ns.                                         |             |                                   |  |  |  |
| Launch Vehicles:                                                                                                                                                                                                                                                                                                                                                                | Ro                                                                                                              | ocketry, Propell                                                              | ants, Propulsion, Combus                                                              | stion, Solid, Liquid                        | l ar        | nd Cryogenic                      |  |  |  |
| engines, Control ar                                                                                                                                                                                                                                                                                                                                                             | nd G                                                                                                            | uidance system                                                                | , Ion propulsion and Nucle                                                            | ar Propulsion.                              |             |                                   |  |  |  |
| UNIT-II 07 Hrs                                                                                                                                                                                                                                                                                                                                                                  |                                                                                                                 |                                                                               |                                                                                       |                                             |             |                                   |  |  |  |
| <b>Satellite Technol</b><br>and Quality and Re                                                                                                                                                                                                                                                                                                                                  | <b>ogy</b><br>eliab                                                                                             | : Structural, lility, Payloads,                                               | Mechanical, Thermal, Po<br>Space simulation.                                          | ower control, Teler                         | neti        | ry, Telecomm                      |  |  |  |
| Satellite structure                                                                                                                                                                                                                                                                                                                                                             | : Sa                                                                                                            | tellite Commun                                                                | ications, Transponders, Sat                                                           | tellite antennas.                           |             | I                                 |  |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                 |                                                                                                                 |                                                                               | UNIT-III                                                                              |                                             |             | 07 Hrs                            |  |  |  |
| Satellite Commun                                                                                                                                                                                                                                                                                                                                                                | icat                                                                                                            | ions: LEO, MI                                                                 | EO and GEO orbits, Altitud                                                            | e and orbit controls,                       | , Mı        | ultiple Access                    |  |  |  |
| Techniques.                                                                                                                                                                                                                                                                                                                                                                     | _                                                                                                               |                                                                               |                                                                                       |                                             |             |                                   |  |  |  |
| Space application<br>medicine, Satellite                                                                                                                                                                                                                                                                                                                                        | s: T<br>nav                                                                                                     | elephony, V-SA igation, GPS.                                                  | AT, DBS system, Satellite F                                                           | Radio and TV, Tele-                         | Ed          | ucation, Tele-                    |  |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                 |                                                                                                                 |                                                                               | UNIT-IV                                                                               |                                             |             | 07 Hrs                            |  |  |  |
| <b>Remote Sensing:</b> Visual bands, Agricultural, Crop vegetation, Forestry, water Resources, Land use, Land mapping, geology, Urban development resource Management, and image processing techniques. <b>Metrology:</b> Weather forecast (Long term and Short term), weather modelling, Cyclone predictions, Disaster and flood warning rainfall predictions using satellites |                                                                                                                 |                                                                               |                                                                                       |                                             |             |                                   |  |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                 |                                                                                                                 |                                                                               | UNIT-V                                                                                |                                             |             | 07Hrs                             |  |  |  |
| Satellite payloads<br>experiments, space<br>Advanced space s<br>Inter-space commu                                                                                                                                                                                                                                                                                               | : Teo<br>bio<br>yste<br>nica                                                                                    | chnology missic<br>logy and Interna<br><b>ms:</b> Remote se<br>ttion systems. | ons, deep space planetary m<br>ational space Missions.<br>nsing cameras, planetary pa | issions, Lunar miss<br>ayloads, space shutt | ions<br>le, | s, zero gravity<br>space station, |  |  |  |

| Course Outcomes: After completing the course, the students will be able to |                                                                                                     |  |  |  |  |  |  |  |  |
|----------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------|--|--|--|--|--|--|--|--|
| CO1                                                                        | Explain different types of satellites, orbit and associated subsystems.                             |  |  |  |  |  |  |  |  |
| CO2                                                                        | Apply the basics of launching vehicles, satellites and sub systems for space applications.          |  |  |  |  |  |  |  |  |
| CO3                                                                        | Analyze the applications of satellite in the area of communication, remote sensing, metrology etc., |  |  |  |  |  |  |  |  |
| CO4                                                                        | Study technology trends, satellite missions and advanced space systems.                             |  |  |  |  |  |  |  |  |

| Refe | rence Books                                                                           |
|------|---------------------------------------------------------------------------------------|
| 1    | Atmosphere, weather and climate, R G Barry, Routledge publications, 2009, ISBN- 10    |
|      | :0415465702.                                                                          |
| 2    | Fundamentals of Satellite Communication, K N Raja Rao, PHI, 2012, ISBN:9788120324015. |
| 3    | Satellite Communication, Timothy pratt, John Wiley, 1986 ISBN: 978-0- 471- 37007 -9,  |
|      | ISBN 10: 047137007X.                                                                  |
| 4    | Remote sensing and applications, B C Panda, VIVA books Pvt. Ltd., 2009,               |
|      | ISBN: 108176496308.                                                                   |

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Total CIE is 30(Q) +60(T) +10(A) =100 Marks.

# Semester End Evaluation (SEE); Theory (100 Marks)

| Semester: VII                                                            |                                                                                             |                             |                         |                            |                        |              |                 |  |  |  |  |
|--------------------------------------------------------------------------|---------------------------------------------------------------------------------------------|-----------------------------|-------------------------|----------------------------|------------------------|--------------|-----------------|--|--|--|--|
| ADVANCED LINEAR ALGEBRA                                                  |                                                                                             |                             |                         |                            |                        |              |                 |  |  |  |  |
| Com                                                                      | rsa Cada                                                                                    |                             | (Grou                   | p H: Global Electiv        | ve)                    |              | 100 Morke       |  |  |  |  |
| Cred                                                                     | lits: L:T:P:S                                                                               | •                           | 3.0.0.0                 |                            | SEE                    | •            | 100 Marks       |  |  |  |  |
| Tota                                                                     | l Hours                                                                                     | :                           | 39L                     |                            | SEE Duration           | :            | 3.00 Hours      |  |  |  |  |
| Cour                                                                     | rse Learning                                                                                | Obi                         | ectives: The studer     | ts will be able to         | 02222000000            | •            |                 |  |  |  |  |
| 1                                                                        | 1 Adequate exposure to learn the fundamental concepts to model a system of linear equations |                             |                         |                            |                        |              |                 |  |  |  |  |
|                                                                          | and to obtain                                                                               | the                         | solution of system      | of linear equations.       |                        |              | -               |  |  |  |  |
| 2                                                                        | Analyze and                                                                                 | exte                        | end the structure of    | vector spaces, linear      | transformations, Syr   | nme          | etric matrices, |  |  |  |  |
|                                                                          | quadratic forms required in applications of Business, Science and Engineering.              |                             |                         |                            |                        |              |                 |  |  |  |  |
| 3                                                                        | Apply the co                                                                                | once                        | ept of Eigenvalues      | to study differentia       | al equations and dyn   | nam          | ical systems.   |  |  |  |  |
|                                                                          | Apply the co                                                                                | nce                         | pt of Orthogonality     | to examine some of         | the least-squares pro  | ble          | ms.             |  |  |  |  |
| 4                                                                        | Apply Linear                                                                                | r Pr                        | ogramming to Netv       | ork problems and G         | ame theory.            |              |                 |  |  |  |  |
|                                                                          |                                                                                             |                             |                         |                            |                        |              |                 |  |  |  |  |
|                                                                          |                                                                                             |                             | I                       | Unit-I                     |                        |              | 07 Hrs          |  |  |  |  |
| Syste                                                                    | em of linear e                                                                              | qua                         | tions                   | ~                          |                        |              |                 |  |  |  |  |
| Matr                                                                     | ices and syste                                                                              | m o                         | f linear equations,     | Geometry of linear e       | equations, Linear mo   | dels         | in Business,    |  |  |  |  |
| Scier                                                                    | ice and Engli                                                                               | neer                        | ing-Input-Output n      | nodel in Economics         | s, Balancing chemic    | al e         | quations and    |  |  |  |  |
| Elect                                                                    | incar networks                                                                              |                             | T                       | nit _ II                   |                        |              | 09 Hrs          |  |  |  |  |
| Vect                                                                     | or snaces and                                                                               | lin                         | ear transformatio       | ng — 11                    |                        |              | 07 1113         |  |  |  |  |
| Revi                                                                     | sion of Vector                                                                              | Spa                         | ces. Subspaces. Li      | near independence. E       | Basis. Dimension and   | Ch           | ange of basis.  |  |  |  |  |
| Appl                                                                     | ications to Di                                                                              | iffer                       | ence equations, M       | arkov chains. Inters       | section, Sum, Produ    | ct o         | f spaces and    |  |  |  |  |
| Tens                                                                     | or product o                                                                                | f t                         | wo vector spaces.       | Introduction to I          | Linear transformatio   | ns,          | Geometrical     |  |  |  |  |
| inter                                                                    | pretations in 2                                                                             | -din                        | nensions and 3-dim      | ensions.                   |                        |              |                 |  |  |  |  |
|                                                                          |                                                                                             |                             | U                       | nit –III                   |                        |              | <b>09 Hrs</b>   |  |  |  |  |
| Orth                                                                     | ogonality, Ei                                                                               | gen                         | values and Eigen        | vectors                    |                        |              |                 |  |  |  |  |
| Ortho                                                                    | ogonality, Inne                                                                             | er pi                       | roduct spaces, Appl     | ications to Weighted       | l least-squares and Fo | ourie        | er series, Fast |  |  |  |  |
| Four                                                                     | ier transform.                                                                              | Eig                         | en values and Eige      | n vectors, Applicatio      | ons to Differential eq | uati         | ons, Discrete   |  |  |  |  |
| dyna                                                                     | mical systems                                                                               | •                           | TT                      | n:t IV                     |                        |              | 07 II.ma        |  |  |  |  |
| Sym                                                                      | metric matric                                                                               | 000 0                       | U<br>and auadratic form | nr –1 v                    |                        |              | 07 HIS          |  |  |  |  |
| Intro                                                                    | duction to svi                                                                              | . <b>cs</b> <i>c</i><br>mma | etric matrices Oua      | us<br>dratic forms. Test f | or Positive definiter  | Iess         | Constrained     |  |  |  |  |
| Optin                                                                    | nization. Sing                                                                              | ular                        | Value Decomposit        | ion. Applications to       | image processing.      | 1000,        | Constrained     |  |  |  |  |
| - <b>I</b> ·                                                             |                                                                                             |                             | Ŭ                       | nit –V                     | 61 8                   |              | 07 Hrs          |  |  |  |  |
| Line                                                                     | ar programm                                                                                 | ing                         | and game theory         |                            |                        |              |                 |  |  |  |  |
| A Ge                                                                     | eometrical intr                                                                             | odu                         | ction to Linear pro     | gramming, Simplex          | method and its geon    | netri        | ical meaning,   |  |  |  |  |
| Network models-Max flow-min cut theorem, Payoff matrix and Matrix games. |                                                                                             |                             |                         |                            |                        |              |                 |  |  |  |  |
| r                                                                        |                                                                                             |                             |                         |                            |                        |              |                 |  |  |  |  |
| Cour                                                                     | rse Outcomes                                                                                | : Af                        | fter completing the     | e course, the studen       | ts will be able to     |              |                 |  |  |  |  |
| CO1                                                                      | : Identify an                                                                               | d in                        | terpret the fundame     | ental concepts of line     | ear equations, vector  | space        | ces, linear     |  |  |  |  |
|                                                                          | transforma                                                                                  | tion                        | is, Orthogonality, E    | igen values, symmet        | tric matrices, quadrat | ic fo        | orms, linear    |  |  |  |  |
| CO                                                                       | • Apply the                                                                                 | ing<br>kno                  | and game theory.        | f Linear algebra to a      | olve lineer equations  | 4:4          | forman          |  |  |  |  |
|                                                                          | differential                                                                                | l eqi                       | uations, constrained    | l optimization proble      | ems, linear programm   | , un<br>ning | problems        |  |  |  |  |

| Refere | ence Books                                                                                             |
|--------|--------------------------------------------------------------------------------------------------------|
| 1      | Linear Algebra and Its Applications, David C Lay, Pearson Education; III Edition; 2003;                |
|        | ISBN: 978-81-775-8333-5.                                                                               |
| 2      | Linear Algebra with Applications, Gareth Williams; 6 <sup>th</sup> edition; 2008; Narosa publications; |
|        | ISBN: 978-81-7319-981-3.                                                                               |
| 3      | Linear Algebra and Its Applications; Gilbert Strang; IV Edition; Cengage Learning India                |
|        | Edition; 2006; ISBN: 81-315-0172-8.                                                                    |
| 4      | Elementary Linear Algebra Applications, Version Howard Anton and Chris Rorres; Wiley                   |
|        | Global Education; 11 <sup>th</sup> Edition; 2013; ISBN: 9781118879160.                                 |

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# Total CIE is 30(Q) +60(T) +10(A) =100 Marks.

# Semester End Evaluation (SEE); Theory (100 Marks)

**SEE** for 100 marks is executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

| CO-PO Mapping |            |     |     |            |     |            |            |            |            |      |      |      |
|---------------|------------|-----|-----|------------|-----|------------|------------|------------|------------|------|------|------|
| CO/PO         | <b>PO1</b> | PO2 | PO3 | <b>PO4</b> | PO5 | <b>PO6</b> | <b>PO7</b> | <b>PO8</b> | <b>PO9</b> | PO10 | PO11 | PO12 |
| CO1           | 3          | 2   | -   | 1          | -   | -          | -          | -          | -          | -    | -    | 2    |
| CO2           | 3          | 2   | 1   | -          | -   | -          | -          | -          | -          | -    | -    | 2    |
| CO3           | 2          | 3   | 2   | 2          | -   | -          | -          | -          | -          | -    | -    | 1    |
| CO4           | 3          | 3   | 1   | 2          | 1   | -          | -          | -          | -          | -    | -    | 3    |

High-3: Medium-2 : Low-1

|                            | Semester: VII                    |      |                       |                  |                      |      |            |  |  |  |  |
|----------------------------|----------------------------------|------|-----------------------|------------------|----------------------|------|------------|--|--|--|--|
| THIN FILM NANOTECHNOLOGY   |                                  |      |                       |                  |                      |      |            |  |  |  |  |
| (Group H: Global Elective) |                                  |      |                       |                  |                      |      |            |  |  |  |  |
| Cou                        | Course Code:16G7H13CIE:100 Marks |      |                       |                  |                      |      |            |  |  |  |  |
| Credits: L:T:P:S           |                                  | :    | 3:0:0:0               | SEE              |                      | :    | 100 Marks  |  |  |  |  |
| Total Hours                |                                  |      | 39L                   | SEE Duration     |                      | :    | 3.00 Hours |  |  |  |  |
| Cou                        | rse Learning (                   | )bj  | ectives: The student  | ts will be able  | to                   |      |            |  |  |  |  |
| 1                          | Understand th                    | ne i | mportance of vacuu    | m in thin film : | fabrication          |      |            |  |  |  |  |
| 2                          | Acquire the k                    | nov  | vledge of thin film p | preparation by   | various techniques   |      |            |  |  |  |  |
| 3                          | Analyze the p                    | orop | perties of thin films | using different  | characterization met | hods | S          |  |  |  |  |
| 4                          | Optimize the                     | pro  | cess parameter and    | property deper   | Idence               |      |            |  |  |  |  |
| 5                          | Apply the know                   | owl  | edge for developing   | g thin film devi | ces.                 |      |            |  |  |  |  |

| Unit-I                                                                            |           |  |  |  |  |  |  |  |  |
|-----------------------------------------------------------------------------------|-----------|--|--|--|--|--|--|--|--|
| Vacuum Technology: Basics of Vacuum - Principles of different vacuum pumps: Rotar | y, Roots, |  |  |  |  |  |  |  |  |
| Diffusion, Turbo molecular and Cryogenic pumps; Measurement of vacuum - Co        | ncept of  |  |  |  |  |  |  |  |  |
| Capacitance Manometer, Pirani and Penning gauges - Vacuum Systems & Applications. |           |  |  |  |  |  |  |  |  |

Unit – II

#### Methods of thin film preparation

Physical Vapor Deposition (PVD) Techniques:

*Evaporation*: Thermal evaporation, Electron beam evaporation, Laser ablation, and Cathode arc deposition. *Sputtering*: DC sputtering, RF Sputtering, Magnetron sputtering, Reactive Sputtering, and Ion beam sputtering.

Chemical Vapor Deposition (CVD) Techniques: Conventional CVD, Plasma Enhance CVD (PECVD) and Atomic layer deposition (ALD).

Other Methods: Spin coating and Spray Pyrolysis.

| Unit –III                                                                                                              | 07 Hrs  |  |  |  |  |  |  |  |
|------------------------------------------------------------------------------------------------------------------------|---------|--|--|--|--|--|--|--|
| Surface Modification and Growth of Thin Films:                                                                         |         |  |  |  |  |  |  |  |
| Surface preparation & Engineering for Thin film growth: Cleaning, Modification, Masking &                              |         |  |  |  |  |  |  |  |
| Patterning, Base Coats and Top Coats.                                                                                  | C       |  |  |  |  |  |  |  |
| Thin Film growth: Sequence of thin film growth, Defects and impurities, Effect of Deposition                           |         |  |  |  |  |  |  |  |
| Parameters on film growth.                                                                                             | -       |  |  |  |  |  |  |  |
| Unit –IV                                                                                                               | 08 Hrs  |  |  |  |  |  |  |  |
| Properties and Characterization of Thin Films                                                                          |         |  |  |  |  |  |  |  |
| Film thickness (Quartz crystal thickness monitor and Stylus Profiler);                                                 |         |  |  |  |  |  |  |  |
| Film Adhesion (Tape, Cross-hatch test, and Humidity methods);                                                          |         |  |  |  |  |  |  |  |
| Surface morphology and topography (SEM and AFM);                                                                       |         |  |  |  |  |  |  |  |
| Film composition (X-ray Photoelectron Spectroscopy);                                                                   |         |  |  |  |  |  |  |  |
| Film structure (X-ray diffraction and Raman studies);                                                                  |         |  |  |  |  |  |  |  |
| Electrical characterization (Four Probe and Semiconductor Analyzer); and                                               |         |  |  |  |  |  |  |  |
| Optical characterization (Spectrophotometer).                                                                          |         |  |  |  |  |  |  |  |
| Unit –V                                                                                                                | 08 Hrs  |  |  |  |  |  |  |  |
| Thin Film Applications:                                                                                                |         |  |  |  |  |  |  |  |
| <ul> <li>Electrodes: Deposition of a Metal film, Ex: Aluminum.</li> </ul>                                              |         |  |  |  |  |  |  |  |
| <ul> <li>Transparent conducting oxides (TCO) – Preparation and Optimization of a semicor</li> </ul>                    | ducting |  |  |  |  |  |  |  |
| film, Ex: ZnO.                                                                                                         |         |  |  |  |  |  |  |  |
| <ul> <li>Optimization of a dielectric film, Ex: Al<sub>2</sub>O<sub>3</sub> or Si<sub>3</sub>N<sub>4</sub>.</li> </ul> |         |  |  |  |  |  |  |  |
| Thin Film Devices:                                                                                                     |         |  |  |  |  |  |  |  |
| • Thin Film Transistors (TFT),                                                                                         |         |  |  |  |  |  |  |  |
| Thin Film Sensors                                                                                                      |         |  |  |  |  |  |  |  |
| Thin Film Capacitors                                                                                                   |         |  |  |  |  |  |  |  |

• Thin film Solar Cells,

08 Hrs

- Thin film Solar Absorbers
- Diamond-like carbon (DLC) coating
- EMI Shielding coatings
- Hard coatings
- Coatings on Plastics/Polymers.

| Cours | Course Outcomes: After completing the course, the students will be able to |  |  |  |  |  |  |  |  |
|-------|----------------------------------------------------------------------------|--|--|--|--|--|--|--|--|
| CO1   | Understand the importance of vacuum technology for thin film growth        |  |  |  |  |  |  |  |  |
| CO2   | Prepare various kinds of thin films using different deposition techniques  |  |  |  |  |  |  |  |  |
| CO3   | Characterize the deposited films for various properties                    |  |  |  |  |  |  |  |  |
| CO4   | Fabricate thin film based devices.                                         |  |  |  |  |  |  |  |  |

# **Reference Books**

|    | A Chee Boons                                                                                         |
|----|------------------------------------------------------------------------------------------------------|
| 1. | Vacuum Technology by A. Roth, Elsevier, 3rd Edition, 1976, ISBN: 9780444880109,                      |
|    | 9780444598745,                                                                                       |
| 2. | Thin Film Phenomenon by K.L. Chopra, McGraw-Hill, 1 <sup>st</sup> Edition, 1969, ISBN: 0070107998,   |
|    | 978-0070107991                                                                                       |
| 3. | Materials Science of Thin Films by Milton Ohring, Elsevier, 2 <sup>rd</sup> Edition, 2001, ISBN:     |
|    | 9780125249751                                                                                        |
| 4. | Thin-Film Deposition: Principles and Practice by Donald Smith, McGraw-Hill, 1 <sup>st</sup> Edition, |
|    | 1995, ISBN: 0070585024, 9780070585027                                                                |

# Continuous Internal Evaluation (CIE); Theory (100 Marks)

**CIE** is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 60 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for Assignment/Presentation/Project 10. **Total CIE is 30(Q) + 60(T) + 10(A) = 100 Marks**.

# Semester End Evaluation (SEE); Theory (100 Marks)

**SEE** for 100 marks is executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

| CO-PO Mapping |     |     |     |     |     |     |            |     |     |      |      |          |
|---------------|-----|-----|-----|-----|-----|-----|------------|-----|-----|------|------|----------|
| CO/PO         | PO1 | PO2 | PO3 | PO4 | PO5 | PO6 | <b>PO7</b> | PO8 | PO9 | PO10 | PO11 | PO1<br>2 |
| CO1           |     |     | 1   |     |     |     |            |     |     |      |      | 2        |
| CO2           |     |     |     | 2   |     |     |            |     |     |      |      | 2        |
| CO3           |     |     |     |     | 2   |     |            |     |     |      |      | 2        |
| CO4           |     |     | 2   | 2   | 2   |     | 2          |     | 2   | 2    |      | 2        |

# High-3; Medium-2; Low-1

| ENGINEERING MATERIALS FOR ADVANCED TECHNOLOGY<br>(Group H: Global Elective)           Course Code: 1 16G7H14         CIE         1 00 Marks           Credits: L.T:P:S         : 3:0:0:0         SEE         : 100 Marks           Total Hours         : 3:0:0:0         SEE         : 100 Marks           Course Code:         : 3:0:0:0         SEE Duration         : 3:0:0 Hours           Course Learning Objectives: The students will be able to         see Duration         : 3:0:0 Hours           1         Apply the basic concepts of Chemistry to develop futuristic materials for high-tech applications in the area of Engineering.         Impart sound knowledge in the different fields of material chemistry so as to apply it to the problems in engineering field.         3           3         Develop analytical capabilities of students so that they can characterize, transform and use materials in engineering and apply knowledge gained in solving related engineering problems.           UNIT-I         08 Hrs           Coating and packaging materials           Suptosis and applications of Polymer coating materials: Teflon, Silicone films Polyvinyl chloride & its copolymers, Poly vinyl acetate, Poly ethylene-HDPE, LDPE, Polyurethane.           Properties required in a pigment and extenders.         Inorganic pigments, extanders.           Inorganic pigments, ettanders.         Develop materials         Dotphymer Solyphymers & biodegradable polymers.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | Semester: VII                                                                                             |                                                                                                                                 |             |                                        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                                                |                      |                          |  |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------|-------------|----------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------|----------------------|--------------------------|--|
| (Group H: Global Elective)           Course Code:         :         16G7H14         CIE         :         100 Marks           Credits:         L:T:P:S         :         3:0:0:0         SEE         :         100 Marks           Course Learning Objectives: The students will be able to         SEE Duration         :         3:0:0 Hours           Course Learning Objectives: The students will be able to         Marks         SEE Duration         :         3:0:0 Hours           1         Aapply the basic concepts of Chemistry to develop futuristic materials for high-tech applications in the area of Engineering.         Impart sound knowledge in the different fields of material chemistry so as to apply it to the problems in engineering field.         Just course and apply knowledge gained in solving related engineering problems.           3         UNIT-I         O8 Hrs         Coating and packaging materials           Surface Coating materials:         UNIT-I         O8 Hrs           Coating and packaging materials         Teflon, Silicone films Polyvinyl chloride & its copolymers, Poly vinyl acetate, Poly ethylene-HDPE, LDPE, Polyurethane.         Properties required in a pigment and extenders.           Inorganic pigments-itianium dioxide, zinc oxide, carbon black, chromate pigments, chrome green, ultramarine blue, iron blue, cadmium red.         Corrosion inhibiting pigments.         Ceramic greenties.           Developments in new polymers such as dendrimers,                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | ENGINEERING MATERIALS FOR ADVANCED TECHNOLOGY                                                             |                                                                                                                                 |             |                                        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                                                |                      |                          |  |
| Course Code:         1         16G7H14         CIE         100 Marks           Credits: L:T:P:S         :         3:0:0:0         SEE         :         100 Marks           Course Learning Objectives: The students will be able to         Aapply the basic concepts of Chemistry to develop futuristic materials for high-tech applications in the area of Engineering.         3         Aapply the basic concepts of Chemistry to develop futuristic materials for high-tech applications in the area of Engineering field.           2         Impart sound knowledge in the different fields of material chemistry so as to apply it to the problems in engineering field.         Develop analytical capabilities of students so that they can characterize, transform and use materials in engineering and apply knowledge gained in solving related engineering problems.           Coating and packaging materials         UNIT-I         08 Hrs           Coating and packaging materials:         Stefon, Silicone films Polyvinyl chloride & its copolymers, Poly vinyl acetate, Poly ethylene-HDPE, LDPE, Polyurethane.         Properties required in a pigment and extenders.           Inorganic pigments, intanium dioxide, zinc oxide, carbon black, chromate pigments, chrome green, ultramarine blue, iron blue, cadmium red.         Corosion inhibiting pigments- zinc phosphate, zinc and barium chromate pigments, ceramic pigments, metal flake pigments, extenders.           Developments in new polymers such as dendrimers, biopoplymers & biodegradable polymers.         Packaging materials           Food products: Cellulosic and Polymeric packaging materials                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | (Group H: Global Elective)                                                                                |                                                                                                                                 |             |                                        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                                                |                      |                          |  |
| Credits: L:T:P:S       1       3:0:0:0       SEE       1       100 Marks         Total Hours       i       39L       SEE Duration       i       3.00 Hours         Course Learning Objectives: The students will be able to<br>in the area of Engineering.       Impart sound knowledge in the different fields of material chemistry so as to apply it to the<br>problems in engineering field.       Impart sound knowledge in the different fields of material chemistry so as to apply it to the<br>materials in engineering field.         3       Develop analytical capabilities of students so that they can characterize, transform and use<br>materials in engineering and apply knowledge gained in solving related engineering problems.         VINT-I       08 Hrs         Coating and packaging materials       Surface Coating materials:<br>Surface Coating materials:<br>Synthesis and applications of Polymer coating materials: Teflon, Silicone films Polyvinyl chloride & its<br>copolymers, Poly vinyl acetate, Poly ethylene-HDPE, LDPE, Polyurethane.         Properties required in a pigment and extenders.<br>Inorganic pigments-titanium dioxide, zinc oxide, carbon black, chromate pigments, chrome green,<br>ultramarine blue, iron blue, cadmium red.         Corrosion inhibiting pigments- zinc phosphate, zinc and barium chromate pigments, ceramic<br>pigments, metal flake pigments- such as dendrimers, biopoplymers & biodegradable polymers.         Packaging materials:       Ford products: Cellulosic and Polymeric packaging materials and their properties – including barrier<br>properties, strength properties, optical properties. Glass, aluminium, tin, paper, plastics, composites. <t< th=""><th>Cou</th><th colspan="8">Course Code:         :         16G7H14         CIE         :         100 Marks</th></t<>                                                                                                                                                                                                                                                                                                              | Cou                                                                                                       | Course Code:         :         16G7H14         CIE         :         100 Marks                                                  |             |                                        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                                                |                      |                          |  |
| Total Hours i: ] 39LSEE Duration: ] 3.00 HoursCourse Learning Objectives: The students will be able to1Apply the basic concepts of Chemistry to develop futuristic materials for high-tech applications<br>in the area of Engineering.2Impart sound knowledge in the different fields of material chemistry so as to apply it to the<br>problems in engineering field.3Develop analytical capabilities of students so that they can characterize, transform and use<br>materials in engineering and apply knowledge gained in solving related engineering problems.VITI-I08 HrsCourse Coating materialsSurface Coating materialsCoating materialsCoating materialsCoating materialsCoating materialsSurface Coating materialsSurface Coating materials<                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | Cred                                                                                                      | lits: L:T:P:S                                                                                                                   | :           | 3:0:0:0                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | SEE                                            | :                    | 100 Marks                |  |
| Course Learning Objectives: The students will be able to         1       Aaapply the basic concepts of Chemistry to develop futuristic materials for high-tech applications in the area of Engineering.         2       Impart sound knowledge in the different fields of material chemistry so as to apply it to the problems in engineering field.         3       Develop analytical capabilities of students so that they can characterize, transform and use materials in engineering and apply knowledge gained in solving related engineering problems.         Coating and packaging materials         Surface Coating materials         Surface Coating materials         Surface Coating materials:         Synthesis and applications of Polymer coating materials: Teflon, Silicone films Polyvinyl chloride & its copolymers, Poly vinyl acetate, Poly ethylene-HDPE, LDPE, Polyurethane.         Properties required in a pigment and extenders.       Inorganic pigments-titanium dioxide, zinc oxide, carbon black, chromate pigments, chrome green, ultramarine blue, iron blue, cadmium red.         Corrosion inhibiting pigments- zinc phosphate, zinc and barium chromate pigments, ceramic pigments, metal flake pigments, extenders.         Developments in new polymers such as dendrimers, biopoplymers & biodegradable polymers.         Packaging materials:         Food products: Cellulosic and Polymeric packaging materials and their properties – including barrier properties, strength properties, optical properties, Glass, aluminium, tin, paper, plastics, compos                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | Tota                                                                                                      | l Hours                                                                                                                         | :           | 39L                                    |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | SEE Duration                                   | :                    | 3.00 <b>Hours</b>        |  |
| 1       Aapply the basic concepts of Chemistry to develop futuristic materials for high-tech applications in the area of Engineering.         2       Impart sound knowledge in the different fields of material chemistry so as to apply it to the problems in engineering field.         3       Develop analytical capabilities of students so that they can characterize, transform and use materials in engineering and apply knowledge gained in solving related engineering problems.         UNIT-I       08 Hrs         Coating and packaging materials         Surface Coating materials         Surface Coating materials:         Surface Coating materials:         Surface Coating materials:         Surface Coating materials:         Projecties required in a pigment and extenders.         Inorganic pigments-titanium dioxide, zinc oxide, carbon black, chromate pigments, chrome green, ultramarine blue, iron blue, cadmium red.         Corrosion inhibiting pigments- zinc phosphate, zinc and barium chromate pigments, ceramic pigments in new polymers such as dendrimers, biopoplymers & biodegradable polymers.         Packaging materials:         Food products: Cellulosic and Polymeric packaging materials and their properties – including barrier properties, strength properties, optical properties. Glass, aluminium, tin, paper, plastics, composites.         Pharmaceutical products: Injectibles and tablet packaging materials.     <                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | Cou                                                                                                       | rse Learning Obje                                                                                                               | ectiv       | ves: The students v                    | vill be able to                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                                                |                      |                          |  |
| 2       Impart sound knowledge in the different fields of material chemistry so as to apply it to the problems in engineering field.         3       Develop analytical capabilities of students so that they can characterize, transform and use materials in engineering and apply knowledge gained in solving related engineering problems.         UNIT-I         08 Hrs         Coating and packaging materials         Synthesis and applications of Polymer coating materials: Teflon, Silicone films Polyvinyl chloride & its copolymers, Poly vinyl acetate, Poly ethylene-HDPE, LDPE, Polyurethane.         Properties required in a pigment and extenders.       Inorganic pigments-titanium dioxide, zinc oxide, carbon black, chromate pigments, chrome green, ultramarine blue, iron blue, cadmium red.         Corrosion inhibiting pigments- zinc phosphate, zinc and barium chromate pigments, ceramic pigments, metal flake pigments, extenders.       Developments in new polymers such as dendrimers, biopoplymers & biodegradable polymers.         Packaging materials         Food products: Cellulosic and Polymeric packaging materials and their properties – including barrier properties, strength properties, optical properties. Glass, aluminium, tin, paper, plastics, composites.         Pharmaceutical products: Injectibles and tablet packaging materials.       O7 Hrs         Adhesives       Introduction-Classification of Adhesives-Natural adhesives, synthetic adhesives, multi part adhesives, pressure sensitive adhesives, contact adhesive, strength- Physical factors influencing Adhesive Action- surface tension                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | 1                                                                                                         | 1 Aapply the basic concepts of Chemistry to develop futuristic materials for high-tech applications in the area of Engineering. |             |                                        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                                                |                      |                          |  |
| 3     Develop analytical capabilities of students so that they can characterize, transform and use materials in engineering and apply knowledge gained in solving related engineering problems.       0     UNIT-I     08 Hrs       Coating and packaging materials       Surface Coating materials       Introduction in piblicing pigments- cinc wide, carbon black, chromate pigments, chrome green, ultramarine blue, iron blue, cadmium red.       Corrosion inhibiting pigments- zinc phosphate, zinc and barium chromate pigments, ceramic pigments, metal flake pigments, extenders. <t< td=""><td>2</td><td>Impart sound known in engine</td><td>owl<br/>neer</td><td>edge in the differe</td><th>ent fields of m</th><th>naterial chemistry so</th><td>as to a</td><td>apply it to the</td></t<>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | 2                                                                                                         | Impart sound known in engine                                                                                                    | owl<br>neer | edge in the differe                    | ent fields of m                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | naterial chemistry so                          | as to a              | apply it to the          |  |
| UNIT-I         08 Hrs           Coating and packaging materials         Surface Coating materials:           Synthesis and applications of Polymer coating materials: Teflon, Silicone films Polyvinyl chloride & its copolymers, Poly vinyl acetate, Poly ethylene-HDPE, LDPE, Polyurethane.         Properties required in a pigment and extenders.           Inorganic pigments-titanium dioxide, zinc oxide, carbon black, chromate pigments, chrome green, ultramarine blue, iron blue, cadmium red.         Corrosion inhibiting pigments- zinc phosphate, zinc and barium chromate pigments, ceramic pigments, metal flake pigments, extenders.           Developments in new polymers such as dendrimers, biopoplymers & biodegradable polymers.         Packaging materials:           Food products: Cellulosic and Polymeric packaging materials and their properties – including barrier properties, strength properties, optical properties. Glass, aluminium, tin, paper, plastics, composites.           Pharmaceutical products: Injectibles and tablet packaging materials         07 Hrs           Adhesives         UNIT-II         07 Hrs           Adhesives         Adhesives., synthetic adhesives, multi part adhesives, pressure sensitive adhesives, contact adhesives, hot adhesive, suffice adhesive Action-surface smoothness, thickness of adhesive film, elasticity and tensile strength. Chemical Factors Influencing Adhesive action - presence of polar groups, degree of polymerization, complexity of the adhesive molecules, effect of pH. Adhesive action- specific adhesive action, mechanical adhesive action, fusion adhesion. Development of adhesives-swith reference to Epoxy, phenolics, Silicone, Polywing acetate.                                                                                                                                                                                                                                                                                                                                                                                                                      | 3                                                                                                         | Develop analytic materials in engin                                                                                             | al oneer    | capabilities of studing and apply know | dents so that two so that the second se | they can characteriz<br>in solving related eng | e, trans<br>gineerin | form and use g problems. |  |
| Coating and packaging materials       Surface Coating materials:         Synthesis and applications of Polymer coating materials: Teflon, Silicone films Polyvinyl chloride & its copolymers, Poly vinyl acetate, Poly ethylene-HDPE, LDPE, Polyurethane.         Properties required in a pigment and extenders.         Inorganic pigments-titanium dioxide, zinc oxide, carbon black, chromate pigments, chrome green, ultramarine blue, iron blue, cadmium red.         Corrosion inhibiting pigments- zinc phosphate, zinc and barium chromate pigments, ceramic pigments in new polymers such as dendrimers, biopoplymers & biodegradable polymers.         Packaging materials:         Food products: Cellulosic and Polymeric packaging materials and their properties – including barrier properties, strength properties, optical properties. Glass, aluminium, tin, paper, plastics, composites.         Pharmaceutical products: Injectibles and tablet packaging materials.         UNIT-III       07 Hrs         Adhesives         Introduction-Classification of Adhesives-Natural adhesives, synthetic adhesives-drying adhesives, pressure sensitive adhesives, contact adhesives strength- Physical factors influencing Adhesive Action-surface tension, surface smoothness, thickness of adhesive strength- adsorption theory and diffusion theory. Preparation, curing and bonding Processes by adhesives strength - adsorption theory and diffusion theory. Preparation, curing and bonding Processes by adhesives strength - adsorption theory and diffusion theory. Preparation, curing and bonding Processes by adhesives strength - adsorption theory and diffusion theory. Preparation, curing and bonding Processes by adhesive strength - dosprint acta. </td <td></td> <td></td> <td></td> <td>UNI</td> <th>Г-І</th> <th></th> <td></td> <td>08 Hrs</td>                                                                                                                                                                                                                                                                                                 |                                                                                                           |                                                                                                                                 |             | UNI                                    | Г-І                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |                                                |                      | 08 Hrs                   |  |
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| copolymers, Poly vinyl acetate, Poly ethylene-HDPE, LDPE, Polyurethane.         Properties required in a pigment and extenders.         Inorganic pigments-titanium dioxide, zinc oxide, carbon black, chromate pigments, chrome green, ultramarine blue, iron blue, cadmium red. <b>Corrosion inhibiting pigments-</b> zinc phosphate, zinc and barium chromate pigments, ceramic pigments, metal flake pigments, extenders.         Developments in new polymers such as dendrimers, biopoplymers & biodegradable polymers. <b>Packaging materials:</b> Food products: Cellulosic and Polymeric packaging materials and their properties – including barrier properties, strength properties, optical properties. Glass, aluminium, tin, paper, plastics, composites.         Pharmaceutical products: Injectibles and tablet packaging materials. <b>UNIT-II 07 Hrs</b> Adhesives         Introduction-Classification of Adhesives-Natural adhesives, synthetic adhesives-drying adhesives, pressure sensitive adhesives, contact adhesives strength- Physical factors influencing Adhesive Action-surface tension, surface smoothness, thickness of adhesive film, elasticity and tensile strength. Chemical Factors Influencing Adhesive action - presence of polar groups, degree of polymerization, complexity of the adhesive molecules, effect of pH. Adhesive action-specific adhesive action, mechanical adhesive action, fusion adhesion. Development of adhesive strength- adsorption theory and diffusion theory. Preparation, curing and bonding Processes by adhesives-with reference to Epoxy, phenolics, Silicone, Polyurethane, Acrylic adhesives, Poly vinyl alcohol, Polyvinyl acetate.                                                                                                                                                                                                                                                                                                                                                                                                                                                                           | Svnt                                                                                                      | hesis and application                                                                                                           | ons         | of Polymer coating                     | materials: Tef                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | lon. Silicone films Po                         | olvvinvl             | chloride & its           |  |
| Properties required in a pigment and extenders.<br>Inorganic pigments-titanium dioxide, zinc oxide, carbon black, chromate pigments, chrome green,<br>ultramarine blue, iron blue, cadmium red.<br><b>Corrosion inhibiting pigments-</b> zinc phosphate, zinc and barium chromate pigments, ceramic<br>pigments, metal flake pigments, extenders.<br>Developments in new polymers such as dendrimers, biopoplymers & biodegradable polymers.<br><b>Packaging materials:</b><br>Food products: Cellulosic and Polymeric packaging materials and their properties – including barrier<br>properties, strength properties, optical properties. Glass, aluminium, tin, paper, plastics, composites.<br><b>Pharmaceutical products:</b> Injectibles and tablet packaging materials.<br><b>Mathematical products:</b> Injectibles and tablet packaging materials.<br><b>Mathematical products:</b> Injectibles and tablet packaging materials.<br><b>Mathematical products:</b> Injectibles and tablet packaging materials.<br><b>Pharmaceutical products:</b> Injectibles and tablet packaging materials.<br><b>Mathematical Notices</b><br><b>Adhesives</b><br>Introduction-Classification of Adhesives-Natural adhesives, synthetic adhesives-drying adhesives,<br>pressure sensitive adhesives, contact adhesives, hot adhesives. One part adhesives, multi part adhesives.<br>Adhesive Action. Development of Adhesive strength- Physical factors influencing Adhesive Action-<br>surface tension, surface smoothness, thickness of adhesive film, elasticity and tensile strength. Chemical<br>Factors Influencing Adhesive action - presence of polar groups, degree of polymerization, complexity<br>of the adhesive molecules, effect of pH. Adhesive action- specific adhesive action, mechanical adhesive<br>action, fusion adhesion. Development of adhesive strength- adsorption theory and diffusion theory.<br>Preparation, curing and bonding Processes by adhesives-with reference to Epoxy, phenolics, Silicone,<br>Polyurethane, Acrylic adhesives, Poly vinyl alcohol, Polyvinyl acetate.<br><b>UNIT-III</b><br><b>O8 Hrs</b>                                            | copo                                                                                                      | lymers. Poly vinyl                                                                                                              | ace         | tate. Polv ethvlene                    | -HDPE, LDPE                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | . Polvurethane.                                |                      |                          |  |
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| Developments in new polymers such as dendrimers, biopoplymers & biodegradable polymers.<br>Packaging materials:<br>Food products: Cellulosic and Polymeric packaging materials and their properties – including barrier<br>properties, strength properties, optical properties. Glass, aluminium, tin, paper, plastics, composites.<br>Pharmaceutical products: Injectibles and tablet packaging materials.<br>Pharmaceutical products: Injectibles and tablet | pigm                                                                                                      | ents, metal flake pi                                                                                                            | igm         | ents, extenders.                       | -                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |                                                | 2 -                  |                          |  |
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| Pharmaceutical products: Injectibles and tablet packaging materials.         UNIT-II       07 Hrs         Adhesives       Introduction-Classification of Adhesives-Natural adhesives, synthetic adhesives-drying adhesives, pressure sensitive adhesives, contact adhesives, hot adhesives. One part adhesives, multi part adhesives. Adhesive Action. Development of Adhesive strength- Physical factors influencing Adhesive Actionsurface tension, surface smoothness, thickness of adhesive film, elasticity and tensile strength. Chemical Factors Influencing Adhesive action - presence of polar groups, degree of polymerization, complexity of the adhesive molecules, effect of pH. Adhesive action- specific adhesive action, mechanical adhesive action, fusion adhesion. Development of adhesive strength- adsorption theory and diffusion theory. Preparation, curing and bonding Processes by adhesives-with reference to Epoxy, phenolics, Silicone, Polyurethane, Acrylic adhesives, Poly vinyl alcohol, Polyvinyl acetate.       UNIT-III       08 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | prop                                                                                                      | erties, strength prop                                                                                                           | pert        | ies, optical propert                   | ies. Glass, alur                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | ninium, tin, paper, pl                         | lastics, o           | composites.              |  |
| UNIT-II07 HrsAdhesivesIntroduction-Classification of Adhesives-Natural adhesives, synthetic adhesives-drying adhesives,<br>pressure sensitive adhesives, contact adhesives, hot adhesives. One part adhesives, multi part adhesives.<br>Adhesive Action. Development of Adhesive strength- Physical factors influencing Adhesive Action-<br>surface tension, surface smoothness, thickness of adhesive film, elasticity and tensile strength. Chemical<br>Factors Influencing Adhesive action - presence of polar groups, degree of polymerization, complexity<br>of the adhesive molecules, effect of pH. Adhesive action- specific adhesive action, mechanical adhesive<br>action, fusion adhesion. Development of adhesive strength- adsorption theory and diffusion theory.<br>Preparation, curing and bonding Processes by adhesives-with reference to Epoxy, phenolics, Silicone,<br>Polyurethane, Acrylic adhesives, Poly vinyl alcohol, Polyvinyl acetate.08 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | Phar                                                                                                      | rmaceutical produ                                                                                                               | icts        | Injectibles and tal                    | blet packaging                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | materials.                                     |                      | -                        |  |
| AdhesivesIntroduction-Classification of Adhesives-Natural adhesives, synthetic adhesives-drying adhesives,<br>pressure sensitive adhesives, contact adhesives, hot adhesives. One part adhesives, multi part adhesives.<br>Adhesive Action. Development of Adhesive strength- Physical factors influencing Adhesive Action-<br>surface tension, surface smoothness, thickness of adhesive film, elasticity and tensile strength. Chemical<br>Factors Influencing Adhesive action - presence of polar groups, degree of polymerization, complexity<br>of the adhesive molecules, effect of pH. Adhesive action- specific adhesive action, mechanical adhesive<br>action, fusion adhesion. Development of adhesive strength- adsorption theory and diffusion theory.<br>Preparation, curing and bonding Processes by adhesives-with reference to Epoxy, phenolics, Silicone,<br>Polyurethane, Acrylic adhesives, Poly vinyl alcohol, Polyvinyl acetate.08 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |                                                                                                           |                                                                                                                                 |             | UNIT                                   | Г <b>-II</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |                                                |                      | 07 Hrs                   |  |
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| pressure sensitive adhesives, contact adhesives, hot adhesives. One part adhesives, multi part adhesives.Adhesive Action. Development of Adhesive strength- Physical factors influencing Adhesive Action-<br>surface tension, surface smoothness, thickness of adhesive film, elasticity and tensile strength. Chemical<br>Factors Influencing Adhesive action - presence of polar groups, degree of polymerization, complexity<br>of the adhesive molecules, effect of pH. Adhesive action- specific adhesive action, mechanical adhesive<br>action, fusion adhesion. Development of adhesive strength- adsorption theory and diffusion theory.<br>Preparation, curing and bonding Processes by adhesives-with reference to Epoxy, phenolics, Silicone,<br>Polyurethane, Acrylic adhesives, Poly vinyl alcohol, Polyvinyl acetate.08 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | Intro                                                                                                     | Introduction-Classification of Adhesives-Natural adhesives, synthetic adhesives-drving adhesives.                               |             |                                        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                                                |                      |                          |  |
| Adhesive Action. Development of Adhesive strength- Physical factors influencing Adhesive Action-<br>surface tension, surface smoothness, thickness of adhesive film, elasticity and tensile strength. Chemical<br>Factors Influencing Adhesive action - presence of polar groups, degree of polymerization, complexity<br>of the adhesive molecules, effect of pH. Adhesive action- specific adhesive action, mechanical adhesive<br>action, fusion adhesion. Development of adhesive strength- adsorption theory and diffusion theory.<br>Preparation, curing and bonding Processes by adhesives-with reference to Epoxy, phenolics, Silicone,<br>Polyurethane, Acrylic adhesives, Poly vinyl alcohol, Polyvinyl acetate.08 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | pressure sensitive adhesives, contact adhesives, hot adhesives. One part adhesives, multi part adhesives. |                                                                                                                                 |             |                                        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                                                |                      |                          |  |
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| Factors Influencing Adhesive action - presence of polar groups, degree of polymerization, complexity<br>of the adhesive molecules, effect of pH. Adhesive action- specific adhesive action, mechanical adhesive<br>action, fusion adhesion. Development of adhesive strength- adsorption theory and diffusion theory.<br>Preparation, curing and bonding Processes by adhesives-with reference to Epoxy, phenolics, Silicone,<br>Polyurethane, Acrylic adhesives, Poly vinyl alcohol, Polyvinyl acetate.08 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | surfa                                                                                                     | ce tension, surface                                                                                                             | sme         | oothness, thickness                    | of adhesive fil                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | m, elasticity and tens                         | ile stren            | gth. Chemical            |  |
| of the adhesive molecules, effect of pH. Adhesive action- specific adhesive action, mechanical adhesive action, fusion adhesion. Development of adhesive strength- adsorption theory and diffusion theory. Preparation, curing and bonding Processes by adhesives-with reference to Epoxy, phenolics, Silicone, Polyurethane, Acrylic adhesives, Poly vinyl alcohol, Polyvinyl acetate.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | Facto                                                                                                     | Factors Influencing Adhesive action - presence of polar groups, degree of polymerization, complexity                            |             |                                        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                                                |                      |                          |  |
| action, fusion adhesion. Development of adhesive strength- adsorption theory and diffusion theory.<br>Preparation, curing and bonding Processes by adhesives-with reference to Epoxy, phenolics, Silicone,<br>Polyurethane, Acrylic adhesives, Poly vinyl alcohol, Polyvinyl acetate.<br>UNIT-III 08 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | of th                                                                                                     | of the adhesive molecules, effect of pH. Adhesive action- specific adhesive action, mechanical adhesive                         |             |                                        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                                                |                      |                          |  |
| Preparation, curing and bonding Processes by adhesives-with reference to Epoxy, phenolics, Silicone,<br>Polyurethane, Acrylic adhesives, Poly vinyl alcohol, Polyvinyl acetate.<br>UNIT-III 08 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | actio                                                                                                     | action, fusion adhesion. Development of adhesive strength- adsorption theory and diffusion theory.                              |             |                                        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                                                |                      |                          |  |
| Polyurethane, Acrylic adhesives, Poly vinyl alcohol, Polyvinyl acetate. UNIT-III 08 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | Prep                                                                                                      | Preparation, curing and bonding Processes by adhesives-with reference to Epoxy, phenolics, Silicone,                            |             |                                        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                                                |                      |                          |  |
| UNIT-III 08 Hrs                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | Poly                                                                                                      | Polyurethane, Acrylic adhesives, Poly vinyl alcohol, Polyvinyl acetate.                                                         |             |                                        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                                                |                      |                          |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |                                                                                                           |                                                                                                                                 |             | UNIT                                   | -III                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |                                                |                      | 08 Hrs                   |  |

#### **Optical fibre materials**

Fiber Optics, Advantages of optical fiber communication over analog communication, Classification based on refractive index of the core- step index and graded index optical fibres, Classification based on core radius-single mode and multimode optical fibres, Fibre fabrication.-Methods to manufacture optical glass fibres. Double crucible method and preform methods. Manufacture of perform- Chemical Vapour Deposition (CVD), Modified vapour deposition (MCVD) Plasma activated vapour deposition (PCVD), Outside vapour deposition (OVD)-Vapour-phase axial deposition (VAD). Drawing the fibres from perform, coating and jacketing process.

#### Ion exchange resins and membranes

Ion exchange resins-Introduction, Types, physical properties, chemical properties-capacity, swelling, kinetics, stability, ion exchange equilibrium, regeneration. Applications of ion exchange resinssoftening of water, demineralization of water, advantages and disadvantages of ion exchange resinscalcium sulphate fouling, iron fouling, adsorption of organic matter, bacterial contamination. Ion exchange membranes, Types, Classification, Fabrication of ion exchange cottons- anion exchange cotton and cation exchange cotton. Application of ion exchange membranes in purification of water by electro dialysis method.

| JNIT-IV |
|---------|
|---------|

**08 Hrs** 

08 Hrs

# Spectroscopic Characterization of materials:

Electromagnetic radiation, interaction of materials with electromagnetic radiation.

UV- visible spectrophotometry :Introduction-Electronic transitions- factors influencing position and intensity of absorption bands-absorption spectra of dienes, polyene and  $\alpha,\beta$ -unsaturated carbonyl compounds, Working of UV-Vis spectrophotometer, Theoretical calculation of  $\lambda_{max}$  by using Woodward-Fieser rules- for cyclic and  $\alpha,\beta$ -unsaturated carbonyl compounds.

IR Spectroscopy: Introduction, principle, molecular vibrations, vibrational frequency, number of fundamental vibrations, factors influencing fundamental vibrations, instrumentation of IR spectrophotometer, sampling techniques and application of IR spectroscopy in characterization of functional groups.

**UNIT-V** 

#### NMR spectroscopy:

H<sup>1</sup> NMR Spectroscopy: Basic concepts- relaxation process. NMR spectrometer-FT NMR-Solvents used in NMR, internal standards-Chemical equivalence -Integrals and Integrations- chemical shift-Factors affecting chemical shifts- shielding and deshielding effects – chemical and magnetic equivalent – magnetic anisotropy-spin-spin splitting rules- Application of NMR on various compounds such as alkanes, alkenes, alkynes, alkyl halides, alcohols, ethers, amines, aldehydes, ketones, carboxylic acids, esters, amides & mono substituted aromatic compounds. Problems on prediction of structure of compounds.

| Course Outcomes: After completing the course, the students will be able to |                                                      |  |  |  |  |  |
|----------------------------------------------------------------------------|------------------------------------------------------|--|--|--|--|--|
| <b>CO1</b> Identify sustainable engineering materials and                  | l understand their properties.                       |  |  |  |  |  |
| CO2 Apply the basic concepts of chemistry to dev                           | elop futuristic materials for high-tech applications |  |  |  |  |  |
| in different areas of engineering.                                         |                                                      |  |  |  |  |  |
| CO3 Analyze and evaluate the specific application                          | of materials.                                        |  |  |  |  |  |
| <b>CO4</b> Design the route for synthesis of material and                  | its characterization.                                |  |  |  |  |  |

#### **Reference Books**

| 1. | Materials Science, G.K.Narula, K.S.Narula & V.K.Gupta. 38th Editon, 2015, Tata McGraw-Hill            |
|----|-------------------------------------------------------------------------------------------------------|
|    | Publishing Company Limited ISBN: 978-0-07-451796-3.                                                   |
| 2. | Solar Lighting, Ramachandra Pode and Boucar Diouf, Springer e-book, 2011, ISBN: 978-1-44-             |
|    | 712133-6 (Print) 978-1-44-712134-3 (Online),                                                          |
| 3. | Spectroscopy of organic compounds, P.S.Kalsi, 6 <sup>th</sup> Edition, 2013, New Age International(P) |
|    | ltd,publisher, ISBN: 978-1-22-415438-6.                                                               |
| 4. | Food Packaging Materials, Mahadeviah M & Gowramma RV, 6 <sup>th</sup> Edition, 1996, Tata McGraw      |
|    | Hill Publishing Company Ltd, ISBN :746-2-23-82 9780-0.                                                |

#### Continuous Internal Evaluation (CIE); Theory (100 Marks)

**CIE** is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for Assignment/Presentation/Project 10.

#### Total CIE is 30(Q) + 60(T) + 10(A) = 100 Marks.

#### Semester End Evaluation (SEE); Theory (100 Marks)

| Semester: VII (Global elective)  |                                                                                                   |       |                    |                      |                        |     |                   |  |  |
|----------------------------------|---------------------------------------------------------------------------------------------------|-------|--------------------|----------------------|------------------------|-----|-------------------|--|--|
| APPLIED PSYCHOLOGY FOR ENGINEERS |                                                                                                   |       |                    |                      |                        |     |                   |  |  |
|                                  |                                                                                                   |       | (Grou              | up H: Global Elect   | ive)                   |     |                   |  |  |
| Cou                              | Course Code : 16G7H15 CIE : 100                                                                   |       |                    |                      |                        |     |                   |  |  |
| Cred                             | lits: L:T:P:S                                                                                     | :     | 3:0:0:0            |                      | SEE                    | :   | 100               |  |  |
| Tota                             | l Hours                                                                                           | :     | 35                 |                      | SEE Duration           | :   | 3 Hours           |  |  |
| Cou                              | rse Learning (                                                                                    | Obje  | ctives: The studen | ts will be able to   |                        |     |                   |  |  |
| 1                                | To appreciate                                                                                     | hun   | han behavior and h | uman mind in the co  | ontext of learner's im | me  | diate society and |  |  |
|                                  | environment.                                                                                      |       |                    |                      |                        |     |                   |  |  |
| 2                                | To understand                                                                                     | d the | importance of life | long learning and pe | ersonal flexibility to | sus | tain personal and |  |  |
|                                  | Professional development as the nature of work evolves.                                           |       |                    |                      |                        |     |                   |  |  |
| 3                                | To provide s                                                                                      | tude  | nts with knowledg  | ge and skills for bu | uilding firm foundat   | ion | for the suitable  |  |  |
|                                  | engineering p                                                                                     | rofe  | ssions.            |                      |                        |     |                   |  |  |
| 4                                | 4 To prepare students to function as effective Engineering Psychologists in an Industrial,        |       |                    |                      |                        |     |                   |  |  |
|                                  | Governmental or consulting organization.                                                          |       |                    |                      |                        |     |                   |  |  |
| 5                                | To enable students to use psychological knowledge, skills, and values in occupational pursuits in |       |                    |                      |                        |     |                   |  |  |
|                                  | a variety of settings that meet personal goals and societal needs.                                |       |                    |                      |                        |     |                   |  |  |

| Unit – I                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | 07 Hrs                                            |  |  |  |  |  |  |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------|--|--|--|--|--|--|
| Introduction to Psychology: Definition and goals of Psychology: Role of a Psychologist in the Society:                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |                                                   |  |  |  |  |  |  |
| Today's Perspectives (Branches of psychology). Psychodynamic, Behavioristic, Cognitive, Humanistic,                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |                                                   |  |  |  |  |  |  |
| Psychological Research and Methods to study Human Behavior: Experimental, Ob                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | oservation,                                       |  |  |  |  |  |  |
| Questionnaire and Clinical Method.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | n                                                 |  |  |  |  |  |  |
| Unit - II                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | 07 Hrs                                            |  |  |  |  |  |  |
| Intelligence and Aptitude: Concept and definition of Intelligence and Aptitude, Nature of In                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | telligence.                                       |  |  |  |  |  |  |
| Theories of Intelligence – Spearman, Thurston, Guilford Vernon. Characteristics of Intellig                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | ence tests,                                       |  |  |  |  |  |  |
| Types of tests. Measurement of Intelligence and Aptitude, Concept of IQ, Measurement of                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | f Multiple                                        |  |  |  |  |  |  |
| Intelligence – Fluid and Crystallized Intelligence.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |                                                   |  |  |  |  |  |  |
| Unit – III                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      | 07 Hrs                                            |  |  |  |  |  |  |
| Personality: Concept and definition of personality, Approaches of personality- psychoanalytic                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | cal, Socio-                                       |  |  |  |  |  |  |
| Cultural, Interpersonal and developmental, Humanistic, Behaviorist, Trait and type ap                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           | oproaches.                                        |  |  |  |  |  |  |
| Assessment of Personality: Self- report measures of Personality, Questionnaires, Rating S                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | Scales and                                        |  |  |  |  |  |  |
| Projective techniques, its Characteristics, advantages & limitations, examples. Behavioral As                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | ssessment.                                        |  |  |  |  |  |  |
| Psychological Stress: a. Stress- Definition, Symptoms of Stress, Extreme products of stress v                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | s Burnout,                                        |  |  |  |  |  |  |
| Work Place Trauma. Causes of Stress – Job related causes of stress. Sources of Frustrat                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | ion, Stress                                       |  |  |  |  |  |  |
| and Job Performance, Stress Vulnerability-Stress threshold, perceived control.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | 1                                                 |  |  |  |  |  |  |
| Unit – IV                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | 07 Hrs                                            |  |  |  |  |  |  |
| Application of Psychology in Working Environment: The present scenario of ir                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | formation                                         |  |  |  |  |  |  |
| technology, the role of psychologist in the organization, Selection and Training of P                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           | sychology                                         |  |  |  |  |  |  |
| Professionals to work in the field of Information Technology. Distance learning, Psy                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | chological                                        |  |  |  |  |  |  |
| consequences of recent developments in information Technology. Type A and Type B Psy                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | chological                                        |  |  |  |  |  |  |
| Counseiing - Need for Counseiing, Types – Directed, Non- Directed, Participative Counseiin                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      | 1g.                                               |  |  |  |  |  |  |
| Unit – V<br>Learning: Definition Conditioning Classical Conditioning Design of Classical Co                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | 0/Hrs                                             |  |  |  |  |  |  |
| Learning: Definition, Conditioning – Classical Conditioning, Basics of Classical Co                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | nditioning                                        |  |  |  |  |  |  |
| (Payloy) the process of Extinction Discrimination and Constraining Operant Conditionin                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | nditioning                                        |  |  |  |  |  |  |
| (Pavlov), the process of Extinction, Discrimination and Generalization. Operant Conditioning<br>evol. The basics of operant conditioning. Schedules of reinforcement. Cognitive – Social a                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      | nditioning<br>g (Skinner                          |  |  |  |  |  |  |
| (Pavlov), the process of Extinction, Discrimination and Generalization. Operant Conditioning<br>expt). The basics of operant conditioning, Schedules of reinforcement. Cognitive – Social a<br>to learning – Latent Learning, Observational Learning, Trial and Error Method, Insightful Le                                                                                                                                                                                                                                                                                                                                                                                                                                     | nditioning<br>g (Skinner<br>pproaches             |  |  |  |  |  |  |
| (Pavlov), the process of Extinction, Discrimination and Generalization. Operant Conditioning<br>expt). The basics of operant conditioning, Schedules of reinforcement. Cognitive – Social a<br>to learning – Latent Learning, Observational Learning, Trial and Error Method, Insightful Le                                                                                                                                                                                                                                                                                                                                                                                                                                     | nditioning<br>g (Skinner<br>pproaches<br>earning. |  |  |  |  |  |  |
| (Pavlov), the process of Extinction, Discrimination and Generalization. Operant Conditioning<br>expt). The basics of operant conditioning, Schedules of reinforcement. Cognitive – Social a<br>to learning – Latent Learning, Observational Learning, Trial and Error Method, Insightful Le<br>Experimental Psychology (Practicals)- Self Study 2 Hrs /Week                                                                                                                                                                                                                                                                                                                                                                     | nditioning<br>g (Skinner<br>pproaches<br>earning. |  |  |  |  |  |  |
| (Pavlov), the process of Extinction, Discrimination and Generalization. Operant Conditioning<br>expt). The basics of operant conditioning, Schedules of reinforcement. Cognitive – Social a<br>to learning – Latent Learning, Observational Learning, Trial and Error Method, Insightful Le<br>Experimental Psychology (Practicals)- Self Study 2 Hrs /Week<br>1.Bhatia's Battery of Performance and intelligence test                                                                                                                                                                                                                                                                                                          | nditioning<br>g (Skinner<br>pproaches<br>earning. |  |  |  |  |  |  |
| (Pavlov), the process of Extinction, Discrimination and Generalization. Operant Conditioning expt). The basics of operant conditioning, Schedules of reinforcement. Cognitive – Social a to learning – Latent Learning, Observational Learning, Trial and Error Method, Insightful Learning – Latent Learning – Social a to learning – Latent Learning, Observational Learning, Trial and Error Method, Insightful Learning – Latent Learning, Observational Learning, Trial and Error Method, Insightful Learning – Latent Learning, Observational Learning, Trial and Error Method, Insightful Learning – Latent Learning – Latent Learning of Performance and Intelligence test 2.Multidimensional Assessment of Personality | nditioning<br>g (Skinner<br>pproaches<br>earning. |  |  |  |  |  |  |

3.David's Battery of Differential Abilities (Aptitude test)

4.Bilateral Transfer of Training Mirror drawing apparatus with Electronic Digital Reset Error Counter (Performance)

5. Student Stress Scale.

| Cours | Course Outcomes: After completing the course, the students will be able to                                                                                                                            |  |  |  |  |  |  |
|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|--|--|--|--|
| CO1   | Describe the basic theories, principles, and concepts of applied psychology as they relate to                                                                                                         |  |  |  |  |  |  |
|       | behaviors and mental processes.                                                                                                                                                                       |  |  |  |  |  |  |
| CO2   | Define learning and compare and contrast the factors that cognitive, behavioral, and                                                                                                                  |  |  |  |  |  |  |
|       | Humanistic theorists believe influence the learning process.                                                                                                                                          |  |  |  |  |  |  |
| CO3   | Develop understanding of psychological attributes such as intelligence, aptitude, creativity, resulting in their enhancement and apply effective strategies for self-management and self-improvement. |  |  |  |  |  |  |
| CO4   | Apply the theories into their own and others' lives in order to better understand their personalities                                                                                                 |  |  |  |  |  |  |
|       | and experiences.                                                                                                                                                                                      |  |  |  |  |  |  |

#### **Reference Books**

| 1. | Understanding Psychology Feldman R. S, IV edition, (1996) McGraw Hill India                                                                   |
|----|-----------------------------------------------------------------------------------------------------------------------------------------------|
| 2. | Psychology Robert A. Baron, III edition (1995) Prentice Hall India                                                                            |
| 3. | Organizational Behaviour , Stephen P Robbins Pearson Education Publications, 13th Edition, $ISBN - 81-317 - 1132 - 3$                         |
| 4. | Organisational Behaviour : Human Behaviour at Work ,John W.Newstrem and Keith Davis. Tata McGraw Hill India, 10th Edition, ISBN 0-07-046504-5 |

#### Continuous Internal Evaluation (CIE); Theory (100 Marks)

**CIE** is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for Assignment/Presentation/Project 10. Total CIE is 30(Q) + 60(T) + 10(A) = 100 Marks.

# Semester End Evaluation (SEE); Theory (100 Marks)

|                                                                                                      | VII Semester                                                                              |         |                                         |             |                      |                                       |      |               |  |
|------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------|---------|-----------------------------------------|-------------|----------------------|---------------------------------------|------|---------------|--|
| FOUNDATIONAL COURSE ON ENTREPRENEURSHIP                                                              |                                                                                           |         |                                         |             |                      |                                       |      |               |  |
| (Group H: Global Elective)                                                                           |                                                                                           |         |                                         |             |                      |                                       |      |               |  |
| Co                                                                                                   | Course Code : 16G7H16 CIE Marks : 100                                                     |         |                                         |             |                      |                                       |      |               |  |
| Cr                                                                                                   | edits: L:T:P:S                                                                            | :       | 3:0:0:0                                 |             |                      | SEE Marks                             | :    | 100           |  |
| Total Hours     :     36L     SEE Duration     :     03 Hours                                        |                                                                                           |         |                                         |             |                      |                                       |      | 03 Hours      |  |
| Co                                                                                                   | urse Learning (                                                                           | )<br>Db | jectives:                               |             |                      |                                       |      |               |  |
| 1                                                                                                    | To make partic                                                                            | ripa    | nts self-discov                         | er their ir | nate flow, entrepre  | eneurial style, and ide               | ntif | v problems    |  |
|                                                                                                      | worth solving t                                                                           | her     | eby becoming                            | entreprene  | eurs                 | , , , , , , , , , , , , , , , , , , , |      | <b>J I</b>    |  |
| 2                                                                                                    | To handhold p                                                                             | arti    | cipants on lean                         | methodo     | logy to craft value  | proposition and get r                 | ead  | v with lean   |  |
|                                                                                                      | canvas                                                                                    |         | - <b>F</b>                              |             |                      | rr                                    |      | <i>J</i>      |  |
| 3                                                                                                    | To create solut                                                                           | ior     | demo by cond                            | lucting cu  | stomer interviews    | and finding problem-                  | solı | ution fit for |  |
| -                                                                                                    | building Minin                                                                            | nun     | n Viable Produc                         | ct (MVP)    |                      | and many processi                     | 5010 |               |  |
| 4                                                                                                    | To make partic                                                                            | ina     | nts understand                          | cost struc  | ture pricing reven   | ue types and importat                 | ice  | of adopting   |  |
| -                                                                                                    | shared leadersh                                                                           | in      | to build good te                        | eam         | , priorig, reven     |                                       |      | or weopung    |  |
| 5                                                                                                    | To help partici                                                                           | pan     | ts build a stron                        | g brand a   | nd identify various  | sales channels for the                | ir p | roducts and   |  |
| -                                                                                                    | services                                                                                  | p       |                                         | 0           | j ·                  |                                       | r    |               |  |
| 6                                                                                                    | To take partic                                                                            | ipa     | nts through ba                          | sics of b   | usiness regulations  | s and other legal ter                 | ms   | along-with    |  |
|                                                                                                      | understanding                                                                             | of I    | ntellectual Pro                         | perty Right | nts                  |                                       |      | 8             |  |
| ļ                                                                                                    |                                                                                           |         |                                         |             |                      |                                       |      |               |  |
|                                                                                                      |                                                                                           |         |                                         | Unit        | -I                   |                                       |      | 07 Hrs        |  |
| Se                                                                                                   | f-Discoverv and                                                                           | 10      | pportunity Di                           | scoverv     |                      |                                       |      |               |  |
| Fir                                                                                                  | iding the Flow:                                                                           | Eff     | ectuation: Iden                         | tifving th  | e Effectuation prin  | ciples used in activit                | ies: | Identifying   |  |
| Pro                                                                                                  | blem Worth S                                                                              | olv     | ing: Design 7                           | Chinking:   | Brainstorming: P     | resenting the Identi                  | fied | problems:     |  |
| Ide                                                                                                  | entifying the Entr                                                                        | ep      | reneurial Style.                        | 6,          | 8,                   | 8                                     |      | r ·····       |  |
|                                                                                                      |                                                                                           | Ĵ       |                                         | Unit -      | - II                 |                                       |      | 07 Hrs        |  |
| Cu                                                                                                   | stomer, Solutio                                                                           | n a     | nd Lean Meth                            | odology     |                      |                                       |      | •             |  |
| Cu                                                                                                   | stomers and Ma                                                                            | rke     | ts; Segmentati                          | on and Ta   | argeting; Identifyin | g Jobs, Pains, and G                  | ains | s and Early   |  |
| Ad                                                                                                   | opters; Crafting                                                                          | Va      | lue Proposition                         | Canvas (    | (VPC); Presenting    | VPC; Basics of Busir                  | iess | Model and     |  |
| Le                                                                                                   | an Approach; Sk                                                                           | etc     | hing the Lean C                         | Canvas; R   | isks and Assumptio   | ons; Presenting Lean C                | Canv | /as.          |  |
|                                                                                                      | •                                                                                         |         | ~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~ | Unit –      | - III                |                                       |      | 07 Hrs        |  |
| Pr                                                                                                   | oblem-Solution                                                                            | Fit     | and Building                            | MVP         |                      |                                       |      | ·             |  |
| Blu                                                                                                  | ue Ocean Strateg                                                                          | у-      | Plotting the Str                        | ategy Car   | vas; Four Action F   | ramework: Eliminate-                  | Rec  | luce-Raise-   |  |
| Create Grid of Blue Ocean Strategy; Building Solution Demo and Conducting Solution Interviews:       |                                                                                           |         |                                         |             |                      |                                       |      |               |  |
| Problem-Solution Fit; Building MVP; Product-Market Fit; Presenting MVP.                              |                                                                                           |         |                                         |             |                      |                                       |      |               |  |
| Unit – IV 06 Hrs                                                                                     |                                                                                           |         |                                         |             |                      |                                       |      |               |  |
| Fii                                                                                                  | nancial Planning                                                                          | g &     | z Team Buildir                          | ng          |                      |                                       |      |               |  |
| Cost Structure - Estimating Costs; Revenues and Pricing: Revenue Streams, Revenue Types, Identifying |                                                                                           |         |                                         |             |                      |                                       |      |               |  |
| Secondary Revenue Streams, Estimating Revenue and Price; Profitability Checks; Bootstrapping and     |                                                                                           |         |                                         |             |                      |                                       |      |               |  |
| Ini                                                                                                  | Initial Financing; Practising Pitch; Shared Leadership; Hiring and Fitment, Team Role and |         |                                         |             |                      |                                       |      |               |  |
| Re                                                                                                   | Responsibilities.                                                                         |         |                                         |             |                      |                                       |      |               |  |
|                                                                                                      |                                                                                           |         |                                         | Unit -      | - V                  |                                       |      | 09 Hrs        |  |
| Ma                                                                                                   | Marketing, Sales, Regulations and Intellectual Property                                   |         |                                         |             |                      |                                       |      |               |  |
| Po                                                                                                   | sitioning and B                                                                           | rar     | ding; Channel                           | s; Sales    | Planning; Project    | Management; Basic                     | s o  | f Business    |  |
| Re                                                                                                   | gulations; How t                                                                          | 0 C     | et Help to Get S                        | Started; Pa | atents, Trademark, I | Licensing, Contracts;                 | Con  | nmon Legal    |  |
| mi                                                                                                   | stakes, Types of                                                                          | Pe      | ermits, Tax Reg                         | gistration  | Documents, Comp      | liance; Infringement                  | and  | Remedies,     |  |
| Ov                                                                                                   | Ownership and Transfer.                                                                   |         |                                         |             |                      |                                       |      |               |  |
| Course     | Course Outcomes: After completing the course, the students will be able to         |  |  |  |  |
|------------|------------------------------------------------------------------------------------|--|--|--|--|
| CO1        | showcase the ability to discern distinct entrepreneurial traits                    |  |  |  |  |
| CO2        | Know the parameters to assess opportunities and constraints for new business ideas |  |  |  |  |
| CO3        | Understand the systematic process to select and screen a business idea             |  |  |  |  |
| <b>CO4</b> | design strategies for successful implementation of ideas                           |  |  |  |  |
| CO5        | Create Business Model and develop Minimum Viable Product                           |  |  |  |  |

| Ref | erence Books                                                                               |
|-----|--------------------------------------------------------------------------------------------|
| 1   | Running Lean: Iterate from Plan A to a Plan That Works. O'Reilly Media, Maurya, A., 2012.  |
| 2   | Entrepreneurship. Roy, R., 2012. Oxford University Press                                   |
| 3   | Intellectual Property Law in India. Gupta, T. S., 2011. Kluwer Law International           |
| 4   | Flow: The Psychology of Optimal Experience. Czikszentmihalyi, M., 2008. Harper Perennial   |
| 4   | Modern Classics                                                                            |
| 5   | Effectuation: Elements of Entrepreneurial Expertise. Sarasvathy, S. D., 2009. Edward Elgar |
| 5   | Publishing Ltd.                                                                            |

# Continuous Internal Evaluation (CIE); Theory (100 Marks)

**CIE** is executed by way of quizzes (Q), tests (T) and Assignment. A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 60. The marks component for assignment is 10. The total marks of CIE are 100.

## Semester End Evaluation (SEE); Theory (100 Marks)- (Needs to be discussed)

**SEE** for 100 marks is executed by means of an examination. The Question paper for each course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

|                                                                                                                                                                                                                                                                                                                                                  | Semester: IIV                                                                                                                   |                   |                              |                                      |                           |             |       |                 |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------|-------------------|------------------------------|--------------------------------------|---------------------------|-------------|-------|-----------------|
|                                                                                                                                                                                                                                                                                                                                                  | UNMANNED AERIAL VEHICLES                                                                                                        |                   |                              |                                      |                           |             |       |                 |
| 0                                                                                                                                                                                                                                                                                                                                                | (Group H: Global Elective)                                                                                                      |                   |                              |                                      |                           |             |       |                 |
|                                                                                                                                                                                                                                                                                                                                                  | odites I .T.D.S                                                                                                                 | :                 | 16G/H1/<br>3:0:0:0           |                                      | SFF                       |             |       | 00 Marks        |
|                                                                                                                                                                                                                                                                                                                                                  |                                                                                                                                 | •                 | 3.0.0.0                      |                                      | SEE<br>SEE Duration:      |             |       | UU WIAIKS       |
|                                                                                                                                                                                                                                                                                                                                                  | ourse Learning                                                                                                                  | l ·<br>Ohi        | JOL                          | students will be able                | to                        | <u> </u>    |       | 1115            |
| 1                                                                                                                                                                                                                                                                                                                                                | Get an overview                                                                                                                 | v of              | the history of               | f IIAV systems                       | 10                        |             |       |                 |
| -                                                                                                                                                                                                                                                                                                                                                | Understand the                                                                                                                  | $\frac{100}{100}$ | nortance of a                | erodynamics propulsion               | n structures and avioni   | 00          | in    | the design of   |
| 2                                                                                                                                                                                                                                                                                                                                                | UAV                                                                                                                             |                   |                              |                                      |                           |             |       |                 |
| 3                                                                                                                                                                                                                                                                                                                                                | Demonstrate at systems, integra                                                                                                 | oilit             | y to address<br>n with manne | the various mission pay<br>d systems | vloads - on-board & of    | : <b>t-</b> | boai  | rd, propulsion  |
| 4                                                                                                                                                                                                                                                                                                                                                | Assess the perfe                                                                                                                | orm               | ance and airv                | vorthiness of the designe            | ed UAV                    |             |       | _               |
|                                                                                                                                                                                                                                                                                                                                                  |                                                                                                                                 |                   |                              |                                      |                           |             |       |                 |
|                                                                                                                                                                                                                                                                                                                                                  |                                                                                                                                 |                   |                              | Unit-I                               |                           |             |       | 06 Hrs          |
| In                                                                                                                                                                                                                                                                                                                                               | troduction to Fl                                                                                                                | igh               | t Vehicles:                  |                                      |                           |             |       |                 |
| H                                                                                                                                                                                                                                                                                                                                                | story of Flight V                                                                                                               | ehi               | cles and UAV                 | s, Classifications, Woki             | ing principles of flight  | ve          | hicl  | e.              |
| III<br>Ta                                                                                                                                                                                                                                                                                                                                        |                                                                                                                                 | nn:<br>nfi        | anned Aircra                 | their advantages disadu              | ontagoa Sustan Comp       |             | tion  | Applications    |
| of                                                                                                                                                                                                                                                                                                                                               | UAVs Characte                                                                                                                   | rict              | ics of Aircraf               | tilen auvantages uisauva             | antages, system Compo     | 51          | tion  | , Applications  |
| 01                                                                                                                                                                                                                                                                                                                                               | UAVS, Characte                                                                                                                  | 1151              | ies of Alferat               | Init _ II                            |                           |             |       | 07 Hrs          |
| D                                                                                                                                                                                                                                                                                                                                                | sign of UAV Sv                                                                                                                  | ster              | ns: Governi                  | ng aspects:                          |                           |             |       | 07 1113         |
| 2.                                                                                                                                                                                                                                                                                                                                               | a. Aerodyna                                                                                                                     | mic               | s. b. Propuls                | ion. C. structure. d. Co             | ontrols                   |             |       |                 |
| A                                                                                                                                                                                                                                                                                                                                                | erodynamics:                                                                                                                    |                   | s, s, <u> </u>               |                                      |                           |             |       |                 |
| In                                                                                                                                                                                                                                                                                                                                               | troduction basic                                                                                                                | Aer               | odynamics, li                | ft, drag, Aerofoils, wing            | area optimization.        |             |       |                 |
| Pr                                                                                                                                                                                                                                                                                                                                               | opulsion:                                                                                                                       |                   |                              |                                      |                           |             |       |                 |
| In                                                                                                                                                                                                                                                                                                                                               | troduction to proj                                                                                                              | puls              | ion system in                | UAV, Propulsion system               | m for fixed wing UAV      | an          | d V   | TOL (Vertical   |
| tal                                                                                                                                                                                                                                                                                                                                              | ke-off and landin                                                                                                               | g) (              | JAV, Advanc                  | ed propulsion systems,               | fuel cells, generators ba | ise         | ed sy | ystems.         |
|                                                                                                                                                                                                                                                                                                                                                  |                                                                                                                                 |                   |                              | Unit -III                            |                           |             |       | 07Hrs           |
| St                                                                                                                                                                                                                                                                                                                                               | ructures of UAV                                                                                                                 | /:                |                              |                                      |                           |             |       |                 |
| Μ                                                                                                                                                                                                                                                                                                                                                | echanic loading,                                                                                                                | basi              | ics of types of              | fload calculation and str            | uctural engineering, Ma   | ite         | rial  | used for UAV    |
| (g                                                                                                                                                                                                                                                                                                                                               | eneral introducti                                                                                                               | on)               | , FRP and m                  | ethods of usage in UA                | V, Testing of FRP sp      | be          | cime  | ens for UAV,    |
| se                                                                                                                                                                                                                                                                                                                                               | lection criteria f                                                                                                              | or                | structure, Ty                | pes of structural eleme              | ents used in UAV the      | ir          | sig   | nificance and   |
| ch                                                                                                                                                                                                                                                                                                                                               | aracteristics, Me                                                                                                               | tho               | ls of manufac                | turing UAV structure.                |                           |             |       |                 |
|                                                                                                                                                                                                                                                                                                                                                  |                                                                                                                                 |                   |                              | Unit -IV                             | -                         |             |       | 07 Hrs          |
| <b>Controls, Avionics, Hardware, Communication, Payloads:</b><br>Basics of control system and Systems for control system in UAV, PID control, simulation introduction to Hardware in loop system (HILS), Avionics: Autopilot (AP) – architecture of AP, sensors, actuators, power supply, integration, installation, configuration, and testing. |                                                                                                                                 |                   |                              |                                      |                           |             |       |                 |
| Ha<br>El<br>sig                                                                                                                                                                                                                                                                                                                                  | Hardware, Communication<br>Electronics Hardware in UAV, Communication methods, communication antenna and their<br>significance. |                   |                              |                                      |                           |             |       |                 |
| Pa<br>Pa                                                                                                                                                                                                                                                                                                                                         | <b>Payloads:</b><br>Payload types and their applications                                                                        |                   |                              |                                      |                           |             |       |                 |
|                                                                                                                                                                                                                                                                                                                                                  |                                                                                                                                 |                   |                              | Unit -V                              |                           |             |       | 09 Hrs          |
| De<br>ba                                                                                                                                                                                                                                                                                                                                         | esign of UAV Sy<br>sed exercise                                                                                                 | yste              | ems: Fixed v                 | ving UAV and Rotary v                | wing UAV (VTOL) Ta        | sk          | spe   | cific, activity |

| Cours      | Course Outcomes: At the end of this course the student will be able to :             |  |  |  |  |  |
|------------|--------------------------------------------------------------------------------------|--|--|--|--|--|
| CO1        | Appraise the evolution of UAVs and understand the current potential benefits of UAVs |  |  |  |  |  |
| CO2        | Apply the principles of Aerospace Engineering in design and development of UAVs      |  |  |  |  |  |
| CO3        | Determine and evaluate the performance of UAV designed for various Missions and      |  |  |  |  |  |
|            | applications                                                                         |  |  |  |  |  |
| <b>CO4</b> | Assess the performance and airworthiness of the designed UAV                         |  |  |  |  |  |

#### **Reference Books**

| 1 | Unmanned Aircraft Systems UAV design, development and deployment, Reg Austin, 1 <sup>st</sup> Edition, 2010, Wiley, ISBN 9780470058190.                        |
|---|----------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 2 | Flight Stability and Automatic Control, Robert C. Nelson, 2 <sup>nd</sup> Edition, October 1, 1997, McGraw-Hill, Inc, ISBN 978-0070462731.                     |
| 3 | Advances in Unmanned Aerial Vehicles: State of the Art and the Road to Autonomy, Kimon P. Valavanis, 1 <sup>st</sup> Edition,2007, Springer ISBN 9781402061141 |
| 4 | Introduction to UAV Systems, Paul G Fahlstrom, Thomas J Gleason, 4 <sup>th</sup> Edition, 2012, Wiley, ISBN: 978-1-119-97866-4                                 |
| 5 | Design of Unmanned Air Vehicle Systems, Dr. Armand J. Chaput, 3 <sup>rd</sup> Edition, 2001, Lockheed Martin Aeronautics Company, ISBN: 978-1-60086-843-6      |

## Continuous Internal Evaluation (CIE); Theory (100 Marks)

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## Semester End Evaluation (SEE); Theory (100 Marks)- (Needs to be discussed)

**SEE** for 100 marks is executed by means of an examination. The Question paper for each course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

| CO-PO Mapping |            |     |     |     |     |            |            |            |     |      |      |      |
|---------------|------------|-----|-----|-----|-----|------------|------------|------------|-----|------|------|------|
| CO/PO         | <b>PO1</b> | PO2 | PO3 | PO4 | PO5 | <b>PO6</b> | <b>PO7</b> | <b>PO8</b> | PO9 | PO10 | PO11 | PO12 |
| CO1           | 3          | 3   | 3   | 1   | 1   | 3          | 2          | 2          |     |      |      | 1    |
| CO2           | 2          | 3   | 3   | 3   | 1   | 1          | 1          | 1          |     |      |      | 2    |
| CO3           | 1          |     | 3   | 3   |     |            |            |            |     |      |      | 2    |
| <b>CO4</b>    | 3          | 3   | 3   | 3   |     | 2          | 1          | 2          |     |      |      | 2    |

## High-3 : Medium-2 : Low-1

| Semester: VIII |                                                                                          |       |                   |                    |                      |      |                           |  |
|----------------|------------------------------------------------------------------------------------------|-------|-------------------|--------------------|----------------------|------|---------------------------|--|
|                | MAJOR PROJECT                                                                            |       |                   |                    |                      |      |                           |  |
|                |                                                                                          |       | ( <b>C</b>        | ommon to all I     | Programs)            |      |                           |  |
| Cou            | rse Code                                                                                 | :     | 16EC81            |                    | CIE                  | :    | 100 Marks                 |  |
| Crec           | lits: L:T:P:S                                                                            | :     | 0:0:16:0          |                    | SEE                  | :    | 100 Marks                 |  |
| Hours / Week   |                                                                                          |       | 32                |                    | <b>SEE Duration</b>  | :    | 3.00 Hours                |  |
| Cour           | rse Learning Obj                                                                         | ject  | ives: The stu     | dents will be ab   | le to                |      |                           |  |
| 1              | Acquire the abi                                                                          | lity  | to make link      | across differen    | t areas of knowled   | lge  | and to generate, develop  |  |
|                | and evaluate id                                                                          | eas   | and informati     | ion so as to apply | these skills to the  | pro  | ject task.                |  |
| 2              | Acquire the ski                                                                          | ills  | to communic       | ate effectively an | nd to present ideas  | cle  | early and coherently to a |  |
|                | specific audience in both written and oral forms.                                        |       |                   |                    |                      |      |                           |  |
| 3              | <b>3</b> Acquire collaborative skills through working in a team to achieve common goals. |       |                   |                    |                      |      |                           |  |
| 4              | Self-learn, refle                                                                        | ect o | on their learning | ng and take appr   | opriate action to im | npro | ove it.                   |  |
| 5              | Prepare schedu                                                                           | les   | and budgets a     | nd keep track of   | the progress and ex  | xpe  | nditure.                  |  |

# **Major Project Guidelines:**

- 1. The project topic, title and synopsis have to be finalized and submitted to their respective internal guide(s) before the beginning of the 8<sup>th</sup> semester.
- 2. The detailed Synopsis (*approved by the department Project Review Committee*) has to be submitted during the 1<sup>st</sup> week after the commencement of 8<sup>th</sup> semester.

## **Batch Formation:**

- Students are free to choose their project partners from within the program or any other program;
- Each student in the team must contribute towards the successful completion of the project. The project may be carried out In-house / Industry / R & D Institution;
- > The project work is to be carried out by a team of two to four students, in exceptional cases where a student is placed in a company and offered an internship through the competitive process or student is selected for internship at national or international level through competitive process, the student can work independently.
- The students are allowed to do either a project for full 5 days in the industry or full 5 days in the college.
- In case the project work is carried out outside Bengaluru, such students must be available during Project Evaluation process scheduled by the respective departments and they must also interact with their guide regularly through Email / Webinar / Skype etc.

# **Project Topic Selection:**

The topics of the project work must be in the *field of respective program areas or in line with CoE's (Centre of Excellence) identified by the college* or List of project areas as given by industry/Faculty. The projects as far as possible should have societal relevance with focus on sustainability.

# **Project Evaluation:**

- Continuous monitoring of project work will be carried out and cumulative evaluation will be done.
- The students are required to meet their internal guides once in a week to report their progress in project work.
- Weekly Activity Report (WAR) has to be maintained in the form of a diary by the project batch and the same has to be discussed with the Internal Guide regularly.
- In case of *Industry project*, during the course of project work, the internal guides will have continuous interaction with external guides and will visit the industry at least twice during the project period.

- ➢ For CIE assessment the project groups must give a final seminar with the draft copy of the project report.
- The presentation by each group will be for 20-30 minutes and every member of the team needs to justify the contributions to the project.
- The project team is required to submit Hard copies of the detailed Project Report in the prescribed format to the department.
  - ➢ For CIE 50% weightage should be given to the project guide and 50% weightage to the project evaluation committee.
  - Before the final evaluations the project group is required to produce a No dues certificate from Industry, Central Library and Department.

| Cours | e Outcomes of Major Project:                                                                  |
|-------|-----------------------------------------------------------------------------------------------|
| 1     | Apply knowledge of mathematics, science and engineering to solve respective engineering       |
|       | domain problems.                                                                              |
| 2     | Design, develop, present and document innovative/multidisciplinary modules for a complete     |
|       | engineering system.                                                                           |
| 3     | Use modern engineering tools, software and equipment to solve problem and engage in life-long |
|       | learning to follow technological developments.                                                |
| 4     | Function effectively as an individual, or leader in diverse teams, with the understanding of  |
|       | professional ethics and responsibilities.                                                     |

# **CIE Assessment:**

The following are the weightings given for the various stages of the project.

| 1.          | Selection of the topic and formulation of objectives   | 10% |
|-------------|--------------------------------------------------------|-----|
| 2.          | Design and Development of Project methodology          | 25% |
| 3.          | Execution of Project                                   | 25% |
| 4.          | Presentation, Demonstration and Results Discussion     | 30% |
| 5.          | Report Writing & Publication                           | 10% |
| SEE Assessn | nent:                                                  |     |
| The follo   | wing are the weightages given during Viva Examination. |     |
| 1.          | Written presentation of synopsis                       | 10% |
| 2.          | Presentation/Demonstration of the project              | 30% |
| 3.          | Methodology and Experimental Results & Discussion      | 30% |
| 4.          | Report                                                 | 10% |
| 5.          | Viva Voce                                              | 20% |

## Calendar of Events for the Project Work:

| Week                                  | Event                                                                                             |
|---------------------------------------|---------------------------------------------------------------------------------------------------|
| Beginning of 7 <sup>th</sup> Semester | Formation of group and approval by the department committee.                                      |
| 7 <sup>th</sup> Semester              | Problem selection and literature survey                                                           |
| Last two weeks of 7 <sup>th</sup>     | Finalization of project and guide allotment                                                       |
| Semester                              |                                                                                                   |
| II Week of 8 <sup>th</sup> Semester   | Synopsis submission and preliminary seminar                                                       |
| III Week                              | First visit of the internal guides to industry (In case of project being carried out in industry) |
| III to VI Week                        | Design and development of project methodology                                                     |
| VII to IX Week                        | Implementation of the project                                                                     |
| X Week                                | Submission of draft copy of the project report                                                    |

Electronics and Communication Engineering

| XI and XII Week | Second visit by guide to industry for demonstration. Final seminar by |
|-----------------|-----------------------------------------------------------------------|
|                 | Finalization of CIE.                                                  |

| Evaluation Scheme for CIE and SEE                                                              |                              |                                        |        |  |  |  |  |  |
|------------------------------------------------------------------------------------------------|------------------------------|----------------------------------------|--------|--|--|--|--|--|
| Scheme of Evaluation for CI                                                                    | Scheme of Evaluation for SEE |                                        |        |  |  |  |  |  |
| Particulars                                                                                    | %Marks                       | Particulars                            | %Marks |  |  |  |  |  |
| Project Evaluation I                                                                           | 10%                          | Project Synopsis (Initial Write<br>up) | 10%    |  |  |  |  |  |
| Project Evaluation II                                                                          | 25%                          | Project Demo / Presentation            | 30%    |  |  |  |  |  |
| Project Evaluation III                                                                         | 25%                          | Methodology and Results Discussion     | 30%    |  |  |  |  |  |
| <b>Project Evaluation Phase-IV</b><br>(Submission of Draft Project Report for<br>Verification) | 30%                          | Project Work Report                    | 10%    |  |  |  |  |  |
| <b>Project Evaluation Phase-V</b><br>(Project Final Internal Evaluation)                       | 10%                          | Viva-voce                              | 20%    |  |  |  |  |  |
| Total                                                                                          | 100                          | Total                                  | 100    |  |  |  |  |  |

#### Sah nd SEE Г ~ **I** ..... for CIF

| Semester: VIII                                           |                                                                                             |    |         |  |              |     |            |
|----------------------------------------------------------|---------------------------------------------------------------------------------------------|----|---------|--|--------------|-----|------------|
| TECHNICAL SEMINAR                                        |                                                                                             |    |         |  |              |     |            |
| (Common to all Programs)                                 |                                                                                             |    |         |  |              |     |            |
| Cou                                                      | rse Code                                                                                    | •• | 16EC82  |  | CIE          | ••• | 100 Marks  |
| Credits: L:T:P:S                                         |                                                                                             | •• | 0:0:2:0 |  | SEE          | ••• | 100 Marks  |
| Hours / Week                                             |                                                                                             |    | 04      |  | SEE Duration | :   | 3.00 Hours |
| Course Learning Objectives: The students will be able to |                                                                                             |    |         |  |              |     |            |
| 1                                                        | <b>1</b> Recognize recent developments in specific program and in multidisciplinary fields. |    |         |  |              |     |            |
| 2                                                        | Summarize the recent technologies and inculcate the skills for literature survey.           |    |         |  |              |     |            |
| 3                                                        | B Demonstrate good presentation skills.                                                     |    |         |  |              |     |            |
| 4                                                        | Plan and improve the Technical Report writing skills.                                       |    |         |  |              |     |            |
| 5                                                        | Support Group discussion and Team work.                                                     |    |         |  |              |     |            |

# General Guidelines for the Seminar

- 1. The seminar has to be presented by individual student.
- 2. The topic of the seminar should be from current thrust area along with consultation with the guide.
- 3. The topic can be based on standard papers (like IEEE/ACM/CSI etc.) in the thrust area for the selected topic.
- 4. Presenting/publishing this paper in conference/ Journal will be given weightage in CIE.
- 5. The student needs to submit both hard & soft copy of the seminar report.
- 6. As Outcome of Technical Seminar, each student has to prepare a technical paper out of seminar topic.

| Cour | se Outcomes of Technical Seminar:                                                              |  |  |  |
|------|------------------------------------------------------------------------------------------------|--|--|--|
| 1    | Communicate effectively on complex engineering problems and demonstrate contextual             |  |  |  |
|      | knowledge to assess societal and environmental contexts.                                       |  |  |  |
| 2    | Identify, formulate, review research literature, analyze and Design solutions for complex      |  |  |  |
|      | engineering problems using appropriate techniques with effective documentation.                |  |  |  |
| 3    | Analyze, interpret and synthesize the information to provide valid conclusions with innovative |  |  |  |
|      | ideas and ethical principles.                                                                  |  |  |  |
| 4    | Apply the knowledge of engineering specialization to suggest solutions to complex engineering  |  |  |  |
|      | problems and recognize the need for technological changes.                                     |  |  |  |

## **Evaluation of CIE Marks:**

| 1. | Relevance of the topic | 10% |
|----|------------------------|-----|
| 2. | Literature Survey      | 10% |
| 3. | Presentation           | 40% |
| 4. | Report                 | 20% |
| 5. | Paper Publication      | 20% |

| Semester: VIII                                           |                                                                                                    |    |         |  |              |    |    |
|----------------------------------------------------------|----------------------------------------------------------------------------------------------------|----|---------|--|--------------|----|----|
| INNOVATION & SOCIAL SKILLS                               |                                                                                                    |    |         |  |              |    |    |
| (Common to all Programs)                                 |                                                                                                    |    |         |  |              |    |    |
| Course (                                                 | Code                                                                                               | •• | 16HSS83 |  | CIE          | •• | NA |
| <b>Credits:</b>                                          | L:T:P:S                                                                                            | •• | 0:0:1:0 |  | SEE          | •• | NA |
| Hours / Week                                             |                                                                                                    | •• | 02      |  | SEE Duration | •• | NA |
| Course Learning Objectives: The students will be able to |                                                                                                    |    |         |  |              |    |    |
| 1                                                        | <b>1</b> To provide a platform for the students to exhibit their organizational capabilities, team |    |         |  |              |    |    |
|                                                          | building, ethical values and extra mural abilities.                                                |    |         |  |              |    |    |
| 2                                                        | 2 To encourage to carryout innovative ideas and projects.                                          |    |         |  |              |    |    |
| 3                                                        | <b>3</b> Take part in societal and community building activities.                                  |    |         |  |              |    |    |
| 4                                                        | 4 Make self-learning, ethics and lifelong learning a motto.                                        |    |         |  |              |    |    |

# Guidelines

- 1. The HSS will be evaluated individually based on the broad parameters which include the progress made by student during 3<sup>rd</sup>& 4<sup>th</sup> year in innovative projects, Seminar, Paper Presentation, Field activity & other Co-curricular activities.
- 2. Students shall submit a report and documents as a proof his/her achievements.

| Course Outcomes of Innovation & Social Skills: |                                                                                |  |  |  |
|------------------------------------------------|--------------------------------------------------------------------------------|--|--|--|
| 1                                              | Apply the knowledge and skills for solving societal issues                     |  |  |  |
| 2                                              | Plan to work in team in various areas with inclusive effort and sustainability |  |  |  |
| 3                                              | Organize various events and use managerial and budgeting abilities             |  |  |  |
| 4                                              | Demonstrate leadership qualities and ethics                                    |  |  |  |



## **Curriculum Design Process**

Academic Planning and Implementation





#### PROCESS FOR COURSE OUTCOME ATTAINMENT

**Final CO Attainment Process** 



# **Program Outcome Attainment Process**



Guidelines for Fixing Targets

• The target may be fixed based on last 3 years' average attainment

# PROGRAM OUTCOMES (POs)

1. **Engineering knowledge:** Apply the knowledge of mathematics, science, engineering fundamentals, and an engineering specialisation for the solution of complex engineering problems.

2. **Problem analysis:** Identify, formulate, research literature, and analyse complex engineering problems reaching substantiated conclusions using first principles of mathematics, natural sciences, and engineering sciences.

3. **Design/development of solutions:** Design solutions for complex engineering problems and design system components or processes that meet t h e specified needs with appropriate consideration for public health and safety, and cultural, societal, and environmental considerations.

4. **Conduct investigations of complex problems:** Use research-based knowledge and research methods including design of experiments, analysis and interpretation of data, and synthesis of the information to provide valid conclusions.

5. **Modern tool usage**: Create, select, and apply appropriate techniques, resources, and modern engineering and IT tools, including prediction and modelling to complex engineering activities, with an understanding of the limitations.

6. **The engineer and society:** Apply reasoning informed by the contextual knowledge to assess societal, health, safety, legal, and cultural issues and the consequent responsibilities relevant to the professional engineering practice.

7. **Environment and sustainability:** Understand the impact of the professional engineering solutions in societal and environmental contexts, and demonstrate the knowledge of, and need for sustainable development.

8. **Ethics:** Apply ethical principles and commit to professional ethics and responsibilities and norms of the engineering practice.

9. **Individual and team work:** Function effectively as an individual, and as a member or leader in diverse teams, and in multidisciplinary settings.

10. **Communication:** Communicate effectively on complex engineering activities with the engineering community and with t h e society at large, such as, being able to comprehend and write effective reports and design documentation, make effective presentations, and give and receive clear instructions.

11. **Project management and finance:** Demonstrate knowledge and understanding of the engineering and management principles and apply these to one's own work, as a member and leader in a team, to manage projects and in multidisciplinary environments.

12. **Life-long learning:** Recognise the need for, and have the preparation and ability to engage in independent and life-long learning in the broadest context of technological change.